

## MSPM0H321x-Q1 Automotive Mixed-Signal Microcontrollers

### 1 Features

- Qualified for automotive applications
- **Core**
  - Arm® 32-bit Cortex®-M0+ CPU, frequency up to 32MHz
- **Operating characteristics**
  - Extended temperature: –40°C to 125°C
  - Supply voltage range: 4.5V to 5.5V
- **Memories**
  - Up to 64KB of flash
  - 8KB of SRAM
- **High-performance analog peripherals**
  - One analog-to-digital converter (ADC) with up to 27 total external channels, 1.6Msps at 12-bit
  - 4.05V internal ADC voltage reference (VREF)
  - Integrated temperature sensor
  - Integrated supply monitor
- **Optimized low-power modes**
  - RUN: 126µA/MHz (CoreMark)
  - SLEEP: 2516µA at 32MHz
  - STOP: 1442µA at 4MHz and 674µA at 32kHz
  - STANDBY: 3.8µA with SRAM retention
- **Intelligent digital peripherals**
  - 3-channel DMA controller
  - Five timers supporting up to 18 PWM channels
    - One 16-bit advanced timers with deadband support up to 8 PWM channels
    - One 16-bit general-purpose timer with 4 capture/compares
    - Two 16-bit general-purpose timers with 2 capture/compares
    - One 16-bit general-purpose timer with 2 capture/compares and QE1
  - Windowed watchdog timer (WWDT)
  - Independent watch dog timer (IWDT)
  - RTC with alarm and calendar mode
  - BEEPER generating 1/2/4/8kHz square wave to drive an external beeper
- **Enhanced communication interfaces**
  - Three UART interfaces supporting low-power operation in STANDBY mode
    - One advanced UART instance supporting LIN, IrDA, DALI, Smart Card, & Manchester coding
  - Two I<sup>2</sup>C interfaces supporting FM+ (1Mbit/s), SMBus/PMBus, and wakeup from STOP mode,
  - One SPI supporting up to 16Mbit/s

- **Clock system**
  - Internal 32MHz oscillator with -2.1% to 1.6% accuracy (SYSOSC)
  - Internal 32kHz low-frequency oscillator (LFOSC) with up to ±3% accuracy
  - External 4MHz to 32MHz crystal oscillator (HFXT)
  - External 32kHz crystal oscillator (LFXT)
  - External Low Frequency (LF) and High Frequency (HF) digital clock inputs
- **Data integrity**
  - Flexible firewalls for protecting code and data
  - Cyclic redundancy checker (CRC-16)
- **Flexible I/O features**
  - Up to 45 GPIOs
  - True 5V IOs
- **Development support**
  - 2-pin serial wire debug (SWD)
- **Package options**
  - 48-pin LQFP (PT), VQFN (RGZ)
  - 32-pin VQFN (RHB)
  - 24-pin VQFN (RGE)
  - 20-pin VSSOP (DGS20), WQFN (RUK)
- **Family members** (also see [Device Comparison](#))
  - MSPM0H3216: 64KB of flash, 8KB of RAM
  - MSPM0H3215: 32KB of flash, 8KB of RAM
- **Development kits and software** (also see [Tools and Software](#))
  - LP-MSPM0H3216 LaunchPad™ development kit
  - MSP Software Development Kit (SDK)

### 2 Applications

- [Automotive body electronics and Lighting](#)
- [Automotive Gateway](#)
- [Steering Wheel Systems](#)
- [Automotive Motor Control](#)
- [DC to AC Inverters](#)
- [Automotive Interior Lighting](#)
- [Door handle modules](#)
- [Kick to open modules](#)
- [Vehicle Occupancy Detection](#)
- [Seat Comfort Module](#)



### 3 Description

MSPM0H321x microcontrollers (MCUs) are part of the MSP highly-integrated 5V power supply and 32-bit MCU family based on the enhanced Arm® Cortex®-M0+ core platform operating at up to 32MHz frequency. These cost-optimized MCUs offer high-performance analog peripheral integration, support extended temperature ranges from -40°C to 125°C, and operate with supply voltages from 4.5V.

The MSPM0H321x devices provide up to 64KB embedded flash program memory with 8KB SRAM. These MCUs incorporate a high-speed on-chip oscillator with an accuracy of -2.1% to 1.6%, eliminating the need for an external crystal. Additional features include a 3-channel DMA, CRC-16 accelerator, and a variety of high-performance analog peripherals such as one 12-bit 1.6Msps ADC with VDD as the voltage reference, and an on-chip temperature sensor. These devices offer intelligent digital peripherals such as one 16-bit advanced timer, four 16-bit general-purpose timer, one windowed watchdog timer, one independent watchdog timer, and a real-time clock (RTC). These devices also offer a variety of communication peripherals including three UART, one SPI, and two I<sup>2</sup>C. These communication peripherals offer protocol support for LIN, IrDA, DALI, Manchester, smart card, SMBus, and PMBus.

The TI MSPM0 family of low-power MCUs consists of devices with varying degrees of analog and digital integration enabling customers to find the MCU that meets their project needs. The architecture combined with extensive low-power modes is optimized to achieve extended battery life in portable measurement applications.

MSPM0H321x MCUs are supported by an extensive hardware and software ecosystem with reference designs and code examples to get the design started quickly. Development kits include a LaunchPad™ kit available for purchase and design files for a target-socket board. TI also provides a free MSP Software Development Kit (SDK), which is available as a component of [Code Composer Studio™](#) IDE desktop and cloud version within the [TI Resource Explorer](#). MSPM0 MCUs are also supported by extensive online collateral, training with [MSP Academy](#), and online support through the [TI E2E™](#) support forums.

For complete module descriptions, see the [MSPM0H-Series 32MHz Microcontrollers Technical Reference Manual](#).

**Table 3-1. Package Information**

| PART NUMBER <sup>(1) (3)</sup> | PACKAGE <sup>(4)</sup> | PACKAGE SIZE <sup>(2)</sup> |
|--------------------------------|------------------------|-----------------------------|
| M0H3216QPTRQ1                  | PT (LQFP, 48)          | 9mm × 9mm                   |
| M0H3215QPTRQ1                  | PT (LQFP, 48)          | 9mm × 9mm                   |
| M0H3216QRGZRQ1                 | RGZ (VQFN, 48)         | 7mm × 7mm                   |
| M0H3215QRGZRQ1                 | RGZ (VQFN, 48)         | 7mm × 7mm                   |
| M0H3216QRHBRQ1                 | RHB (VQFN, 32)         | 5mm × 5mm                   |
| M0H3215QRHBRQ1                 | RHB (VQFN, 32)         | 5mm × 5mm                   |
| M0H3216QRGERQ1                 | RGE (VQFN, 24)         | 4mm × 4mm                   |
| M0H3215QRGERQ1                 | RGE (VQFN, 24)         | 4mm × 4mm                   |
| M0H3216QDGS20RQ1               | DGS20 (VSSOP, 20)      | 5.1mm × 4.9mm               |
| M0H3215QDGS20RQ1               | DGS20 (VSSOP, 20)      | 5.1mm × 4.9mm               |
| M0H3216QRUKRQ1                 | RUK (WQFN, 20)         | 3mm × 3mm                   |
| M0H3215QRUKRQ1                 | RUK (WQFN, 20)         | 3mm × 3mm                   |

- (1) For the most current part, package, and ordering information for all available devices, see the *Package Option Addendum* in [Section 12](#), or see the [TI web site](#).
- (2) The package size (length × width) is a nominal value and includes pins, where applicable. For package dimensions with tolerances, see the *Mechanical Data* in [Section 12](#).
- (3) For more information about the device name, see [Section 10.1](#).
- (4) QFN packages are available with wettable flanks.

## 4 Functional Block Diagram

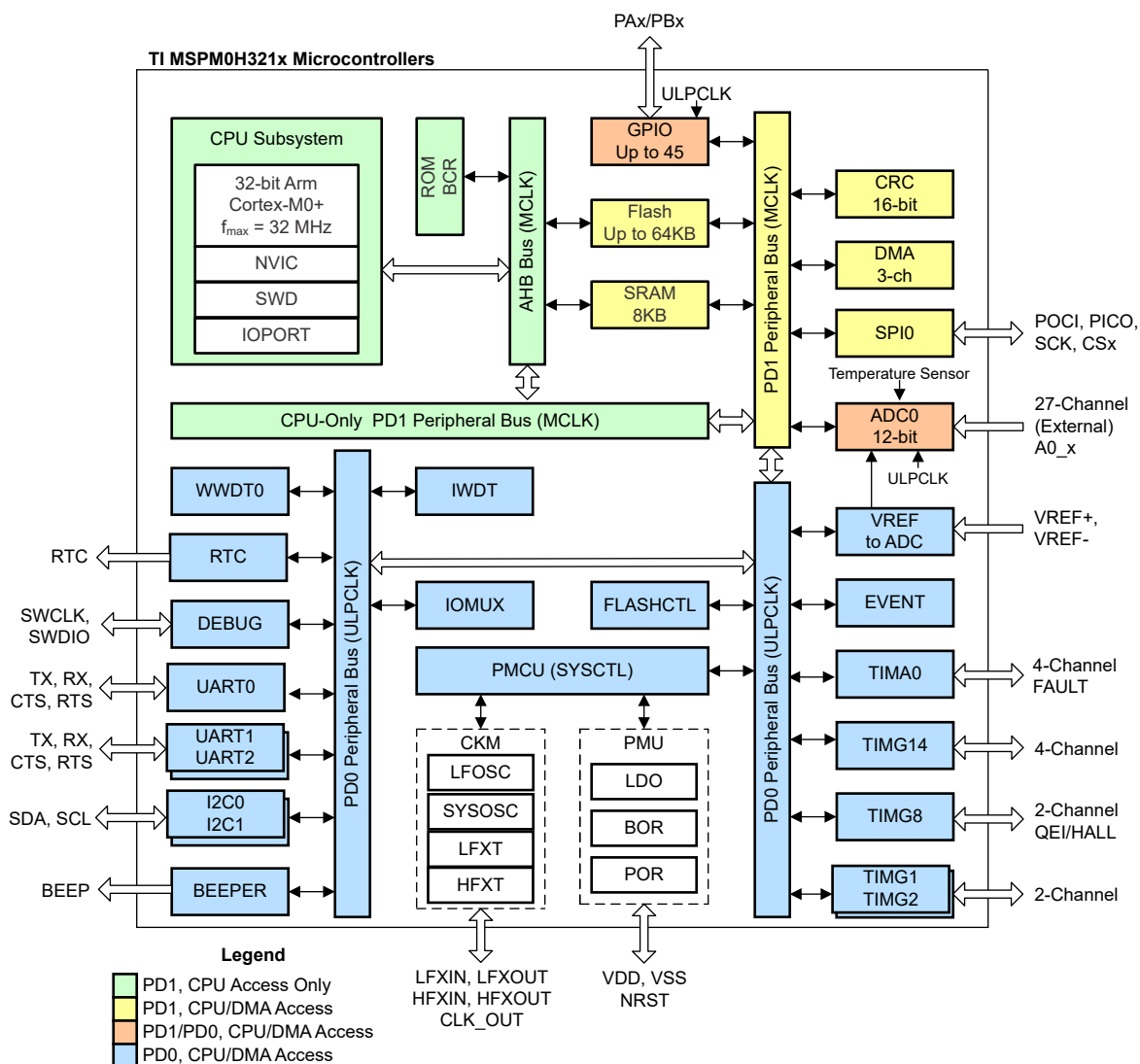


**Figure 4-1. MSPM0H321x Functional Block Diagram**

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## 5 Device Comparison

**Table 5-1. Device Comparison**

| DEVICE NAME <sup>(1) (3)</sup> | FLASH / SRAM (KB) | ADC CH. | UART / I2C / SPI | TIMG | TIMA | GPIOs | PACKAGE (PACKAGE SIZE) <sup>(2)</sup> |
|--------------------------------|-------------------|---------|------------------|------|------|-------|---------------------------------------|
| M0H3216QPTRQ1                  | 64 / 8            | 27      | 3 / 2 / 1        | 4    | 1    | 45    | 48 LQFP<br>(9mm × 9mm)                |
| M0H3215QPTRQ1                  | 32 / 8            |         |                  |      |      |       |                                       |
| M0H3216QRGZRQ1                 | 64 / 8            | 27      | 3 / 2 / 1        | 4    | 1    | 45    | 48 VQFN<br>(7mm × 7mm)                |
| M0H3215QRGZRQ1                 | 32 / 8            |         |                  |      |      |       |                                       |
| M0H3216QRHBRQ1                 | 64 / 8            | 18      | 3 / 2 / 1        | 4    | 1    | 29    | 32 VQFN<br>(5mm × 5mm)                |
| M0H3215QRHBRQ1                 | 32 / 8            |         |                  |      |      |       |                                       |
| M0H3216QRGERQ1                 | 64 / 8            | 13      | 3 / 2 / 1        | 4    | 1    | 21    | 24 VQFN<br>(4mm × 4mm)                |
| M0H3215QRGERQ1                 | 32 / 8            |         |                  |      |      |       |                                       |
| M0H3216QDGS20RQ1               | 64 / 8            | 12      | 3 / 2 / 1        | 4    | 1    | 17    | 20 VSSOP<br>(5.1mm × 4.9mm)           |
| M0H3215QDGS20RQ1               | 32 / 8            |         |                  |      |      |       |                                       |
| M0H3216QRUKRQ1                 | 64 / 8            | 12      | 3 / 2 / 1        | 4    | 1    | 17    | 20 WQFN<br>(3mm × 3mm)                |
| M0H3215QRUKRQ1                 | 32 / 8            |         |                  |      |      |       |                                       |

- (1) For the most current part, package, and ordering information for all available devices, see the *Package Option Addendum* in [Section 12](#), or see the [TI web site](#).
- (2) The package size (length × width) is a nominal value and includes pins, where applicable. For package dimensions with tolerances, see the *Mechanical Data* in [Section 12](#).
- (3) For more information about the device name, see [Section 10.1](#).

## 6 Pin Configuration and Functions

### 6.1 Pin Diagrams

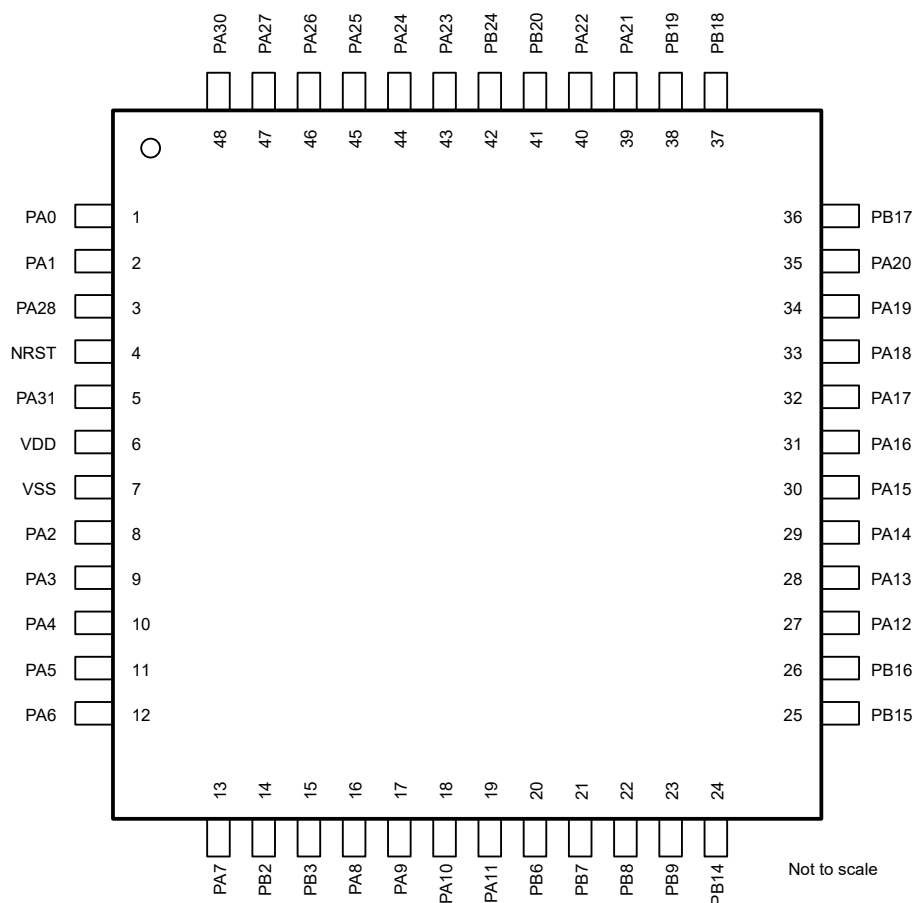


**Figure 6-1. 48-Pin PT (LQFP) (Top View)**

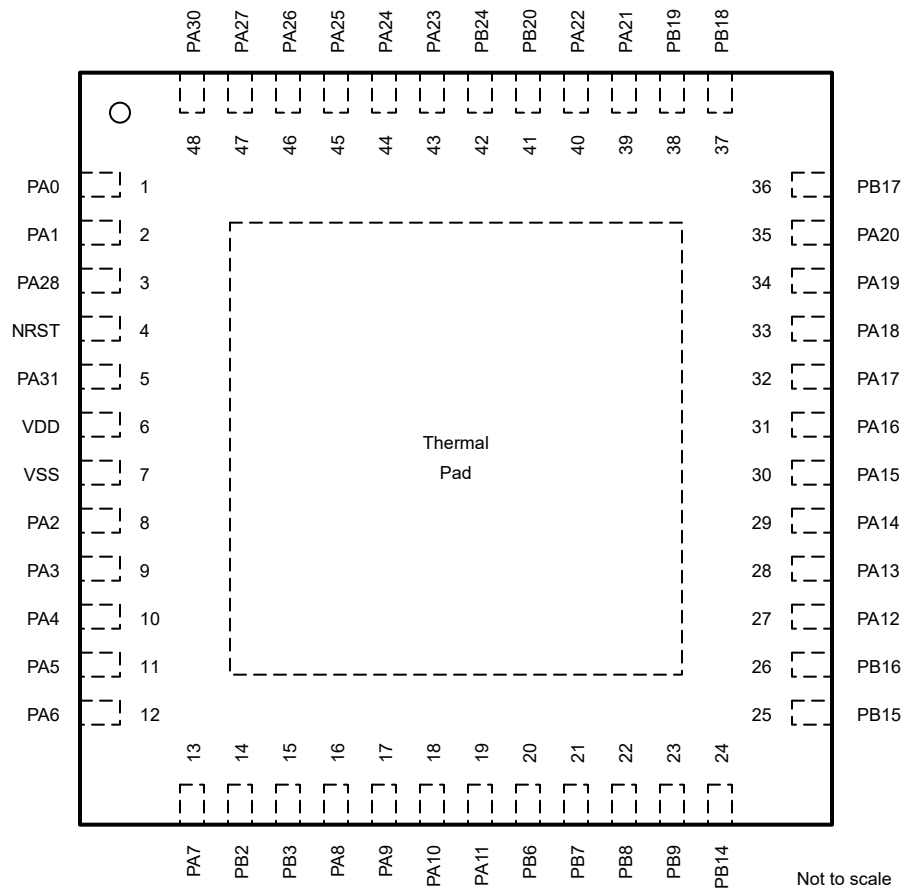


**Figure 6-2. 48-Pin RGZ (VQFN) (Top View)**

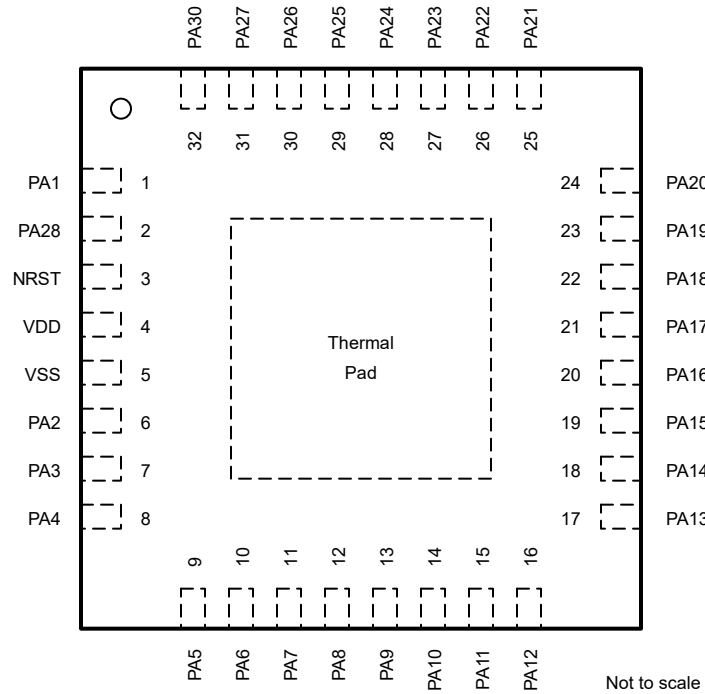


**Figure 6-3. 32-Pin RHB (VQFN) (Top View)**

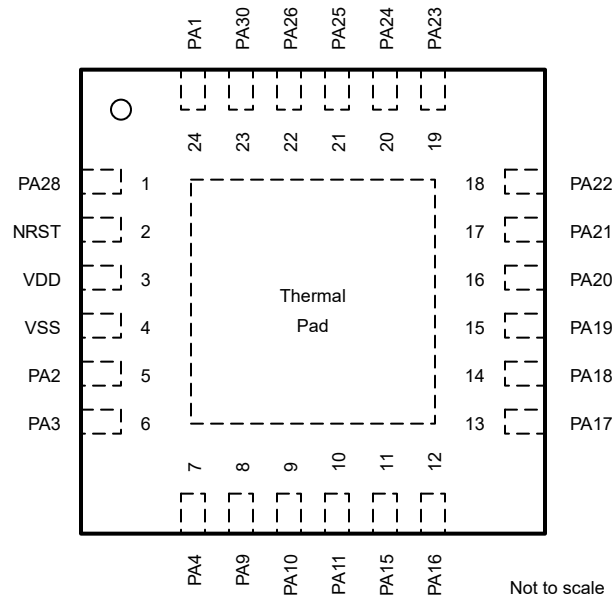


**Figure 6-4. 24-Pin RGE (VQFN) (Top View)**

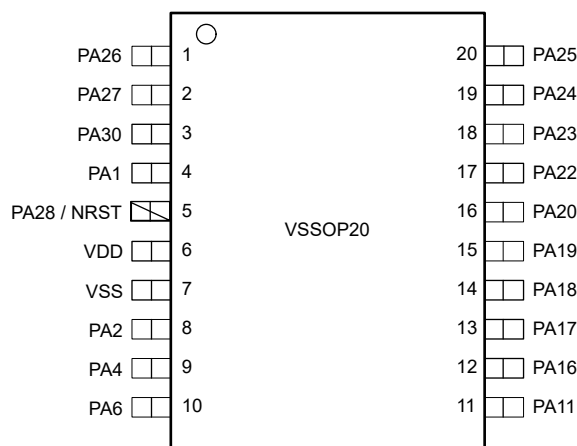


**Figure 6-5. 20-Pin DGS20 (VSSOP) (Top View)**

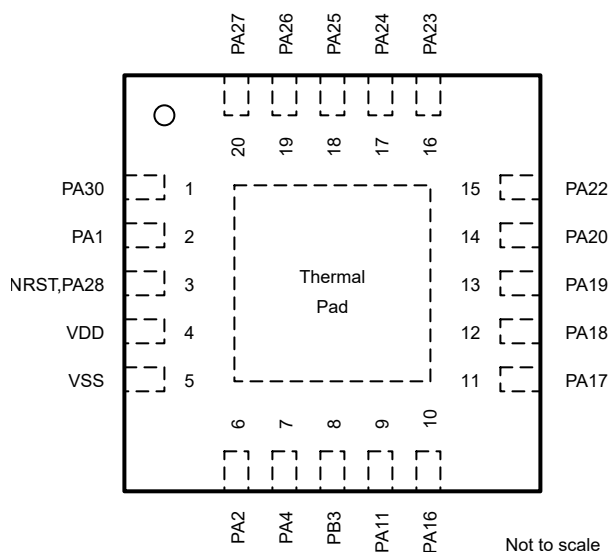


**Figure 6-6. 20-Pin RUK (WQFN) (Top View)**

## 6.2 Pin Attributes

The following table describes the functions available on every pin for each device package.

### Note

Each digital I/O on a device is mapped to a specific Pin Control Management Register (PINCMx) that lets users configure the desired *Pin Function* using the PINCM.PF control bits.

Each digital I/O on a device is mapped to a specific Pin Control Management Register (PINCMx) which allows users to configure the desired Pin Function using the PINCM.PF control bits. The IOMUX only supports connecting one IOMUX-managed digital function to the pin at the same time. The PINCM.PF and PINCM.PC in IOMUX are recommended to be set to 0 when non-IOMUX managed functions (such as analog connections)

are intended to be used on a pin. However, non-IOMUX managed signals can be enabled on a pin at the same time that an IOMUX managed digital function is enabled on the pin, provided there is no contention between the functions. In this case, the designer must verify that no contention exists between the functions enabled on each pin.

**Table 6-1. Digital IO Features by IO Type**

| BUFFER TYPE           | INVERSION CONTROL | DRIVE STRENGTH CONTROL | HYSTERESIS CONTROL | PULLUP RESISTOR | PULLDOWN RESISTOR | WAKEUP LOGIC |
|-----------------------|-------------------|------------------------|--------------------|-----------------|-------------------|--------------|
| SDIO (standard drive) | Y                 |                        |                    | Y               |                   |              |
| HSIO (High speed)     | Y                 |                        |                    | Y               |                   |              |

**Table 6-2. Pin Attributes (PT, RUK, RGZ, RHB, RGE, DGS20 Packages)**

| PT PIN | RUK PIN | RGZ PIN | RHB PIN | RGE PIN | DGS20 PIN | PIN NAME/<br>IOMUX REG/<br>IOMUX ADDR | SIGNAL NAME | IOMUX PF        | SIGNAL TYPE | BUFFER TYPE        |
|--------|---------|---------|---------|---------|-----------|---------------------------------------|-------------|-----------------|-------------|--------------------|
| 4      | 3       | 4       | 3       | 2       | 5         | NRST                                  | NRST        | (Non-IOMUX 1) 0 | RESET       | RESET              |
| 1      |         | 1       |         |         |           | PA0<br>PINCM1<br>0x40428000           | PA0         | 1               | IO          | SDIO<br>(standard) |
|        |         |         |         |         |           |                                       | UART0_TX    | 2               | O           |                    |
|        |         |         |         |         |           |                                       | I2C0_SDA    | 3               | IOD         |                    |
|        |         |         |         |         |           |                                       | TIMA0_C0    | 4               | IO          |                    |
|        |         |         |         |         |           |                                       | TIMA_FAL1   | 5               | I           |                    |
|        |         |         |         |         |           |                                       | FCC_IN      | 6               | I           |                    |
|        |         |         |         |         |           |                                       | TIMG8_C1    | 7               | IO          |                    |
|        |         |         |         |         |           |                                       | BEEP        | 8               | O           |                    |
|        |         |         |         |         |           |                                       | TIMG14_C0   | 9               | IO          |                    |
|        |         |         |         |         |           |                                       | SPI0_CS1    | 10              | IO          |                    |
|        |         |         |         |         |           |                                       | RTC_OUT     | 12              | O           |                    |
| 2      | 2       | 2       | 1       | 24      | 4         | PA1<br>PINCM2<br>0x40428004           | PA1         | 1               | IO          | SDIO<br>(standard) |
|        |         |         |         |         |           |                                       | UART0_RX    | 2               | IO          |                    |
|        |         |         |         |         |           |                                       | I2C0_SCL    | 3               | IOD         |                    |
|        |         |         |         |         |           |                                       | TIMA0_C1    | 4               | IO          |                    |
|        |         |         |         |         |           |                                       | TIMA_FAL2   | 5               | I           |                    |
|        |         |         |         |         |           |                                       | TIMG8_IDX   | 6               | I           |                    |
|        |         |         |         |         |           |                                       | TIMG8_C0    | 7               | IO          |                    |
|        |         |         |         |         |           |                                       | TIMG14_C1   | 9               | IO          |                    |
|        |         |         |         |         |           |                                       | SPI0_CS3    | 10              | IO          |                    |
|        |         |         |         |         |           |                                       | HFCLKIN     | 11              | I           |                    |
|        |         |         |         |         |           |                                       | UART0_TX    | 12              | O           |                    |
|        |         |         |         |         |           |                                       | UART1_RTS   | 13              | O           |                    |
|        |         |         |         |         |           |                                       | I2C0_SDA    | 14              | IOD         |                    |
|        |         |         |         |         |           |                                       | HFXOUT      | (Non-IOMUX 1) 0 | A           |                    |

**Table 6-2. Pin Attributes (PT, RUK, RGZ, RHB, RGE, DGS20 Packages) (continued)**

| PT<br>PIN | RUK<br>PIN | RGZ<br>PIN | RHB<br>PIN | RGE<br>PIN | DGS20<br>PIN | PIN NAME/<br>IOMUX REG/<br>IOMUX ADDR | SIGNAL<br>NAME | IOMUX<br>PF     | SIGNAL<br>TYPE | BUFFER<br>TYPE    |
|-----------|------------|------------|------------|------------|--------------|---------------------------------------|----------------|-----------------|----------------|-------------------|
| 8         | 6          | 8          | 6          | 5          | 8            | PA2<br>PINCM5<br>0x40428010           | PA2            | 1               | IO             | HSIO (high-speed) |
|           |            |            |            |            |              |                                       | TIMG8_C1       | 2               | IO             |                   |
|           |            |            |            |            |              |                                       | SPI0_CS0       | 3               | IO             |                   |
|           |            |            |            |            |              |                                       | TIMG2_C1       | 4               | IO             |                   |
|           |            |            |            |            |              |                                       | TIMG8_IDX      | 5               | I              |                   |
|           |            |            |            |            |              |                                       | TIMA0_C3N      | 6               | O              |                   |
|           |            |            |            |            |              |                                       | TIMA0_C2N      | 7               | O              |                   |
|           |            |            |            |            |              |                                       | TIMA_FAL0      | 8               | I              |                   |
|           |            |            |            |            |              |                                       | TIMA_FAL1      | 9               | I              |                   |
|           |            |            |            |            |              |                                       | TIMA0_C0       | 11              | IO             |                   |
|           |            |            |            |            |              |                                       | I2C0_SCL       | 12              | IOD            |                   |
| 9         |            | 9          | 7          | 6          |              | PA3<br>PINCM6<br>0x40428014           | PA3            | 1               | IO             | HSIO (high-speed) |
|           |            |            |            |            |              |                                       | TIMG8_C0       | 2               | IO             |                   |
|           |            |            |            |            |              |                                       | SPI0_CS1       | 3               | IO             |                   |
|           |            |            |            |            |              |                                       | I2C1_SDA       | 4               | IOD            |                   |
|           |            |            |            |            |              |                                       | TIMA0_C1       | 5               | IO             |                   |
|           |            |            |            |            |              |                                       | TIMG2_C0       | 7               | IO             |                   |
|           |            |            |            |            |              |                                       | TIMA0_C2       | 8               | IO             |                   |
|           |            |            |            |            |              |                                       | UART2_CTS      | 9               | I              |                   |
|           |            |            |            |            |              |                                       | UART1_TX       | 10              | O              |                   |
|           |            |            |            |            |              |                                       | SPI0_CS3       | 11              | IO             |                   |
|           |            |            |            |            |              |                                       | I2C0_SDA       | 12              | IOD            |                   |
|           |            |            |            |            |              |                                       | LFXIN          | (Non-IOMUX 1) 0 | A              |                   |
| 10        | 7          | 10         | 8          | 7          | 9            | PA4<br>PINCM7<br>0x40428018           | PA4            | 1               | IO             | HSIO (high-speed) |
|           |            |            |            |            |              |                                       | TIMG8_C1       | 2               | IO             |                   |
|           |            |            |            |            |              |                                       | SPI0_POCI      | 3               | IO             |                   |
|           |            |            |            |            |              |                                       | I2C1_SCL       | 4               | IOD            |                   |
|           |            |            |            |            |              |                                       | TIMA0_C1N      | 5               | O              |                   |
|           |            |            |            |            |              |                                       | TIMG2_C1       | 7               | IO             |                   |
|           |            |            |            |            |              |                                       | TIMA0_C3       | 8               | IO             |                   |
|           |            |            |            |            |              |                                       | UART2_RTS      | 9               | O              |                   |
|           |            |            |            |            |              |                                       | UART1_RX       | 10              | I              |                   |
|           |            |            |            |            |              |                                       | SPI0_CS0       | 11              | IO             |                   |
|           |            |            |            |            |              |                                       | TIMA0_CON      | 12              | O              |                   |
|           |            |            |            |            |              |                                       | HFCLKIN        | 13              | I              |                   |
|           |            |            |            |            |              |                                       | LFXOUT         | (Non-IOMUX 1) 0 | A              |                   |
| 11        |            | 11         | 9          |            |              | PA5<br>PINCM8<br>0x4042801c           | PA5            | 1               | IO             | HSIO (high-speed) |
|           |            |            |            |            |              |                                       | TIMG8_C0       | 2               | IO             |                   |
|           |            |            |            |            |              |                                       | SPI0_PICO      | 3               | IO             |                   |
|           |            |            |            |            |              |                                       | I2C1_SDA       | 4               | IOD            |                   |
|           |            |            |            |            |              |                                       | TIMG14_C0      | 5               | IO             |                   |
|           |            |            |            |            |              |                                       | FCC_IN         | 6               | I              |                   |
|           |            |            |            |            |              |                                       | TIMG1_C0       | 7               | IO             |                   |
|           |            |            |            |            |              |                                       | TIMA_FAL1      | 8               | I              |                   |
|           |            |            |            |            |              |                                       | UART0_CTS      | 9               | I              |                   |
|           |            |            |            |            |              |                                       | UART1_TX       | 11              | O              |                   |
|           |            |            |            |            |              |                                       | TIMA0_C1       | 12              | IO             |                   |

**Table 6-2. Pin Attributes (PT, RUK, RGZ, RHB, RGE, DGS20 Packages) (continued)**

| PT<br>PIN | RUK<br>PIN | RGZ<br>PIN | RHB<br>PIN | RGE<br>PIN | DGS20<br>PIN | PIN NAME/<br>IOMUX REG/<br>IOMUX ADDR | SIGNAL<br>NAME | IOMUX<br>PF | SIGNAL<br>TYPE | BUFFER<br>TYPE    |
|-----------|------------|------------|------------|------------|--------------|---------------------------------------|----------------|-------------|----------------|-------------------|
| 12        |            | 12         | 10         |            | 10           | PA6<br>PINCM9<br>0x40428020           | PA6            | 1           | IO             | HSIO (high-speed) |
|           |            |            |            |            |              |                                       | TIMG8_C1       | 2           | IO             |                   |
|           |            |            |            |            |              |                                       | SPI0_SCLK      | 3           | IOD            |                   |
|           |            |            |            |            |              |                                       | I2C1_SCL       | 4           | IOD            |                   |
|           |            |            |            |            |              |                                       | TIMG14_C1      | 5           | IO             |                   |
|           |            |            |            |            |              |                                       | HFCLKIN        | 6           | I              |                   |
|           |            |            |            |            |              |                                       | TIMG1_C1       | 7           | IO             |                   |
|           |            |            |            |            |              |                                       | TIMA_FAL0      | 8           | I              |                   |
|           |            |            |            |            |              |                                       | UART0_RTS      | 9           | O              |                   |
|           |            |            |            |            |              |                                       | TIMA0_C2N      | 10          | O              |                   |
|           |            |            |            |            |              |                                       | UART1_RX       | 11          | I              |                   |
|           |            |            |            |            |              |                                       | TIMA0_C2       | 12          | IO             |                   |
|           |            |            |            |            |              |                                       | I2C0_SDA       | 13          | IOD            |                   |
|           |            |            |            |            |              |                                       | BEEP           | 14          | O              |                   |
| 13        |            | 13         | 11         |            |              | PA7<br>PINCM10<br>0x40428024          | PA7            | 1           | IO             | HSIO (high-speed) |
|           |            |            |            |            |              |                                       | CLK_OUT        | 2           | O              |                   |
|           |            |            |            |            |              |                                       | TIMG8_C0       | 3           | IO             |                   |
|           |            |            |            |            |              |                                       | TIMA0_C2       | 4           | IO             |                   |
|           |            |            |            |            |              |                                       | TIMG8_IDX      | 5           | I              |                   |
|           |            |            |            |            |              |                                       | TIMG2_C1       | 6           | IO             |                   |
|           |            |            |            |            |              |                                       | TIMA0_C1       | 7           | IO             |                   |
|           |            |            |            |            |              |                                       | SPI0_CS2       | 8           | IO             |                   |
|           |            |            |            |            |              |                                       | FCC_IN         | 9           | I              |                   |
|           |            |            |            |            |              |                                       | SPI0_POCI      | 10          | IO             |                   |
|           |            |            |            |            |              |                                       | SPI0_PICO      | 11          | IO             |                   |
|           |            |            |            |            |              |                                       | UART1_TX       | 12          | O              |                   |
|           |            |            |            |            |              |                                       | TIMG1_C0       | 13          | IO             |                   |
| 16        |            | 16         | 12         |            |              | PA8<br>PINCM13<br>0x40428030          | PA8            | 1           | IO             | HSIO (high-speed) |
|           |            |            |            |            |              |                                       | UART1_TX       | 2           | O              |                   |
|           |            |            |            |            |              |                                       | SPI0_CS0       | 3           | IO             |                   |
|           |            |            |            |            |              |                                       | I2C0_SDA       | 4           | IOD            |                   |
|           |            |            |            |            |              |                                       | TIMA0_C0       | 5           | IO             |                   |
|           |            |            |            |            |              |                                       | TIMA_FAL2      | 6           | I              |                   |
|           |            |            |            |            |              |                                       | TIMA_FAL0      | 7           | I              |                   |
|           |            |            |            |            |              |                                       | SPI0_CS3       | 8           | IO             |                   |
|           |            |            |            |            |              |                                       | TIMG2_C1       | 9           | IO             |                   |
|           |            |            |            |            |              |                                       | HFCLKIN        | 10          | I              |                   |
|           |            |            |            |            |              |                                       | UART0_RTS      | 11          | O              |                   |
|           |            |            |            |            |              |                                       | SPI0_SCLK      | 12          | IOD            |                   |
|           |            |            |            |            |              |                                       | UART1_RX       | 13          | I              |                   |
|           |            |            |            |            |              |                                       | TIMA0_C3N      | 14          | O              |                   |

**Table 6-2. Pin Attributes (PT, RUK, RGZ, RHB, RGE, DGS20 Packages) (continued)**

| PT<br>PIN | RUK<br>PIN | RGZ<br>PIN | RHB<br>PIN | RGE<br>PIN | DGS20<br>PIN | PIN NAME/<br>IOMUX REG/<br>IOMUX ADDR | SIGNAL<br>NAME   | IOMUX<br>PF     | SIGNAL<br>TYPE | BUFFER<br>TYPE     |
|-----------|------------|------------|------------|------------|--------------|---------------------------------------|------------------|-----------------|----------------|--------------------|
| 17        |            | 17         | 13         | 8          |              | PA9<br>PINCM14<br>0x40428034          | PA9              | 1               | IO             | HSIO (high-speed)  |
|           |            |            |            |            |              |                                       | UART1_RX         | 2               | I              |                    |
|           |            |            |            |            |              |                                       | SPI0_PICO        | 3               | IO             |                    |
|           |            |            |            |            |              |                                       | I2C0_SCL         | 4               | IOD            |                    |
|           |            |            |            |            |              |                                       | TIMA0_C0N        | 5               | O              |                    |
|           |            |            |            |            |              |                                       | CLK_OUT          | 6               | O              |                    |
|           |            |            |            |            |              |                                       | TIMA0_C1         | 7               | IO             |                    |
|           |            |            |            |            |              |                                       | RTC_OUT          | 8               | O              |                    |
|           |            |            |            |            |              |                                       | TIMG2_C0         | 9               | IO             |                    |
|           |            |            |            |            |              |                                       | SPI0_POCI        | 10              | IO             |                    |
|           |            |            |            |            |              |                                       | UART0_CTS        | 11              | I              |                    |
|           |            |            |            |            |              |                                       | TIMA_FAL1        | 12              | I              |                    |
|           |            |            |            |            |              |                                       | TIMG1_C1         | 13              | IO             |                    |
| 18        |            | 18         | 14         | 9          |              | PA10<br>PINCM15<br>0x40428038         | PA10             | 1               | IO             | SDIO<br>(standard) |
|           |            |            |            |            |              |                                       | UART0_TX         | 2               | O              |                    |
|           |            |            |            |            |              |                                       | SPI0_POCI        | 3               | IO             |                    |
|           |            |            |            |            |              |                                       | I2C0_SDA         | 4               | IOD            |                    |
|           |            |            |            |            |              |                                       | TIMA0_C2         | 5               | IO             |                    |
|           |            |            |            |            |              |                                       | CLK_OUT          | 6               | O              |                    |
|           |            |            |            |            |              |                                       | TIMG14_C0        | 7               | IO             |                    |
|           |            |            |            |            |              |                                       | I2C1_SDA         | 8               | IOD            |                    |
|           |            |            |            |            |              |                                       | TIMA_FAL1        | 10              | I              |                    |
|           |            |            |            |            |              |                                       | TIMA0_C1N        | 12              | O              |                    |
|           |            |            |            |            |              |                                       | TIMG8_C1         | 13              | IO             |                    |
|           |            |            |            |            |              |                                       | SPI0_PICO        | 14              | IO             |                    |
| 19        | 9          | 19         | 15         | 10         | 11           | PA11<br>PINCM16<br>0x4042803c         | PA11             | 1               | IO             | HSIO (high-speed)  |
|           |            |            |            |            |              |                                       | UART0_RX         | 2               | IO             |                    |
|           |            |            |            |            |              |                                       | SPI0_SCLK        | 3               | IOD            |                    |
|           |            |            |            |            |              |                                       | I2C0_SCL         | 4               | IOD            |                    |
|           |            |            |            |            |              |                                       | TIMA0_C2N        | 5               | O              |                    |
|           |            |            |            |            |              |                                       | UART1_RX         | 6               | I              |                    |
|           |            |            |            |            |              |                                       | TIMG14_C1        | 7               | IO             |                    |
|           |            |            |            |            |              |                                       | I2C1_SCL         | 8               | IOD            |                    |
|           |            |            |            |            |              |                                       | TIMA_FAL0        | 10              | I              |                    |
|           |            |            |            |            |              |                                       | SPI0_CS0         | 12              | IO             |                    |
|           |            |            |            |            |              |                                       | BSL_invoke_flash | 13              | I              |                    |
|           |            |            |            |            |              |                                       | ADC0_25          | (Non-IOMUX 1) 0 | A              |                    |

**Table 6-2. Pin Attributes (PT, RUK, RGZ, RHB, RGE, DGS20 Packages) (continued)**

| PT<br>PIN | RUK<br>PIN | RGZ<br>PIN | RHB<br>PIN | RGE<br>PIN | DGS20<br>PIN | PIN NAME/<br>IOMUX REG/<br>IOMUX ADDR | SIGNAL<br>NAME | IOMUX<br>PF     | SIGNAL<br>TYPE | BUFFER<br>TYPE     |
|-----------|------------|------------|------------|------------|--------------|---------------------------------------|----------------|-----------------|----------------|--------------------|
| 27        |            | 27         | 16         |            |              | PA12<br>PINCM24<br>0x4042805c         | PA12           | 1               | IO             | SDIO<br>(standard) |
|           |            |            |            |            |              |                                       | SPI0_SCLK      | 2               | IOD            |                    |
|           |            |            |            |            |              |                                       | TIMA0_C3       | 4               | IO             |                    |
|           |            |            |            |            |              |                                       | FCC_IN         | 5               | I              |                    |
|           |            |            |            |            |              |                                       | TIMG14_C0      | 6               | IO             |                    |
|           |            |            |            |            |              |                                       | SPI0_CS1       | 8               | IO             |                    |
|           |            |            |            |            |              |                                       | UART2_CTS      | 9               | I              |                    |
|           |            |            |            |            |              |                                       | UART1_CTS      | 10              | I              |                    |
|           |            |            |            |            |              |                                       | TIMA0_C3N      | 11              | O              |                    |
|           |            |            |            |            |              |                                       | I2C1_SCL       | 12              | IOD            |                    |
|           |            |            |            |            |              |                                       | TIMG2_C1       | 13              | IO             |                    |
|           |            |            |            |            |              |                                       | ADC0_18        | (Non-IOMUX 1) 0 | A              |                    |
| 28        |            | 28         | 17         |            |              | PA13<br>PINCM25<br>0x40428060         | PA13           | 1               | IO             | SDIO<br>(standard) |
|           |            |            |            |            |              |                                       | SPI0_POCI      | 3               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMA0_C2N      | 4               | O              |                    |
|           |            |            |            |            |              |                                       | TIMA0_C3N      | 5               | O              |                    |
|           |            |            |            |            |              |                                       | RTC_OUT        | 6               | O              |                    |
|           |            |            |            |            |              |                                       | TIMG14_C1      | 7               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMG14_C3      | 8               | IO             |                    |
|           |            |            |            |            |              |                                       | SPI0_CS3       | 9               | IO             |                    |
|           |            |            |            |            |              |                                       | UART2_TX       | 10              | O              |                    |
|           |            |            |            |            |              |                                       | UART1_RTS      | 11              | O              |                    |
|           |            |            |            |            |              |                                       | SPI0_CS0       | 12              | IO             |                    |
|           |            |            |            |            |              |                                       | TIMG8_C1       | 13              | IO             |                    |
|           |            |            |            |            |              |                                       | TIMA0_C1       | 14              | IO             |                    |
|           |            |            |            |            |              |                                       | ADC0_17        | (Non-IOMUX 1) 0 | A              |                    |
| 29        |            | 29         | 18         |            |              | PA14<br>PINCM26<br>0x40428064         | PA14           | 1               | IO             | SDIO<br>(standard) |
|           |            |            |            |            |              |                                       | UART0_CTS      | 2               | I              |                    |
|           |            |            |            |            |              |                                       | SPI0_PICO      | 3               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMG1_C0       | 4               | IO             |                    |
|           |            |            |            |            |              |                                       | CLK_OUT        | 6               | O              |                    |
|           |            |            |            |            |              |                                       | SPI0_CS2       | 9               | IO             |                    |
|           |            |            |            |            |              |                                       | UART2_RX       | 10              | I              |                    |
|           |            |            |            |            |              |                                       | I2C0_SCL       | 12              | IOD            |                    |
|           |            |            |            |            |              |                                       | UART0_TX       | 13              | O              |                    |
|           |            |            |            |            |              |                                       | TIMA0_C2       | 14              | IO             |                    |
| 30        |            | 30         | 19         | 11         |              | PA15<br>PINCM27<br>0x40428068         | ADC0_16        | (Non-IOMUX 1) 0 | A              | SDIO<br>(standard) |
|           |            |            |            |            |              |                                       | PA15           | 1               | IO             |                    |
|           |            |            |            |            |              |                                       | UART0_RTS      | 2               | O              |                    |
|           |            |            |            |            |              |                                       | SPI0_CS2       | 3               | IO             |                    |
|           |            |            |            |            |              |                                       | I2C1_SCL       | 4               | IOD            |                    |
|           |            |            |            |            |              |                                       | TIMA0_C2       | 5               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMG8_IDX      | 7               | I              |                    |
|           |            |            |            |            |              |                                       | UART2_RTS      | 10              | O              |                    |
|           |            |            |            |            |              |                                       | ADC0_15        | (Non-IOMUX 1) 0 | A              |                    |

**Table 6-2. Pin Attributes (PT, RUK, RGZ, RHB, RGE, DGS20 Packages) (continued)**

| PT<br>PIN | RUK<br>PIN | RGZ<br>PIN | RHB<br>PIN | RGE<br>PIN | DGS20<br>PIN | PIN NAME/<br>IOMUX REG/<br>IOMUX ADDR | SIGNAL<br>NAME | IOMUX<br>PF     | SIGNAL<br>TYPE | BUFFER<br>TYPE        |
|-----------|------------|------------|------------|------------|--------------|---------------------------------------|----------------|-----------------|----------------|-----------------------|
| 31        | 10         | 31         | 20         | 12         | 12           | PA16<br>PINCM28<br>0x4042806c         | PA16           | 1               | IO             | SDIO<br>(standard)    |
|           |            |            |            |            |              |                                       | SPI0_POCI      | 3               | IO             |                       |
|           |            |            |            |            |              |                                       | I2C1_SDA       | 4               | IOD            |                       |
|           |            |            |            |            |              |                                       | TIMA0_C2N      | 5               | O              |                       |
|           |            |            |            |            |              |                                       | FCC_IN         | 7               | I              |                       |
|           |            |            |            |            |              |                                       | UART2_CTS      | 10              | I              |                       |
|           |            |            |            |            |              |                                       | TIMG14_C2      | 12              | IO             |                       |
|           |            |            |            |            |              |                                       | ADC0_14        | (Non-IOMUX 1) 0 | A              |                       |
| 32        | 11         | 32         | 21         | 13         | 13           | PA17<br>PINCM29<br>0x40428070         | PA17           | 1               | IO             | HSIO (high-<br>speed) |
|           |            |            |            |            |              |                                       | UART1_TX       | 2               | O              |                       |
|           |            |            |            |            |              |                                       | TIMA0_C2       | 3               | IO             |                       |
|           |            |            |            |            |              |                                       | I2C1_SCL       | 4               | IOD            |                       |
|           |            |            |            |            |              |                                       | TIMA0_C3       | 5               | IO             |                       |
|           |            |            |            |            |              |                                       | TIMG2_C0       | 6               | IO             |                       |
|           |            |            |            |            |              |                                       | TIMG8_C0       | 7               | IO             |                       |
|           |            |            |            |            |              |                                       | TIMA0_C0N      | 8               | O              |                       |
|           |            |            |            |            |              |                                       | SPI0_CS1       | 9               | IO             |                       |
|           |            |            |            |            |              |                                       | SPI0_SCLK      | 10              | IOD            |                       |
|           |            |            |            |            |              |                                       | UART0_RX       | 12              | IO             |                       |
|           |            |            |            |            |              |                                       | ADC0_13        | (Non-IOMUX 1) 0 | A              |                       |
| 33        | 12         | 33         | 22         | 14         | 14           | PA18<br>PINCM30<br>0x40428074         | PA18           | 1               | IO             | SDIO<br>(standard)    |
|           |            |            |            |            |              |                                       | UART1_RX       | 2               | I              |                       |
|           |            |            |            |            |              |                                       | UART1_RTS      | 3               | O              |                       |
|           |            |            |            |            |              |                                       | I2C1_SDA       | 4               | IOD            |                       |
|           |            |            |            |            |              |                                       | TIMA0_C3N      | 5               | O              |                       |
|           |            |            |            |            |              |                                       | TIMG2_C1       | 6               | IO             |                       |
|           |            |            |            |            |              |                                       | TIMG8_C1       | 7               | IO             |                       |
|           |            |            |            |            |              |                                       | SPI0_PICO      | 8               | IO             |                       |
|           |            |            |            |            |              |                                       | SPI0_CS0       | 9               | IO             |                       |
|           |            |            |            |            |              |                                       | UART0_CTS      | 10              | I              |                       |
|           |            |            |            |            |              |                                       | TIMA0_C0       | 11              | IO             |                       |
|           |            |            |            |            |              |                                       | SPI0_POCI      | 12              | IO             |                       |
|           |            |            |            |            |              |                                       | TIMA_FAL2      | 13              | I              |                       |
|           |            |            |            |            |              |                                       | CLK_OUT        | 14              | O              |                       |
|           |            |            |            |            |              |                                       | ADC0_12        | (Non-IOMUX 1) 0 | A              |                       |
| 34        | 13         | 34         | 23         | 15         | 15           | PA19<br>PINCM31<br>0x40428078         | PA19           | 1               | IO             | HSIO (high-<br>speed) |
|           |            |            |            |            |              |                                       | SWDIO          | 2               | IO             |                       |
|           |            |            |            |            |              |                                       | SPI0_SCLK      | 3               | IOD            |                       |
|           |            |            |            |            |              |                                       | I2C1_SDA       | 4               | IOD            |                       |
|           |            |            |            |            |              |                                       | TIMA0_C2       | 5               | IO             |                       |
|           |            |            |            |            |              |                                       | TIMG14_C0      | 6               | IO             |                       |
|           |            |            |            |            |              |                                       | SPI0_POCI      | 7               | IO             |                       |
|           |            |            |            |            |              |                                       | UART0_CTS      | 8               | I              |                       |
|           |            |            |            |            |              |                                       | UART0_RTS      | 12              | O              |                       |
|           |            |            |            |            |              |                                       | SPI0_PICO      | 13              | IO             |                       |
|           |            |            |            |            |              |                                       | ADC0_22        | (Non-IOMUX 1) 0 | A              |                       |

**Table 6-2. Pin Attributes (PT, RUK, RGZ, RHB, RGE, DGS20 Packages) (continued)**

| PT<br>PIN | RUK<br>PIN | RGZ<br>PIN | RHB<br>PIN | RGE<br>PIN | DGS20<br>PIN | PIN NAME/<br>IOMUX REG/<br>IOMUX ADDR | SIGNAL<br>NAME | IOMUX<br>PF     | SIGNAL<br>TYPE | BUFFER<br>TYPE    |
|-----------|------------|------------|------------|------------|--------------|---------------------------------------|----------------|-----------------|----------------|-------------------|
| 35        | 14         | 35         | 24         | 16         | 16           | PA20<br>PINCM32<br>0x4042807c         | PA20           | 1               | IO             | HSIO (high-speed) |
|           |            |            |            |            |              |                                       | SWCLK          | 2               | I              |                   |
|           |            |            |            |            |              |                                       | TIMA_FAL1      | 3               | I              |                   |
|           |            |            |            |            |              |                                       | I2C1_SCL       | 4               | IOD            |                   |
|           |            |            |            |            |              |                                       | TIMA0_C2N      | 5               | O              |                   |
|           |            |            |            |            |              |                                       | TIMG14_C1      | 6               | IO             |                   |
|           |            |            |            |            |              |                                       | SPI0_PICO      | 7               | IO             |                   |
|           |            |            |            |            |              |                                       | TIMA0_C0       | 8               | IO             |                   |
|           |            |            |            |            |              |                                       | UART0_RTS      | 9               | O              |                   |
|           |            |            |            |            |              |                                       | UART1_RX       | 13              | I              |                   |
|           |            |            |            |            |              |                                       | ADC0_4         | (Non-IOMUX 1) 0 | A              |                   |
| 39        |            | 39         | 25         | 17         |              | PA21<br>PINCM36<br>0x4042808c         | PA21           | 1               | IO             | SDIO (standard)   |
|           |            |            |            |            |              |                                       | UART2_TX       | 2               | O              |                   |
|           |            |            |            |            |              |                                       | SPI0_CS3       | 3               | IO             |                   |
|           |            |            |            |            |              |                                       | UART1_CTS      | 4               | I              |                   |
|           |            |            |            |            |              |                                       | TIMA0_C0       | 5               | IO             |                   |
|           |            |            |            |            |              |                                       | TIMG1_C0       | 6               | IO             |                   |
|           |            |            |            |            |              |                                       | UART2_CTS      | 8               | I              |                   |
|           |            |            |            |            |              |                                       | TIMG8_C0       | 10              | IO             |                   |
|           |            |            |            |            |              |                                       | TIMA0_C0N      | 12              | O              |                   |
|           |            |            |            |            |              |                                       | UART2_RX       | 13              | I              |                   |
|           |            |            |            |            |              |                                       | ADC0_8         | (Non-IOMUX 1) 0 | A              |                   |
| 40        | 15         | 40         | 26         | 18         | 17           | PA22<br>PINCM37<br>0x40428090         | PA22           | 1               | IO             | SDIO (standard)   |
|           |            |            |            |            |              |                                       | UART2_RX       | 2               | I              |                   |
|           |            |            |            |            |              |                                       | SPI0_CS2       | 3               | IO             |                   |
|           |            |            |            |            |              |                                       | UART1_RTS      | 4               | O              |                   |
|           |            |            |            |            |              |                                       | TIMA0_C0N      | 5               | O              |                   |
|           |            |            |            |            |              |                                       | TIMG1_C1       | 6               | IO             |                   |
|           |            |            |            |            |              |                                       | TIMA0_C1       | 7               | IO             |                   |
|           |            |            |            |            |              |                                       | CLK_OUT        | 8               | O              |                   |
|           |            |            |            |            |              |                                       | I2C0_SCL       | 9               | IOD            |                   |
|           |            |            |            |            |              |                                       | TIMG8_C1       | 10              | IO             |                   |
|           |            |            |            |            |              |                                       | UART1_RX       | 11              | I              |                   |
|           |            |            |            |            |              |                                       | SPI0_POCI      | 12              | IO             |                   |
|           |            |            |            |            |              |                                       | UART2_TX       | 13              | O              |                   |
|           |            |            |            |            |              |                                       | ADC0_7         | (Non-IOMUX 1) 0 | A              |                   |
|           |            |            |            |            |              |                                       | VREF-          | (Non-IOMUX 2) 0 | A              |                   |

**Table 6-2. Pin Attributes (PT, RUK, RGZ, RHB, RGE, DGS20 Packages) (continued)**

| PT<br>PIN | RUK<br>PIN | RGZ<br>PIN | RHB<br>PIN | RGE<br>PIN | DGS20<br>PIN | PIN NAME/<br>IOMUX REG/<br>IOMUX ADDR | SIGNAL<br>NAME | IOMUX<br>PF     | SIGNAL<br>TYPE | BUFFER<br>TYPE     |
|-----------|------------|------------|------------|------------|--------------|---------------------------------------|----------------|-----------------|----------------|--------------------|
| 43        | 16         | 43         | 27         | 19         | 18           | PA23<br>PINCM40<br>0x4042809c         | PA23           | 1               | IO             | HSIO (high-speed)  |
|           |            |            |            |            |              |                                       | UART2_TX       | 2               | O              |                    |
|           |            |            |            |            |              |                                       | SPI0_CS3       | 3               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMA0_C3       | 5               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMG8_C0       | 6               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMG2_C0       | 7               | IO             |                    |
|           |            |            |            |            |              |                                       | UART0_TX       | 8               | O              |                    |
|           |            |            |            |            |              |                                       | TIMG14_C0      | 9               | IO             |                    |
|           |            |            |            |            |              |                                       | SPI0_POCI      | 12              | IO             |                    |
|           |            |            |            |            |              |                                       | UART0_CTS      | 13              | I              |                    |
|           |            |            |            |            |              |                                       | ADC0_26        | (Non-IOMUX 1) 0 | A              |                    |
|           |            |            |            |            |              |                                       | VREF+          | (Non-IOMUX 2) 0 | A              |                    |
| 44        | 17         | 44         | 28         | 20         | 19           | PA24<br>PINCM41<br>0x404280a0         | PA24           | 1               | IO             | SDIO<br>(standard) |
|           |            |            |            |            |              |                                       | UART2_RX       | 2               | I              |                    |
|           |            |            |            |            |              |                                       | SPI0_CS2       | 3               | IO             |                    |
|           |            |            |            |            |              |                                       | UART0_RTS      | 4               | O              |                    |
|           |            |            |            |            |              |                                       | TIMA0_C3N      | 5               | O              |                    |
|           |            |            |            |            |              |                                       | TIMG8_C1       | 6               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMG2_C1       | 7               | IO             |                    |
|           |            |            |            |            |              |                                       | UART1_RX       | 8               | I              |                    |
|           |            |            |            |            |              |                                       | TIMG14_C1      | 9               | IO             |                    |
|           |            |            |            |            |              |                                       | SPI0_PICO      | 12              | IO             |                    |
|           |            |            |            |            |              |                                       | I2C0_SDA       | 13              | IOD            |                    |
|           |            |            |            |            |              |                                       | ADC0_3         | (Non-IOMUX 1) 0 | A              |                    |
| 45        | 18         | 45         | 29         | 21         | 20           | PA25<br>PINCM42<br>0x404280a4         | PA25           | 1               | IO             | SDIO<br>(standard) |
|           |            |            |            |            |              |                                       | SPI0_PICO      | 2               | IO             |                    |
|           |            |            |            |            |              |                                       | SPI0_POCI      | 3               | IO             |                    |
|           |            |            |            |            |              |                                       | SPI0_SCLK      | 4               | IOD            |                    |
|           |            |            |            |            |              |                                       | TIMA0_C3       | 5               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMA0_C1N      | 6               | O              |                    |
|           |            |            |            |            |              |                                       | TIMA0_C2       | 7               | IO             |                    |
|           |            |            |            |            |              |                                       | UART2_CTS      | 8               | I              |                    |
|           |            |            |            |            |              |                                       | TIMG14_C0      | 9               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMG1_C0       | 10              | IO             |                    |
|           |            |            |            |            |              |                                       | I2C0_SDA       | 11              | IOD            |                    |
|           |            |            |            |            |              |                                       | UART0_TX       | 12              | O              |                    |
|           |            |            |            |            |              |                                       | UART0_RTS      | 13              | O              |                    |
|           |            |            |            |            |              |                                       | I2C0_SCL       | 14              | IOD            |                    |
|           |            |            |            |            |              |                                       | ADC0_2         | (Non-IOMUX 1) 0 | A              |                    |

**Table 6-2. Pin Attributes (PT, RUK, RGZ, RHB, RGE, DGS20 Packages) (continued)**

| PT<br>PIN | RUK<br>PIN | RGZ<br>PIN | RHB<br>PIN | RGE<br>PIN | DGS20<br>PIN | PIN NAME/<br>IOMUX REG/<br>IOMUX ADDR | SIGNAL<br>NAME | IOMUX<br>PF     | SIGNAL<br>TYPE | BUFFER<br>TYPE     |
|-----------|------------|------------|------------|------------|--------------|---------------------------------------|----------------|-----------------|----------------|--------------------|
| 46        | 19         | 46         | 30         | 22         | 1            | PA26<br>PINCM43<br>0x404280a8         | PA26           | 1               | IO             | HSIO (high-speed)  |
|           |            |            |            |            |              |                                       | BEEP           | 2               | O              |                    |
|           |            |            |            |            |              |                                       | SPI0_POCI      | 3               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMG8_C0       | 4               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMA_FAL0      | 5               | I              |                    |
|           |            |            |            |            |              |                                       | TIMA0_C3N      | 6               | O              |                    |
|           |            |            |            |            |              |                                       | TIMG2_C0       | 7               | IO             |                    |
|           |            |            |            |            |              |                                       | UART2_RTS      | 8               | O              |                    |
|           |            |            |            |            |              |                                       | I2C0_SCL       | 9               | IOD            |                    |
|           |            |            |            |            |              |                                       | TIMG1_C1       | 10              | IO             |                    |
|           |            |            |            |            |              |                                       | UART0_RX       | 11              | IO             |                    |
|           |            |            |            |            |              |                                       | TIMA0_C0       | 12              | IO             |                    |
|           |            |            |            |            |              |                                       | I2C0_SDA       | 13              | IOD            |                    |
|           |            |            |            |            |              |                                       | UART1_CTS      | 14              | I              |                    |
|           |            |            |            |            |              |                                       | ADC0_1         | (Non-IOMUX 1) 0 | A              |                    |
| 47        | 20         | 47         | 31         |            | 2            | PA27<br>PINCM44<br>0x404280ac         | PA27           | 1               | IO             | HSIO (high-speed)  |
|           |            |            |            |            |              |                                       | SPI0_CS3       | 2               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMA0_CON      | 3               | O              |                    |
|           |            |            |            |            |              |                                       | TIMG8_C1       | 4               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMA_FAL2      | 5               | I              |                    |
|           |            |            |            |            |              |                                       | CLK_OUT        | 6               | O              |                    |
|           |            |            |            |            |              |                                       | TIMG2_C1       | 7               | IO             |                    |
|           |            |            |            |            |              |                                       | RTC_OUT        | 8               | O              |                    |
|           |            |            |            |            |              |                                       | UART1_CTS      | 9               | I              |                    |
|           |            |            |            |            |              |                                       | I2C0_SCL       | 10              | IOD            |                    |
|           |            |            |            |            |              |                                       | UART0_TX       | 11              | O              |                    |
|           |            |            |            |            |              |                                       | SPI0_POCI      | 12              | IO             |                    |
|           |            |            |            |            |              |                                       | LFCLKIN        | 14              | I              |                    |
|           |            |            |            |            |              |                                       | ADC0_0         | (Non-IOMUX 1) 0 | A              |                    |
| 3         | 3          | 3          | 2          | 1          | 5            | PA28<br>PINCM3<br>0x40428008          | PA28           | 1               | IO             | SDIO<br>(standard) |
|           |            |            |            |            |              |                                       | UART0_TX       | 2               | O              |                    |
|           |            |            |            |            |              |                                       | I2C0_SDA       | 3               | IOD            |                    |
|           |            |            |            |            |              |                                       | TIMA0_C3       | 4               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMA_FAL0      | 5               | I              |                    |
|           |            |            |            |            |              |                                       | TIMG2_C0       | 6               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMA0_C1       | 7               | IO             |                    |
|           |            |            |            |            |              |                                       | HFXIN          | (Non-IOMUX 1) 0 | A              |                    |
| 48        | 1          | 48         | 32         | 23         | 3            | PA30<br>PINCM45<br>0x404280b0         | PA30           | 1               | IO             | SDIO<br>(standard) |
|           |            |            |            |            |              |                                       | UART0_RX       | 4               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMG8_IDX      | 5               | I              |                    |
|           |            |            |            |            |              |                                       | TIMA0_C0       | 6               | IO             |                    |
|           |            |            |            |            |              |                                       | UART1_RTS      | 9               | O              |                    |
|           |            |            |            |            |              |                                       | TIMG2_C1       | 10              | IO             |                    |
|           |            |            |            |            |              |                                       | TIMG14_C2      | 11              | IO             |                    |
|           |            |            |            |            |              |                                       | I2C0_SDA       | 12              | IOD            |                    |

**Table 6-2. Pin Attributes (PT, RUK, RGZ, RHB, RGE, DGS20 Packages) (continued)**

| PT<br>PIN | RUK<br>PIN | RGZ<br>PIN | RHB<br>PIN | RGE<br>PIN | DGS20<br>PIN | PIN NAME/<br>IOMUX REG/<br>IOMUX ADDR | SIGNAL<br>NAME | IOMUX<br>PF     | SIGNAL<br>TYPE | BUFFER<br>TYPE        |
|-----------|------------|------------|------------|------------|--------------|---------------------------------------|----------------|-----------------|----------------|-----------------------|
| 5         |            | 5          |            |            |              | PA31<br>PINCM4<br>0x4042800c          | PA31           | 1               | IO             | SDIO<br>(standard)    |
|           |            |            |            |            |              |                                       | UART0_RX       | 2               | IO             |                       |
|           |            |            |            |            |              |                                       | I2C0_SCL       | 3               | IOD            |                       |
|           |            |            |            |            |              |                                       | TIMA0_C3N      | 4               | O              |                       |
|           |            |            |            |            |              |                                       | CLK_OUT        | 6               | O              |                       |
| 14        |            | 14         |            |            |              | PB2<br>PINCM11<br>0x40428028          | PB2            | 1               | IO             | HSIO (high-<br>speed) |
|           |            |            |            |            |              |                                       | UART2_CTS      | 3               | I              |                       |
|           |            |            |            |            |              |                                       | I2C1_SCL       | 4               | IOD            |                       |
|           |            |            |            |            |              |                                       | TIMA0_C3       | 5               | IO             |                       |
|           |            |            |            |            |              |                                       | UART1_CTS      | 6               | I              |                       |
|           |            |            |            |            |              |                                       | TIMG1_C0       | 7               | IO             |                       |
|           |            |            |            |            |              |                                       | UART2_TX       | 8               | O              |                       |
|           |            |            |            |            |              |                                       | HFCLKIN        | 10              | I              |                       |
|           |            |            |            |            |              |                                       | SPI0_PICO      | 11              | IO             |                       |
|           |            |            |            |            |              |                                       | UART1_RX       | 12              | I              |                       |
|           |            |            |            |            |              |                                       | TIMA0_C1N      | 13              | O              |                       |
| 15        | 8          | 15         |            |            |              | PB3<br>PINCM12<br>0x4042802c          | PB3            | 1               | IO             | HSIO (high-<br>speed) |
|           |            |            |            |            |              |                                       | TIMA_FAL0      | 2               | I              |                       |
|           |            |            |            |            |              |                                       | UART2_RTS      | 3               | O              |                       |
|           |            |            |            |            |              |                                       | I2C1_SDA       | 4               | IOD            |                       |
|           |            |            |            |            |              |                                       | TIMA0_C3N      | 5               | O              |                       |
|           |            |            |            |            |              |                                       | UART1_RTS      | 6               | O              |                       |
|           |            |            |            |            |              |                                       | TIMG1_C1       | 7               | IO             |                       |
|           |            |            |            |            |              |                                       | UART2_RX       | 8               | I              |                       |
|           |            |            |            |            |              |                                       | TIMG2_C1       | 9               | IO             |                       |
|           |            |            |            |            |              |                                       | TIMA0_C0       | 10              | IO             |                       |
|           |            |            |            |            |              |                                       | SPI0_SCLK      | 11              | IOD            |                       |
|           |            |            |            |            |              |                                       | SPI0_CS0       | 12              | IO             |                       |
|           |            |            |            |            |              |                                       | UART1_TX       | 13              | O              |                       |
|           |            |            |            |            |              |                                       | RTC_OUT        | 14              | O              |                       |
| 20        |            | 20         |            |            |              | PB6<br>PINCM17<br>0x40428040          | PB6            | 1               | IO             | SDIO<br>(standard)    |
|           |            |            |            |            |              |                                       | UART1_TX       | 2               | O              |                       |
|           |            |            |            |            |              |                                       | TIMG8_C0       | 5               | IO             |                       |
|           |            |            |            |            |              |                                       | UART2_CTS      | 6               | I              |                       |
|           |            |            |            |            |              |                                       | TIMG1_C0       | 7               | IO             |                       |
|           |            |            |            |            |              |                                       | TIMA_FAL2      | 8               | I              |                       |
|           |            |            |            |            |              |                                       | SPI0_CS1       | 9               | IO             |                       |
|           |            |            |            |            |              |                                       | TIMA0_C3N      | 11              | O              |                       |
|           |            |            |            |            |              |                                       | TIMG8_C1       | 12              | IO             |                       |
|           |            |            |            |            |              |                                       | TIMA0_C2N      | 13              | O              |                       |
|           |            |            |            |            |              |                                       | UART0_TX       | 14              | O              |                       |
|           |            |            |            |            |              |                                       | ADC0_24        | (Non-IOMUX 1) 0 | A              |                       |

**Table 6-2. Pin Attributes (PT, RUK, RGZ, RHB, RGE, DGS20 Packages) (continued)**

| PT PIN | RUK PIN | RGZ PIN | RHB PIN | RGE PIN | DGS20 PIN | PIN NAME/<br>IOMUX REG/<br>IOMUX ADDR | SIGNAL NAME | IOMUX PF        | SIGNAL TYPE | BUFFER TYPE        |
|--------|---------|---------|---------|---------|-----------|---------------------------------------|-------------|-----------------|-------------|--------------------|
| 21     |         | 21      |         |         |           | PB7<br>PINCM18<br>0x40428044          | PB7         | 1               | IO          | SDIO<br>(standard) |
|        |         |         |         |         |           |                                       | UART1_RX    | 2               | I           |                    |
|        |         |         |         |         |           |                                       | TIMG8_C1    | 5               | IO          |                    |
|        |         |         |         |         |           |                                       | UART2_RTS   | 6               | O           |                    |
|        |         |         |         |         |           |                                       | TIMG1_C1    | 7               | IO          |                    |
|        |         |         |         |         |           |                                       | SPI0_CS2    | 9               | IO          |                    |
|        |         |         |         |         |           |                                       | BEEP        | 12              | O           |                    |
|        |         |         |         |         |           |                                       | SPI0_SCLK   | 13              | IOD         |                    |
|        |         |         |         |         |           |                                       | UART0_RX    | 14              | IO          |                    |
|        |         |         |         |         |           |                                       | ADC0_23     | (Non-IOMUX 1) 0 | A           |                    |
| 22     |         | 22      |         |         |           | PB8<br>PINCM19<br>0x40428048          | PB8         | 1               | IO          | SDIO<br>(standard) |
|        |         |         |         |         |           |                                       | UART1_CTS   | 2               | I           |                    |
|        |         |         |         |         |           |                                       | TIMA0_C0    | 5               | IO          |                    |
|        |         |         |         |         |           |                                       | TIMG1_C0    | 7               | IO          |                    |
|        |         |         |         |         |           |                                       | SPI0_SCLK   | 9               | IOD         |                    |
|        |         |         |         |         |           |                                       | BEEP        | 10              | O           |                    |
|        |         |         |         |         |           |                                       | TIMG8_C0    | 11              | IO          |                    |
|        |         |         |         |         |           |                                       | UART0_RX    | 12              | IO          |                    |
|        |         |         |         |         |           |                                       | SPI0_POCI   | 13              | IO          |                    |
|        |         |         |         |         |           |                                       | I2C0_SCL    | 14              | IOD         |                    |
| 23     |         | 23      |         |         |           | PB9<br>PINCM20<br>0x4042804c          | PB9         | 1               | IO          | SDIO<br>(standard) |
|        |         |         |         |         |           |                                       | UART1_RTS   | 2               | O           |                    |
|        |         |         |         |         |           |                                       | TIMA0_C0N   | 5               | O           |                    |
|        |         |         |         |         |           |                                       | TIMA0_C1    | 6               | IO          |                    |
|        |         |         |         |         |           |                                       | TIMG1_C1    | 7               | IO          |                    |
|        |         |         |         |         |           |                                       | TIMG2_C0    | 8               | IO          |                    |
|        |         |         |         |         |           |                                       | SPI0_POCI   | 10              | IO          |                    |
|        |         |         |         |         |           |                                       | UART0_RX    | 11              | IO          |                    |
|        |         |         |         |         |           |                                       | I2C0_SCL    | 12              | IOD         |                    |
|        |         |         |         |         |           |                                       | UART0_TX    | 13              | O           |                    |
| 24     |         | 24      |         |         |           | PB14<br>PINCM21<br>0x40428050         | PB14        | 1               | IO          | SDIO<br>(standard) |
|        |         |         |         |         |           |                                       | TIMA0_C0    | 5               | IO          |                    |
|        |         |         |         |         |           |                                       | TIMG8_IDX   | 6               | I           |                    |
|        |         |         |         |         |           |                                       | SPI0_CS3    | 7               | IO          |                    |
|        |         |         |         |         |           |                                       | TIMG2_C1    | 8               | IO          |                    |
|        |         |         |         |         |           |                                       | I2C0_SDA    | 9               | IOD         |                    |
|        |         |         |         |         |           |                                       | SPI0_PICO   | 10              | IO          |                    |
|        |         |         |         |         |           |                                       | UART0_TX    | 11              | O           |                    |
|        |         |         |         |         |           |                                       | TIMA_FAL2   | 12              | I           |                    |
|        |         |         |         |         |           |                                       | TIMA_FAL0   | 13              | I           |                    |
|        |         |         |         |         |           |                                       | TIMG14_C2   | 14              | IO          |                    |
|        |         |         |         |         |           |                                       | ADC0_21     | (Non-IOMUX 1) 0 | A           |                    |

**Table 6-2. Pin Attributes (PT, RUK, RGZ, RHB, RGE, DGS20 Packages) (continued)**

| PT<br>PIN | RUK<br>PIN | RGZ<br>PIN | RHB<br>PIN | RGE<br>PIN | DGS20<br>PIN | PIN NAME/<br>IOMUX REG/<br>IOMUX ADDR | SIGNAL<br>NAME | IOMUX<br>PF     | SIGNAL<br>TYPE | BUFFER<br>TYPE     |
|-----------|------------|------------|------------|------------|--------------|---------------------------------------|----------------|-----------------|----------------|--------------------|
| 25        |            | 25         |            |            |              | PB15<br>PINCM22<br>0x40428054         | PB15           | 1               | IO             | SDIO<br>(standard) |
|           |            |            |            |            |              |                                       | UART2_TX       | 2               | O              |                    |
|           |            |            |            |            |              |                                       | TIMG8_C0       | 5               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMG2_C0       | 6               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMA0_C1N      | 12              | O              |                    |
|           |            |            |            |            |              |                                       | UART1_TX       | 13              | O              |                    |
|           |            |            |            |            |              |                                       | TIMG2_C1       | 14              | IO             |                    |
|           |            |            |            |            |              |                                       | ADC0_20        | (Non-IOMUX 1) 0 | A              |                    |
| 26        |            | 26         |            |            |              | PB16<br>PINCM23<br>0x40428058         | PB16           | 1               | IO             | SDIO<br>(standard) |
|           |            |            |            |            |              |                                       | UART2_RX       | 2               | I              |                    |
|           |            |            |            |            |              |                                       | TIMG8_C1       | 5               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMG2_C1       | 6               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMA0_C2N      | 12              | O              |                    |
|           |            |            |            |            |              |                                       | UART1_RX       | 13              | I              |                    |
|           |            |            |            |            |              |                                       | I2C1_SDA       | 14              | IOD            |                    |
|           |            |            |            |            |              |                                       | ADC0_19        | (Non-IOMUX 1) 0 | A              |                    |
| 36        |            | 36         |            |            |              | PB17<br>PINCM33<br>0x40428080         | PB17           | 1               | IO             | SDIO<br>(standard) |
|           |            |            |            |            |              |                                       | UART2_TX       | 2               | O              |                    |
|           |            |            |            |            |              |                                       | SPI0_PICO      | 3               | IO             |                    |
|           |            |            |            |            |              |                                       | I2C0_SCL       | 4               | IOD            |                    |
|           |            |            |            |            |              |                                       | TIMA0_C2       | 5               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMG14_C0      | 6               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMG1_C0       | 9               | IO             |                    |
|           |            |            |            |            |              |                                       | SPI0_CS0       | 10              | IO             |                    |
|           |            |            |            |            |              |                                       | UART1_RX       | 11              | I              |                    |
|           |            |            |            |            |              |                                       | UART1_TX       | 13              | O              |                    |
|           |            |            |            |            |              |                                       | UART0_RTS      | 14              | O              |                    |
|           |            |            |            |            |              |                                       | ADC0_11        | (Non-IOMUX 1) 0 | A              |                    |
| 37        |            | 37         |            |            |              | PB18<br>PINCM34<br>0x40428084         | PB18           | 1               | IO             | SDIO<br>(standard) |
|           |            |            |            |            |              |                                       | UART2_RX       | 2               | I              |                    |
|           |            |            |            |            |              |                                       | SPI0_SCLK      | 3               | IOD            |                    |
|           |            |            |            |            |              |                                       | I2C0_SDA       | 4               | IOD            |                    |
|           |            |            |            |            |              |                                       | TIMA0_C2N      | 5               | O              |                    |
|           |            |            |            |            |              |                                       | TIMG14_C1      | 6               | IO             |                    |
|           |            |            |            |            |              |                                       | SPI0_CS0       | 7               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMG1_C1       | 9               | IO             |                    |
|           |            |            |            |            |              |                                       | TIMA0_C1       | 12              | IO             |                    |
|           |            |            |            |            |              |                                       | UART0_RTS      | 13              | O              |                    |
|           |            |            |            |            |              |                                       | ADC0_10        | (Non-IOMUX 1) 0 | A              |                    |

**Table 6-2. Pin Attributes (PT, RUK, RGZ, RHB, RGE, DGS20 Packages) (continued)**

| PT PIN | RUK PIN | RGZ PIN | RHB PIN | RGE PIN | DGS20 PIN | PIN NAME/<br>IOMUX REG/<br>IOMUX ADDR | SIGNAL NAME | IOMUX PF        | SIGNAL TYPE | BUFFER TYPE        |
|--------|---------|---------|---------|---------|-----------|---------------------------------------|-------------|-----------------|-------------|--------------------|
| 38     |         | 38      |         |         |           | PB19<br>PINCM35<br>0x40428088         | PB19        | 1               | IO          | SDIO<br>(standard) |
|        |         |         |         |         |           |                                       | SPI0_POCI   | 3               | IO          |                    |
|        |         |         |         |         |           |                                       | TIMG8_C1    | 4               | IO          |                    |
|        |         |         |         |         |           |                                       | UART0_CTS   | 5               | I           |                    |
|        |         |         |         |         |           |                                       | TIMG2_C1    | 6               | IO          |                    |
|        |         |         |         |         |           |                                       | TIMG8_IDX   | 7               | I           |                    |
|        |         |         |         |         |           |                                       | UART2_CTS   | 8               | I           |                    |
|        |         |         |         |         |           |                                       | TIMA0_C1N   | 12              | O           |                    |
|        |         |         |         |         |           |                                       | UART2_RX    | 13              | I           |                    |
|        |         |         |         |         |           |                                       | ADC0_9      | (Non-IOMUX 1) 0 | A           |                    |
| 41     |         | 41      |         |         |           | PB20<br>PINCM38<br>0x40428094         | PB20        | 1               | IO          | SDIO<br>(standard) |
|        |         |         |         |         |           |                                       | SPI0_CS2    | 2               | IO          |                    |
|        |         |         |         |         |           |                                       | TIMA0_C2    | 5               | IO          |                    |
|        |         |         |         |         |           |                                       | TIMA_FAL1   | 6               | I           |                    |
|        |         |         |         |         |           |                                       | TIMA0_C1    | 7               | IO          |                    |
|        |         |         |         |         |           |                                       | UART2_RTS   | 8               | O           |                    |
|        |         |         |         |         |           |                                       | I2C0_SDA    | 9               | IOD         |                    |
|        |         |         |         |         |           |                                       | UART1_CTS   | 12              | I           |                    |
|        |         |         |         |         |           |                                       | TIMA0_C2N   | 13              | O           |                    |
|        |         |         |         |         |           |                                       | TIMG8_C1    | 14              | IO          |                    |
|        |         |         |         |         |           |                                       | ADC0_6      | (Non-IOMUX 1) 0 | A           |                    |
| 42     |         | 42      |         |         |           | PB24<br>PINCM39<br>0x40428098         | PB24        | 1               | IO          | SDIO<br>(standard) |
|        |         |         |         |         |           |                                       | SPI0_CS3    | 2               | IO          |                    |
|        |         |         |         |         |           |                                       | SPI0_CS1    | 3               | IO          |                    |
|        |         |         |         |         |           |                                       | TIMA0_C3    | 5               | IO          |                    |
|        |         |         |         |         |           |                                       | TIMA0_C1N   | 6               | O           |                    |
|        |         |         |         |         |           |                                       | UART2_RTS   | 8               | O           |                    |
|        |         |         |         |         |           |                                       | SPI0_SCLK   | 12              | IOD         |                    |
|        |         |         |         |         |           |                                       | TIMG14_C2   | 13              | IO          |                    |
|        |         |         |         |         |           |                                       | UART0_RTS   | 14              | O           |                    |
|        |         |         |         |         |           |                                       | ADC0_5      | (Non-IOMUX 1) 0 | A           |                    |
| 6      | 4       | 6       | 4       | 3       | 6         | VDD                                   | VDD         | (Non-IOMUX 1) 0 | PWR         | PWR                |
| 7      | 5       | 7       | 5       | 4       | 7         | VSS                                   | VSS         | (Non-IOMUX 1) 0 | PWR         | PWR                |

## 6.3 Signal Descriptions

**Table 6-3. Analog to Digital Converter (ADC) Signal Descriptions**

| SIGNAL NAME | PIN TYPE | DESCRIPTION                 | PT PIN | RUK PIN | RGZ PIN | RHB PIN | RGE PIN | DGS20 PIN |
|-------------|----------|-----------------------------|--------|---------|---------|---------|---------|-----------|
| ADC0_0      | A        | ADC0 analog input channel 0 | 47     | 20      | 47      | 31      |         | 2         |
| ADC0_1      | A        | ADC0 analog input channel 1 | 46     | 19      | 46      | 30      | 22      | 1         |
| ADC0_2      | A        | ADC0 analog input channel 2 | 45     | 18      | 45      | 29      | 21      | 20        |
| ADC0_3      | A        | ADC0 analog input channel 3 | 44     | 17      | 44      | 28      | 20      | 19        |
| ADC0_4      | A        | ADC0 analog input channel 4 | 35     | 14      | 35      | 24      | 16      | 16        |
| ADC0_5      | A        | ADC0 analog input channel 5 | 42     |         | 42      |         |         |           |
| ADC0_6      | A        | ADC0 analog input channel 6 | 41     |         | 41      |         |         |           |
| ADC0_7      | A        | ADC0 analog input channel 7 | 40     | 15      | 40      | 26      | 18      | 17        |
| ADC0_8      | A        | ADC0 analog input channel 8 | 39     |         | 39      | 25      | 17      |           |

**Table 6-3. Analog to Digital Converter (ADC) Signal Descriptions (continued)**

| SIGNAL NAME | PIN TYPE | DESCRIPTION                  | PT PIN | RUK PIN | RGZ PIN | RHB PIN | RGE PIN | DGS20 PIN |
|-------------|----------|------------------------------|--------|---------|---------|---------|---------|-----------|
| ADC0_9      | A        | ADC0 analog input channel 9  | 38     |         | 38      |         |         |           |
| ADC0_10     | A        | ADC0 analog input channel 10 | 37     |         | 37      |         |         |           |
| ADC0_11     | A        | ADC0 analog input channel 11 | 36     |         | 36      |         |         |           |
| ADC0_12     | A        | ADC0 analog input channel 12 | 33     | 12      | 33      | 22      | 14      | 14        |
| ADC0_13     | A        | ADC0 analog input channel 13 | 32     | 11      | 32      | 21      | 13      | 13        |
| ADC0_14     | A        | ADC0 analog input channel 14 | 31     | 10      | 31      | 20      | 12      | 12        |
| ADC0_15     | A        | ADC0 analog input channel 15 | 30     |         | 30      | 19      | 11      |           |
| ADC0_16     | A        | ADC0 analog input channel 16 | 29     |         | 29      | 18      |         |           |
| ADC0_17     | A        | ADC0 analog input channel 17 | 28     |         | 28      | 17      |         |           |
| ADC0_18     | A        | ADC0 analog input channel 18 | 27     |         | 27      | 16      |         |           |
| ADC0_19     | A        | ADC0 analog input channel 19 | 26     |         | 26      |         |         |           |
| ADC0_20     | A        | ADC0 analog input channel 20 | 25     |         | 25      |         |         |           |
| ADC0_21     | A        | ADC0 analog input channel 21 | 24     |         | 24      |         |         |           |
| ADC0_22     | A        | ADC0 analog input channel 22 | 34     | 13      | 34      | 23      | 15      | 15        |
| ADC0_23     | A        | ADC0 analog input channel 23 | 21     |         | 21      |         |         |           |
| ADC0_24     | A        | ADC0 analog input channel 24 | 20     |         | 20      |         |         |           |
| ADC0_25     | A        | ADC0 analog input channel 25 | 19     | 9       | 19      | 15      | 10      | 11        |
| ADC0_26     | A        | ADC0 analog input channel 26 | 43     | 16      | 43      | 27      | 19      | 18        |

**Table 6-4. Bootstrap Loader (BSL) Signal Descriptions**

| SIGNAL NAME      | PIN TYPE | DESCRIPTION                     | PT PIN | RUK PIN | RGZ PIN | RHB PIN | RGE PIN | DGS20 PIN |
|------------------|----------|---------------------------------|--------|---------|---------|---------|---------|-----------|
| BSL_invoke_flash | I        | Default Flash BSL invoke signal | 19     | 9       | 19      | 15      | 10      | 11        |

**Table 6-5. Clock Module (CKM) Signal Descriptions**

| SIGNAL NAME | PIN TYPE | DESCRIPTION                                     | PT PIN                        | RUK PIN    | RGZ PIN                       | RHB PIN                    | RGE PIN      | DGS20 PIN |
|-------------|----------|-------------------------------------------------|-------------------------------|------------|-------------------------------|----------------------------|--------------|-----------|
| CLK_OUT     | O        | CLK_OUT digital clock output from the PMCU      | 13, 17, 18, 29, 33, 40, 47, 5 | 12, 15, 20 | 13, 17, 18, 29, 33, 40, 47, 5 | 11, 13, 14, 18, 22, 26, 31 | 14, 18, 8, 9 | 14, 17, 2 |
| FCC_IN      | I        | Frequency clock counter (FCC) input signal      | 1, 11, 13, 27, 31             | 10         | 1, 11, 13, 27, 31             | 11, 16, 20, 9              | 12           | 12        |
| HFCLKIN     | I        | High frequency clock digital clock input signal | 10, 12, 14, 16, 2             | 2, 7       | 10, 12, 14, 16, 2             | 1, 10, 12, 8               | 24, 7        | 10, 4, 9  |
| HFXIN       | A        | High frequency crystal oscillator (HFXT) signal | 3                             | 3          | 3                             | 2                          | 1            | 5         |
| HFXOUT      | A        | High frequency crystal oscillator (HFXT) signal | 2                             | 2          | 2                             | 1                          | 24           | 4         |
| LFCLKIN     | I        | Low frequency clock digital clock input signal  | 47                            | 20         | 47                            | 31                         |              | 2         |
| LFXIN       | A        | Low frequency crystal oscillator (LFXT) signal  | 9                             |            | 9                             | 7                          | 6            |           |
| LFXOUT      | A        | Low frequency crystal oscillator (LFXT) signal  | 10                            | 7          | 10                            | 8                          | 7            | 9         |

**Table 6-6. General Purpose Input Output Module Signal Descriptions**

| SIGNAL NAME | PIN TYPE | DESCRIPTION                 | PT PIN | RUK PIN | RGZ PIN | RHB PIN | RGE PIN | DGS20 PIN |
|-------------|----------|-----------------------------|--------|---------|---------|---------|---------|-----------|
| PA0         | IO       | GPIO port A input/output 0  | 1      |         | 1       |         |         |           |
| PA1         | IO       | GPIO port A input/output 1  | 2      | 2       | 2       | 1       | 24      | 4         |
| PA2         | IO       | GPIO port A input/output 2  | 8      | 6       | 8       | 6       | 5       | 8         |
| PA3         | IO       | GPIO port A input/output 3  | 9      |         | 9       | 7       | 6       |           |
| PA4         | IO       | GPIO port A input/output 4  | 10     | 7       | 10      | 8       | 7       | 9         |
| PA5         | IO       | GPIO port A input/output 5  | 11     |         | 11      | 9       |         |           |
| PA6         | IO       | GPIO port A input/output 6  | 12     |         | 12      | 10      |         | 10        |
| PA7         | IO       | GPIO port A input/output 7  | 13     |         | 13      | 11      |         |           |
| PA8         | IO       | GPIO port A input/output 8  | 16     |         | 16      | 12      |         |           |
| PA9         | IO       | GPIO port A input/output 9  | 17     |         | 17      | 13      | 8       |           |
| PA10        | IO       | GPIO port A input/output 10 | 18     |         | 18      | 14      | 9       |           |
| PA11        | IO       | GPIO port A input/output 11 | 19     | 9       | 19      | 15      | 10      | 11        |
| PA12        | IO       | GPIO port A input/output 12 | 27     |         | 27      | 16      |         |           |
| PA13        | IO       | GPIO port A input/output 13 | 28     |         | 28      | 17      |         |           |
| PA14        | IO       | GPIO port A input/output 14 | 29     |         | 29      | 18      |         |           |
| PA15        | IO       | GPIO port A input/output 15 | 30     |         | 30      | 19      | 11      |           |
| PA16        | IO       | GPIO port A input/output 16 | 31     | 10      | 31      | 20      | 12      | 12        |
| PA17        | IO       | GPIO port A input/output 17 | 32     | 11      | 32      | 21      | 13      | 13        |
| PA18        | IO       | GPIO port A input/output 18 | 33     | 12      | 33      | 22      | 14      | 14        |
| PA19        | IO       | GPIO port A input/output 19 | 34     | 13      | 34      | 23      | 15      | 15        |
| PA20        | IO       | GPIO port A input/output 20 | 35     | 14      | 35      | 24      | 16      | 16        |
| PA21        | IO       | GPIO port A input/output 21 | 39     |         | 39      | 25      | 17      |           |
| PA22        | IO       | GPIO port A input/output 22 | 40     | 15      | 40      | 26      | 18      | 17        |
| PA23        | IO       | GPIO port A input/output 23 | 43     | 16      | 43      | 27      | 19      | 18        |
| PA24        | IO       | GPIO port A input/output 24 | 44     | 17      | 44      | 28      | 20      | 19        |
| PA25        | IO       | GPIO port A input/output 25 | 45     | 18      | 45      | 29      | 21      | 20        |
| PA26        | IO       | GPIO port A input/output 26 | 46     | 19      | 46      | 30      | 22      | 1         |
| PA27        | IO       | GPIO port A input/output 27 | 47     | 20      | 47      | 31      |         | 2         |
| PA28        | IO       | GPIO port A input/output 28 | 3      | 3       | 3       | 2       | 1       | 5         |
| PA30        | IO       | GPIO port A input/output 30 | 48     | 1       | 48      | 32      | 23      | 3         |
| PA31        | IO       | GPIO port A input/output 31 | 5      |         | 5       |         |         |           |
| PB2         | IO       | GPIO port B input/output 2  | 14     |         | 14      |         |         |           |
| PB3         | IO       | GPIO port B input/output 3  | 15     | 8       | 15      |         |         |           |
| PB6         | IO       | GPIO port B input/output 6  | 20     |         | 20      |         |         |           |
| PB7         | IO       | GPIO port B input/output 7  | 21     |         | 21      |         |         |           |
| PB8         | IO       | GPIO port B input/output 8  | 22     |         | 22      |         |         |           |
| PB9         | IO       | GPIO port B input/output 9  | 23     |         | 23      |         |         |           |
| PB14        | IO       | GPIO port B input/output 14 | 24     |         | 24      |         |         |           |
| PB15        | IO       | GPIO port B input/output 15 | 25     |         | 25      |         |         |           |
| PB16        | IO       | GPIO port B input/output 16 | 26     |         | 26      |         |         |           |
| PB17        | IO       | GPIO port B input/output 17 | 36     |         | 36      |         |         |           |
| PB18        | IO       | GPIO port B input/output 18 | 37     |         | 37      |         |         |           |
| PB19        | IO       | GPIO port B input/output 19 | 38     |         | 38      |         |         |           |
| PB20        | IO       | GPIO port B input/output 20 | 41     |         | 41      |         |         |           |

**Table 6-6. General Purpose Input Output Module Signal Descriptions (continued)**

| SIGNAL NAME | PIN TYPE | DESCRIPTION                 | PT PIN | RUK PIN | RGZ PIN | RHB PIN | RGE PIN | DGS20 PIN |
|-------------|----------|-----------------------------|--------|---------|---------|---------|---------|-----------|
| PB24        | IO       | GPIO port B input/output 24 | 42     |         | 42      |         |         |           |

**Table 6-7. I2C Signal Descriptions**

| SIGNAL NAME | PIN TYPE | DESCRIPTION                    | PT PIN                                                 | RUK PIN                 | RGZ PIN                                                | RHB PIN                             | RGE PIN                     | DGS20 PIN              |
|-------------|----------|--------------------------------|--------------------------------------------------------|-------------------------|--------------------------------------------------------|-------------------------------------|-----------------------------|------------------------|
| I2C0_SCL    | IOD      | I2C0 serial clock signal (SCL) | 17, 19, 2, 22, 23, 29, 36, 40, 45, 46, 47, 5, 8        | 15, 18, 19, 2, 20, 6, 9 | 17, 19, 2, 22, 23, 29, 36, 40, 45, 46, 47, 5, 8        | 1, 13, 15, 18, 26, 29, 30, 31, 6    | 10, 18, 21, 22, 24, 5, 8    | 1, 11, 17, 2, 20, 4, 8 |
| I2C0_SDA    | IOD      | I2C0 serial data signal (SDA)  | 1, 12, 16, 18, 2, 23, 24, 3, 37, 41, 44, 45, 46, 48, 9 | 1, 17, 18, 19, 2, 3     | 1, 12, 16, 18, 2, 23, 24, 3, 37, 41, 44, 45, 46, 48, 9 | 1, 10, 12, 14, 2, 28, 29, 30, 32, 7 | 1, 20, 21, 22, 23, 24, 6, 9 | 1, 10, 19, 20, 3, 4, 5 |
| I2C1_SCL    | IOD      | I2C1 serial clock signal (SCL) | 10, 12, 14, 19, 27, 30, 32, 35                         | 11, 14, 7, 9            | 10, 12, 14, 19, 27, 30, 32, 35                         | 10, 15, 16, 19, 21, 24, 8           | 10, 11, 13, 16, 7           | 10, 11, 13, 16, 9      |
| I2C1_SDA    | IOD      | I2C1 serial data signal (SDA)  | 11, 15, 18, 26, 31, 33, 34, 9                          | 10, 12, 13, 8           | 11, 15, 18, 26, 31, 33, 34, 9                          | 14, 20, 22, 23, 7, 9                | 12, 14, 15, 6, 9            | 12, 14, 15             |

**Table 6-8. Power Management Unit (PMU) Signal Descriptions**

| SIGNAL NAME | PIN TYPE | DESCRIPTION  | PT PIN | RUK PIN | RGZ PIN | RHB PIN | RGE PIN | DGS20 PIN |
|-------------|----------|--------------|--------|---------|---------|---------|---------|-----------|
| VDD         | PWR      | VDD supply   | 6      | 4       | 6       | 4       | 3       | 6         |
| VSS         | PWR      | VSS (ground) | 7      | 5       | 7       | 5       | 4       | 7         |

**Table 6-9. Real-time Clock (RTC) Signal Descriptions**

| SIGNAL NAME | PIN TYPE | DESCRIPTION                   | PT PIN            | RUK PIN | RGZ PIN           | RHB PIN    | RGE PIN | DGS20 PIN |
|-------------|----------|-------------------------------|-------------------|---------|-------------------|------------|---------|-----------|
| RTC_OUT     | O        | Real-time clock output signal | 1, 15, 17, 28, 47 | 20, 8   | 1, 15, 17, 28, 47 | 13, 17, 31 | 8       | 2         |

**Table 6-10. Serial Peripheral Interface (SPI) Signal Descriptions**

| SIGNAL NAME | PIN TYPE | DESCRIPTION                              | PT PIN                                             | RUK PIN            | RGZ PIN                                            | RHB PIN                               | RGE PIN                  | DGS20 PIN          |
|-------------|----------|------------------------------------------|----------------------------------------------------|--------------------|----------------------------------------------------|---------------------------------------|--------------------------|--------------------|
| SPI0_PICO   | IO       | SPI0 peripheral in controller out signal | 11, 13, 14, 17, 18, 24, 29, 33, 34, 35, 36, 44, 45 | 12, 13, 14, 17, 18 | 11, 13, 14, 17, 18, 24, 29, 33, 34, 35, 36, 44, 45 | 11, 13, 14, 18, 22, 23, 24, 28, 29, 9 | 14, 15, 16, 20, 21, 8, 9 | 14, 15, 16, 19, 20 |

**Table 6-10. Serial Peripheral Interface (SPI) Signal Descriptions (continued)**

| SIGNAL NAME | PIN TYPE | DESCRIPTION                              | PT PIN                                                         | RUK PIN                           | RGZ PIN                                                        | RHB PIN                                           | RGE PIN                             | DGS20 PIN                       |
|-------------|----------|------------------------------------------|----------------------------------------------------------------|-----------------------------------|----------------------------------------------------------------|---------------------------------------------------|-------------------------------------|---------------------------------|
| SPI0_POCI   | IO       | SPI0 peripheral out controller in signal | 10, 13, 17, 18, 22, 23, 28, 31, 33, 34, 38, 40, 43, 45, 46, 47 | 10, 12, 13, 15, 16, 18, 19, 20, 7 | 10, 13, 17, 18, 22, 23, 28, 31, 33, 34, 38, 40, 43, 45, 46, 47 | 11, 13, 14, 17, 20, 22, 23, 26, 27, 29, 30, 31, 8 | 12, 14, 15, 18, 19, 21, 22, 7, 8, 9 | 1, 12, 14, 15, 17, 18, 2, 20, 9 |
| SPI0_SCLK   | IOD      | SPI0 serial clock                        | 12, 15, 16, 19, 21, 22, 27, 32, 34, 37, 42, 45                 | 11, 13, 18, 8, 9                  | 12, 15, 16, 19, 21, 22, 27, 32, 34, 37, 42, 45                 | 10, 12, 15, 16, 21, 23, 29                        | 10, 13, 15, 21                      | 10, 11, 13, 15, 20              |
| SPI0_CS0    | IO       | SPI0 chip-select 0 signal                | 10, 15, 16, 19, 28, 33, 36, 37, 8                              | 12, 6, 7, 8, 9                    | 10, 15, 16, 19, 28, 33, 36, 37, 8                              | 12, 15, 17, 22, 6, 8                              | 10, 14, 5, 7                        | 11, 14, 8, 9                    |
| SPI0_CS1    | IO       | SPI0 chip-select 1 signal                | 1, 20, 27, 32, 42, 9                                           | 11                                | 1, 20, 27, 32, 42, 9                                           | 16, 21, 7                                         | 13, 6                               | 13                              |
| SPI0_CS2    | IO       | SPI0 chip-select 2 signal                | 13, 21, 29, 30, 40, 41, 44                                     | 15, 17                            | 13, 21, 29, 30, 40, 41, 44                                     | 11, 18, 19, 26, 28                                | 11, 18, 20                          | 17, 19                          |
| SPI0_CS3    | IO       | SPI0 chip-select 3 signal                | 16, 2, 24, 28, 39, 42, 43, 47, 9                               | 16, 2, 20                         | 16, 2, 24, 28, 39, 42, 43, 47, 9                               | 1, 12, 17, 25, 27, 31, 7                          | 17, 19, 24, 6                       | 18, 2, 4                        |

**Table 6-11. Serial Wire Debug (SWD) Signal Descriptions**

| SIGNAL NAME | PIN TYPE | DESCRIPTION                                          | PT PIN | RUK PIN | RGZ PIN | RHB PIN | RGE PIN | DGS20 PIN |
|-------------|----------|------------------------------------------------------|--------|---------|---------|---------|---------|-----------|
| SWCLK       | I        | Serial wire debug interface clock input signal       | 35     | 14      | 35      | 24      | 16      | 16        |
| SWDIO       | IO       | Serial wire debug interface data input/output signal | 34     | 13      | 34      | 23      | 15      | 15        |

**Table 6-12. System Controller (SYSCTL) Signal Descriptions**

| SIGNAL NAME | PIN TYPE | DESCRIPTION                                                          | PT PIN            | RUK PIN | RGZ PIN           | RHB PIN | RGE PIN | DGS20 PIN |
|-------------|----------|----------------------------------------------------------------------|-------------------|---------|-------------------|---------|---------|-----------|
| BEEP        | O        | Beep output                                                          | 1, 12, 21, 22, 46 | 19      | 1, 12, 21, 22, 46 | 10, 30  | 22      | 1, 10     |
| NRST        | RESET    | Active-low reset signal (must be logic high for the device to start) | 4                 | 3       | 4                 | 3       | 2       | 5         |

**Table 6-13. Timer (TIMx) Signal Descriptions**

| SIGNAL NAME | PIN TYPE | DESCRIPTION                                  | PT PIN                                    | RUK PIN             | RGZ PIN                                   | RHB PIN                           | RGE PIN               | DGS20 PIN         |
|-------------|----------|----------------------------------------------|-------------------------------------------|---------------------|-------------------------------------------|-----------------------------------|-----------------------|-------------------|
| TIMA0_C0    | IO       | TIMA0 capture/compare 0 signal               | 1, 15, 16, 22, 24, 33, 35, 39, 46, 48, 8  | 1, 12, 14, 19, 6, 8 | 1, 15, 16, 22, 24, 33, 35, 39, 46, 48, 8  | 12, 22, 24, 25, 30, 32, 6         | 14, 16, 17, 22, 23, 5 | 1, 14, 16, 3, 8   |
| TIMA0_C1    | IO       | TIMA0 capture/compare 1 signal               | 11, 13, 17, 2, 23, 28, 3, 37, 40, 41, 9   | 15, 2, 3            | 11, 13, 17, 2, 23, 28, 3, 37, 40, 41, 9   | 1, 11, 13, 17, 2, 26, 7, 9        | 1, 18, 24, 6, 8       | 17, 4, 5          |
| TIMA0_C2    | IO       | TIMA0 capture/compare 2 signal               | 12, 13, 18, 29, 30, 32, 34, 36, 41, 45, 9 | 11, 13, 18          | 12, 13, 18, 29, 30, 32, 34, 36, 41, 45, 9 | 10, 11, 14, 18, 19, 21, 23, 29, 7 | 11, 13, 15, 21, 6, 9  | 10, 13, 15, 20    |
| TIMA0_C3    | IO       | TIMA0 capture/compare 3 signal               | 10, 14, 27, 3, 32, 42, 43, 45             | 11, 16, 18, 3, 7    | 10, 14, 27, 3, 32, 42, 43, 45             | 16, 2, 21, 27, 29, 8              | 1, 13, 19, 21, 7      | 13, 18, 20, 5, 9  |
| TIMA0_CON   | O        | TIMA0 capture/compare 0 complementary output | 10, 17, 23, 32, 39, 40, 47                | 11, 15, 20, 7       | 10, 17, 23, 32, 39, 40, 47                | 13, 21, 25, 26, 31, 8             | 13, 17, 18, 7, 8      | 13, 17, 2, 9      |
| TIMA0_C1N   | O        | TIMA0 capture/compare 1 complementary output | 10, 14, 18, 25, 38, 42, 45                | 18, 7               | 10, 14, 18, 25, 38, 42, 45                | 14, 29, 8                         | 21, 7, 9              | 20, 9             |
| TIMA0_C2N   | O        | TIMA0 capture/compare 2 complementary output | 12, 19, 20, 26, 28, 31, 35, 37, 41, 8     | 10, 14, 6, 9        | 12, 19, 20, 26, 28, 31, 35, 37, 41, 8     | 10, 15, 17, 20, 24, 6             | 10, 12, 16, 5         | 10, 11, 12, 16, 8 |
| TIMA0_C3N   | O        | TIMA0 capture/compare 3 complementary output | 15, 16, 20, 27, 28, 33, 44, 46, 5, 8      | 12, 17, 19, 6, 8    | 15, 16, 20, 27, 28, 33, 44, 46, 5, 8      | 12, 16, 17, 22, 28, 30, 6         | 14, 20, 22, 5         | 1, 14, 19, 8      |
| TIMA_FAL0   | I        | TIMA fault input 0                           | 12, 15, 16, 19, 24, 3, 46, 8              | 19, 3, 6, 8, 9      | 12, 15, 16, 19, 24, 3, 46, 8              | 10, 12, 15, 2, 30, 6              | 1, 10, 22, 5          | 1, 10, 11, 5, 8   |
| TIMA_FAL1   | I        | TIMA fault input 1                           | 1, 11, 17, 18, 35, 41, 8                  | 14, 6               | 1, 11, 17, 18, 35, 41, 8                  | 13, 14, 24, 6, 9                  | 16, 5, 8, 9           | 16, 8             |
| TIMA_FAL2   | I        | TIMA fault input 2                           | 16, 2, 20, 24, 33, 47                     | 12, 2, 20           | 16, 2, 20, 24, 33, 47                     | 1, 12, 22, 31                     | 14, 24                | 14, 2, 4          |
| TIMG8_IDX   | I        | TIMG8 quadrature encoder index pulse signal  | 13, 2, 24, 30, 38, 48, 8                  | 1, 2, 6             | 13, 2, 24, 30, 38, 48, 8                  | 1, 11, 19, 32, 6                  | 11, 23, 24, 5         | 3, 4, 8           |
| TIMG14_C0   | IO       | TIMG14 capture/compare 0 signal              | 1, 11, 18, 27, 34, 36, 43, 45             | 13, 16, 18          | 1, 11, 18, 27, 34, 36, 43, 45             | 14, 16, 23, 27, 29, 9             | 15, 19, 21, 9         | 15, 18, 20        |

**Table 6-13. Timer (TIMx) Signal Descriptions (continued)**

| SIGNAL NAME | PIN TYPE | DESCRIPTION                     | PT PIN                                                   | RUK PIN                | RGZ PIN                                                  | RHB PIN                          | RGE PIN               | DGS20 PIN               |
|-------------|----------|---------------------------------|----------------------------------------------------------|------------------------|----------------------------------------------------------|----------------------------------|-----------------------|-------------------------|
| TIMG14_C1   | IO       | TIMG14 capture/compare 1 signal | 12, 19, 2, 28, 35, 37, 44                                | 14, 17, 2, 9           | 12, 19, 2, 28, 35, 37, 44                                | 1, 10, 15, 17, 24, 28            | 10, 16, 20, 24        | 10, 11, 16, 19, 4       |
| TIMG14_C2   | IO       | TIMG14 capture/compare 2 signal | 24, 31, 42, 48                                           | 1, 10                  | 24, 31, 42, 48                                           | 20, 32                           | 12, 23                | 12, 3                   |
| TIMG14_C3   | IO       | TIMG14 capture/compare 3 signal | 28                                                       |                        | 28                                                       | 17                               |                       |                         |
| TIMG1_C0    | IO       | TIMG1 capture/compare 0 signal  | 11, 13, 14, 20, 22, 29, 36, 39, 45                       | 18                     | 11, 13, 14, 20, 22, 29, 36, 39, 45                       | 11, 18, 25, 29, 9                | 17, 21                | 20                      |
| TIMG1_C1    | IO       | TIMG1 capture/compare 1 signal  | 12, 15, 17, 21, 23, 37, 40, 46                           | 15, 19, 8              | 12, 15, 17, 21, 23, 37, 40, 46                           | 10, 13, 26, 30                   | 18, 22, 8             | 1, 10, 17               |
| TIMG2_C0    | IO       | TIMG2 capture/compare 0 signal  | 17, 23, 25, 3, 32, 43, 46, 9                             | 11, 16, 19, 3          | 17, 23, 25, 3, 32, 43, 46, 9                             | 13, 2, 21, 27, 30, 7             | 1, 13, 19, 22, 6, 8   | 1, 13, 18, 5            |
| TIMG2_C1    | IO       | TIMG2 capture/compare 1 signal  | 10, 13, 15, 16, 24, 25, 26, 27, 33, 38, 44, 47, 48, 8    | 1, 12, 17, 20, 6, 7, 8 | 10, 13, 15, 16, 24, 25, 26, 27, 33, 38, 44, 47, 48, 8    | 11, 12, 16, 22, 28, 31, 32, 6, 8 | 14, 20, 23, 5, 7      | 14, 19, 2, 3, 8, 9      |
| TIMG8_C0    | IO       | TIMG8 capture/compare 0 signal  | 11, 13, 2, 20, 22, 25, 32, 39, 43, 46, 9                 | 11, 16, 19, 2          | 11, 13, 2, 20, 22, 25, 32, 39, 43, 46, 9                 | 1, 11, 21, 25, 27, 30, 7, 9      | 13, 17, 19, 22, 24, 6 | 1, 13, 18, 4            |
| TIMG8_C1    | IO       | TIMG8 capture/compare 1 signal  | 1, 10, 12, 18, 20, 21, 26, 28, 33, 38, 40, 41, 44, 47, 8 | 12, 15, 17, 20, 6, 7   | 1, 10, 12, 18, 20, 21, 26, 28, 33, 38, 40, 41, 44, 47, 8 | 10, 14, 17, 22, 26, 28, 31, 6, 8 | 14, 18, 20, 5, 7, 9   | 10, 14, 17, 19, 2, 8, 9 |

**Table 6-14. Universal Asynchronous Receiver Transmitter (UART) Signal Descriptions**

| SIGNAL NAME | PIN TYPE | DESCRIPTION                | PT PIN                                 | RUK PIN        | RGZ PIN                                | RHB PIN                    | RGE PIN            | DGS20 PIN          |
|-------------|----------|----------------------------|----------------------------------------|----------------|----------------------------------------|----------------------------|--------------------|--------------------|
| UART0_CTS   | I        | UART0 clear to send signal | 11, 17, 29, 33, 34, 38, 43             | 12, 13, 16     | 11, 17, 29, 33, 34, 38, 43             | 13, 18, 22, 23, 27, 9      | 14, 15, 19, 8      | 14, 15, 18         |
| UART0_RTS   | O        | UART0 ready to send signal | 12, 16, 30, 34, 35, 36, 37, 42, 44, 45 | 13, 14, 17, 18 | 12, 16, 30, 34, 35, 36, 37, 42, 44, 45 | 10, 12, 19, 23, 24, 28, 29 | 11, 15, 16, 20, 21 | 10, 15, 16, 19, 20 |

**Table 6-14. Universal Asynchronous Receiver Transmitter (UART) Signal Descriptions (continued)**

| SIGNAL NAME | PIN TYPE | DESCRIPTION                 | PT PIN                                             | RUK PIN              | RGZ PIN                                            | RHB PIN                           | RGE PIN                  | DGS20 PIN                 |
|-------------|----------|-----------------------------|----------------------------------------------------|----------------------|----------------------------------------------------|-----------------------------------|--------------------------|---------------------------|
| UART0_RX    | IO       | UART0 receive signal (RXD)  | 19, 2, 21, 22, 23, 32, 46, 48, 5                   | 1, 11, 19, 2, 9      | 19, 2, 21, 22, 23, 32, 46, 48, 5                   | 1, 15, 21, 30, 32                 | 10, 13, 22, 23, 24       | 1, 11, 13, 3, 4           |
| UART0_TX    | O        | UART0 transmit signal (TXD) | 1, 18, 2, 20, 23, 24, 29, 3, 43, 45, 47            | 16, 18, 2, 20, 3     | 1, 18, 2, 20, 23, 24, 29, 3, 43, 45, 47            | 1, 14, 18, 2, 27, 29, 31          | 1, 19, 21, 24, 9         | 18, 2, 20, 4, 5           |
| UART1_CTS   | I        | UART1 clear to send signal  | 14, 22, 27, 39, 41, 46, 47                         | 19, 20               | 14, 22, 27, 39, 41, 46, 47                         | 16, 25, 30, 31                    | 17, 22                   | 1, 2                      |
| UART1_RTS   | O        | UART1 ready to send signal  | 15, 2, 23, 28, 33, 40, 48                          | 1, 12, 15, 2, 8      | 15, 2, 23, 28, 33, 40, 48                          | 1, 17, 22, 26, 32                 | 14, 18, 23, 24           | 14, 17, 3, 4              |
| UART1_RX    | I        | UART1 receive signal (RXD)  | 10, 12, 14, 16, 17, 19, 21, 26, 33, 35, 36, 40, 44 | 12, 14, 15, 17, 7, 9 | 10, 12, 14, 16, 17, 19, 21, 26, 33, 35, 36, 40, 44 | 10, 12, 13, 15, 22, 24, 26, 28, 8 | 10, 14, 16, 18, 20, 7, 8 | 10, 11, 14, 16, 17, 19, 9 |
| UART1_TX    | O        | UART1 transmit signal (TXD) | 11, 13, 15, 16, 20, 25, 32, 36, 9                  | 11, 8                | 11, 13, 15, 16, 20, 25, 32, 36, 9                  | 11, 12, 21, 7, 9                  | 13, 6                    | 13                        |
| UART2_CTS   | I        | UART2 clear to send signal  | 14, 20, 27, 31, 38, 39, 45, 9                      | 10, 18               | 14, 20, 27, 31, 38, 39, 45, 9                      | 16, 20, 25, 29, 7                 | 12, 17, 21, 6            | 12, 20                    |
| UART2_RTS   | O        | UART2 ready to send signal  | 10, 15, 21, 30, 41, 42, 46                         | 19, 7, 8             | 10, 15, 21, 30, 41, 42, 46                         | 19, 30, 8                         | 11, 22, 7                | 1, 9                      |
| UART2_RX    | I        | UART2 receive signal (RXD)  | 15, 26, 29, 37, 38, 39, 40, 44                     | 15, 17, 8            | 15, 26, 29, 37, 38, 39, 40, 44                     | 18, 25, 26, 28                    | 17, 18, 20               | 17, 19                    |
| UART2_TX    | O        | UART2 transmit signal (TXD) | 14, 25, 28, 36, 39, 40, 43                         | 15, 16               | 14, 25, 28, 36, 39, 40, 43                         | 17, 25, 26, 27                    | 17, 18, 19               | 17, 18                    |

**Table 6-15. Voltage Reference Signal Descriptions**

| SIGNAL NAME | PIN TYPE | DESCRIPTION                      | PT PIN | RUK PIN | RGZ PIN | RHB PIN | RGE PIN | DGS20 PIN |
|-------------|----------|----------------------------------|--------|---------|---------|---------|---------|-----------|
| VREF+       | A        | Voltage reference positive input | 43     | 16      | 43      | 27      | 19      | 18        |
| VREF-       | A        | Voltage reference negative input | 40     | 15      | 40      | 26      | 18      | 17        |

## 6.4 Connections for Unused Pins

Table 6-16 lists the correct termination of unused pins.

**Table 6-16. Connection of Unused Pins**

| PIN <sup>(1)</sup> | POTENTIAL | COMMENT                                                                                                                                               |
|--------------------|-----------|-------------------------------------------------------------------------------------------------------------------------------------------------------|
| PAx                | Open      | Set corresponding pin functions to GPIO (PINCMx.PF = 0x1) and configure unused pins to output low or input with internal pullup or pulldown resistor. |
| NRST               | VCC       | NRST is an active-low reset signal. Pull high to VCC or the device cannot start. For more information, see <a href="#">Section 9.1</a> .              |

(1) Any unused pin with a function that is shared with general-purpose I/O must follow the "PAx" unused pin connection guidelines.

## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                  |                         |                                      | MIN  | MAX                                | UNIT |
|------------------|-------------------------|--------------------------------------|------|------------------------------------|------|
| VDD              | Supply voltage          | At VDD pin                           | -0.3 | 6.5                                | V    |
| V <sub>I</sub>   | Input voltage           | Applied to any common tolerance pins | -0.3 | V <sub>DD</sub> + 0.3<br>(6.5 MAX) | V    |
| I <sub>VDD</sub> | Current of VDD pin      | Current into VDD pin (source)        |      | 80                                 | mA   |
| I <sub>VSS</sub> | Current of VSS pin      | Current out of VSS pin (sink)        |      | 80                                 | mA   |
| I <sub>IO</sub>  | Current for SDIO pin    | Current sunk or sourced by SDIO pin  |      | 3                                  | mA   |
| I <sub>IO</sub>  | Current for SDIO pin    | Current sunk or sourced by HSIO pin  |      | 6                                  | mA   |
| I <sub>D</sub>   | Supported diode current | Diode current at any device pin      |      | ±2                                 | mA   |
| T <sub>A</sub>   |                         | Ambient Temperature                  | -40  | 125                                | °C   |
| T <sub>J</sub>   |                         | Junction temperature                 | -40  | 130                                | °C   |
| T <sub>stg</sub> |                         | Storage temperature <sup>(2)</sup>   | -40  | 150                                | °C   |

- (1) Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute Maximum Ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If used outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.
- (2) Higher temperatures may be applied during board soldering according to the current JEDEC J-STD-020 specification with peak reflow temperatures not higher than classified on the device label on the shipping boxes or reels.

### 7.2 ESD Ratings

|                    |                         |                                                                   | VALUE | UNIT |
|--------------------|-------------------------|-------------------------------------------------------------------|-------|------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human body model (HBM), per AEC Q100-002, all pins <sup>(1)</sup> | ±2000 | V    |
| V <sub>(ESD)</sub> | Electrostatic discharge | Charged device model (CDM), per pAEC Q100-011, all pins           | ±500  | V    |
| V <sub>(ESD)</sub> | Electrostatic discharge | Charged device model (CDM), per AEC-Q100-011, Corner pins         | ±750  | V    |

- (1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

### 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                   |                                                                       | MIN | NOM | MAX | UNIT |
|-------------------|-----------------------------------------------------------------------|-----|-----|-----|------|
| VDD               | Supply voltage                                                        | 4.5 |     | 5.5 | V    |
| C <sub>VDD</sub>  | Capacitor placed between VDD and VSS <sup>(1)</sup>                   |     | 10  |     | uF   |
| T <sub>A</sub>    | Ambient temperature                                                   | -40 |     | 125 | °C   |
| T <sub>J</sub>    | Max junction temperature                                              |     |     | 130 | °C   |
| f <sub>MCLK</sub> | MCLK, CPUCLK, ULPCLK frequency with 1 flash wait state <sup>(2)</sup> |     |     | 32  | MHz  |
|                   | MCLK, CPUCLK, ULPCLK frequency with 0 flash wait state <sup>(2)</sup> |     |     | 24  | MHz  |

- (1) Connect C<sub>VDD</sub> between VDD/VSS, as close to the device pins as possible. A low-ESR capacitor with at least the specified value and tolerance of ±20% or better is required for C<sub>VDD</sub>.
- (2) Wait states are managed automatically by the system controller (SYSCTL) and do not need to be configured by application software.

## 7.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | PACKAGE          | VALUE | UNIT |
|-------------------------------|----------------------------------------------|------------------|-------|------|
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | LQFP-48 (PT)     | 77.8  | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    |                  | 34.2  | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         |                  | 49.8  | °C/W |
| Ψ <sub>JT</sub>               | Junction-to-top characterization parameter   |                  | 3.1   | °C/W |
| Ψ <sub>JB</sub>               | Junction-to-board characterization parameter |                  | 49.2  | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance |                  | N/A   | °C/W |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | VQFN-48 (RGZ)    | 35.6  | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    |                  | 24.3  | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         |                  | 16.4  | °C/W |
| Ψ <sub>JT</sub>               | Junction-to-top characterization parameter   |                  | 1.4   | °C/W |
| Ψ <sub>JB</sub>               | Junction-to-board characterization parameter |                  | 16.2  | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance |                  | 8.0   | °C/W |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | VQFN-32 (RHB)    | 36.8  | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    |                  | 29.1  | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         |                  | 17.1  | °C/W |
| Ψ <sub>JT</sub>               | Junction-to-top characterization parameter   |                  | 1.1   | °C/W |
| Ψ <sub>JB</sub>               | Junction-to-board characterization parameter |                  | 17.0  | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance |                  | 7.2   | °C/W |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | VQFN-24 (RGE)    | 45.8  | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    |                  | 38.6  | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         |                  | 21.6  | °C/W |
| Ψ <sub>JT</sub>               | Junction-to-top characterization parameter   |                  | 1.5   | °C/W |
| Ψ <sub>JB</sub>               | Junction-to-board characterization parameter |                  | 21.8  | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance |                  | 7.3   | °C/W |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | VSSOP-20 (DGS20) | 91.6  | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    |                  | 34.4  | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         |                  | 48.3  | °C/W |
| Ψ <sub>JT</sub>               | Junction-to-top characterization parameter   |                  | 1.2   | °C/W |
| Ψ <sub>JB</sub>               | Junction-to-board characterization parameter |                  | 47.8  | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance |                  | N/A   | °C/W |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | WQFN-20 (RUK)    | 48.4  | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    |                  | 48.0  | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         |                  | 23.0  | °C/W |
| Ψ <sub>JT</sub>               | Junction-to-top characterization parameter   |                  | 1.2   | °C/W |
| Ψ <sub>JB</sub>               | Junction-to-board characterization parameter |                  | 23.0  | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance |                  | 8.2   | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 7.5 Supply Current Characteristics

### 7.5.1 RUN/SLEEP Modes

VDD=5V. All inputs tied to 0V or VDD. Outputs do not source or sink any current. All peripherals are disabled.

| PARAMETER                    |                                           | MCLK  | -40°C     | 25°C      | 85°C      | 105°C     | 125°C     | UNIT   |
|------------------------------|-------------------------------------------|-------|-----------|-----------|-----------|-----------|-----------|--------|
|                              |                                           |       | TYP MAX   | TYP MAX   | TYP MAX   | TYP MAX   | TYP MAX   |        |
| RUN Mode                     |                                           |       |           |           |           |           |           |        |
| IDD <sub>RUN</sub>           | MCLK=SYSOSC, CoreMark, execute from flash | 32MHz | 3.9       | 4.0       | 4.0       | 4.0       | 4.1       | mA     |
| IDD <sub>RUN</sub> , per MHz | MCLK=SYSOSC, CoreMark, execute from flash | 32MHz | 123       | 126       | 127       | 127       | 127       | uA/Mhz |
|                              | MCLK=SYSOSC, While(1), execute from flash | 32MHz | 89 100    | 91 101    | 92 102    | 92 102    | 93 102    |        |
| SLEEP Mode                   |                                           |       |           |           |           |           |           |        |
| IDD <sub>SLEEP</sub>         | MCLK=SYSOSC, CPU is halted                | 32MHz | 2452 2647 | 2516 2693 | 2558 2723 | 2575 2740 | 2595 2760 | uA     |
| IDD <sub>SLEEP</sub>         | MCLK=LFCLK, CPU is halted                 | 32kHz | 828 930   | 873 959   | 926 1011  | 943 1028  | 967 1128  | uA     |

### 7.5.2 STOP/STANDBY Modes

VDD=5V unless otherwise noted. All inputs tied to 0V or VDD. Outputs do not source or sink any current. All peripherals not noted are disabled.

| PARAMETER    |                                              | ULPCLK | -40°C |      | 25°C |      | 85°C |      | 105°C |      | 125°C |      | UNIT |
|--------------|----------------------------------------------|--------|-------|------|------|------|------|------|-------|------|-------|------|------|
|              |                                              |        | TYP   | MAX  | TYP  | MAX  | TYP  | MAX  | TYP   | MAX  | TYP   | MAX  |      |
| STOP Mode    |                                              |        |       |      |      |      |      |      |       |      |       |      |      |
| IDD_STOP0    | SYSOSC=32MHz,<br>DISABLESTOP=0               | 4MHz   | 1390  | 1512 | 1442 | 1547 | 1479 | 1575 | 1493  | 1589 | 1510  | 1628 | uA   |
| IDD_STOP2    | SYSOSC off, DISABLESTOP=1,<br>ULPCLK=LFCLK   | 32kHz  | 631   | 720  | 674  | 749  | 714  | 783  | 729   | 798  | 748   | 869  |      |
| STANDBY Mode |                                              |        |       |      |      |      |      |      |       |      |       |      |      |
| IDD_STBY0    | LFCLK=LFOSC, STOPCLKSTBY=0,<br>TIMG8 enabled | 32kHz  | 4.0   | 5.5  | 4.3  | 5.5  | 12   | 23   | 17    | 27   | 24    | 79   | uA   |
|              | LFCLK=LFXT, STOPCLKSTBY=0,<br>TIMG8 enabled  | 32kHz  | 4.0   | 5.5  | 4.3  | 5.5  | 12   | 24   | 17    | 29   | 24    | 86   |      |
| IDD_STBY1    | LFCLK=LFOSC, STOPCLKSTBY=1,<br>TIMG8 enabled | 32kHz  | 3.5   | 4.4  | 3.8  | 4.8  | 12   | 22   | 16    | 26   | 24    | 78   | uA   |
|              | LFCLK=LFOSC, STOPCLKSTBY=1,<br>GPIOA enabled | 32kHz  | 3.5   | 4.4  | 3.8  | 4.8  | 12   | 22   | 16    | 26   | 24    | 78   |      |
|              | LFCLK=LFXT, STOPCLKSTBY=1,<br>TIMG8 enabled  | 32kHz  | 3.5   | 4.4  | 3.8  | 4.8  | 12   | 23   | 16    | 28   | 24    | 85   |      |
|              | LFCLK=LFXT, STOPCLKSTBY=1,<br>GPIOA enabled  | 32kHz  | 3.5   | 4.4  | 3.8  | 4.8  | 12   | 23   | 16    | 28   | 24    | 85   |      |

## 7.6 Power Supply Sequencing

### 7.6.1 POR and BOR

over operating free-air temperature range (unless otherwise noted)

| PARAMETER             |                                | TEST CONDITIONS        | MIN | TYP  | MAX  | UNIT |
|-----------------------|--------------------------------|------------------------|-----|------|------|------|
| dVDD/dt               | VDD (supply voltage) slew rate | Rising                 |     |      | 0.1  | V/us |
|                       |                                | Falling <sup>(1)</sup> |     |      | 0.01 |      |
|                       |                                | Falling, STANDBY       |     |      | 0.1  | V/ms |
| V <sub>POR+</sub>     | Power-on reset voltage level   | Rising                 | 2.5 | 3.33 | 4.2  | V    |
| V <sub>POR-</sub>     |                                | Falling                | 2.4 | 3.25 | 4.1  | V    |
| V <sub>HYS, POR</sub> | POR hysteresis                 |                        | 10  | 80   | 170  | mV   |

over operating free-air temperature range (unless otherwise noted)

| PARAMETER         |                                                 | TEST CONDITIONS     | MIN  | TYP  | MAX  | UNIT |
|-------------------|-------------------------------------------------|---------------------|------|------|------|------|
| $V_{BOR0+, COLD}$ | Brown-out reset voltage level 0 (default level) | Cold start, rising  | 3.9  | 4.2  | 4.5  | V    |
| $V_{BOR0+}$       |                                                 | Rising              | 4.26 | 4.4  | 4.5  |      |
| $V_{BOR0-}$       |                                                 | Falling             | 4.24 | 4.38 | 4.48 |      |
| $V_{BOR0, STBY}$  | Brown-out reset voltage level 0 (default level) | STANDBY mode        | 4    | 4.27 | 4.5  | V    |
| $V_{HYS, BOR}$    | Brown-out reset hysteresis                      | Level 0             |      | 14   | 23   | mV   |
| $T_{PD, BOR}$     | BOR propagation delay                           | RUN/SLEEP/STOP mode |      |      | 10   | us   |
|                   |                                                 | STANDBY mode        |      |      | 100  | us   |

(1) Device operating in RUN, SLEEP, or STOP mode.

## 7.6.2 Power Supply Ramp

Figure 7-1 gives the relationship of POR-, POR+, BOR0-, and BOR0+ during power-up and power-down.

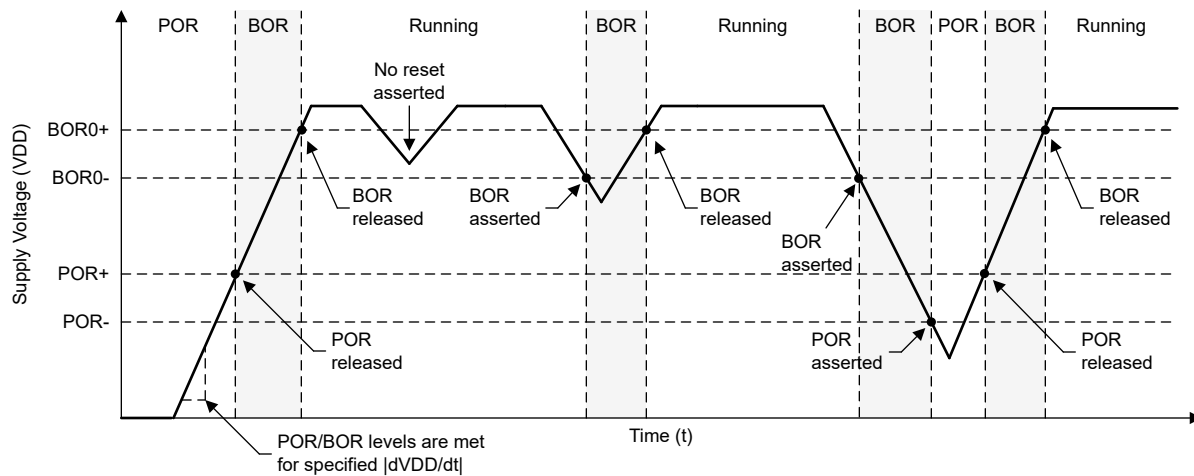


Figure 7-1. Power Cycle POR/BOR Conditions

## 7.7 Flash Memory Characteristics

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                    |                                                                                | TEST CONDITIONS                                        | MIN | TYP | MAX | UNIT               |
|------------------------------|--------------------------------------------------------------------------------|--------------------------------------------------------|-----|-----|-----|--------------------|
| <b>Supply</b>                |                                                                                |                                                        |     |     |     |                    |
| $I_{DDERASE}$                | Supply current from VDD during erase operation                                 | Supply current delta                                   |     |     | 10  | mA                 |
| $I_{DDPGM}$                  | Supply current from VDD during program operation                               | Supply current delta                                   |     |     | 10  | mA                 |
| <b>Endurance</b>             |                                                                                |                                                        |     |     |     |                    |
| $N_{WEC(HI\_ENDURANCE)}$     | Erase/program cycle endurance for chosen 32 sectors of flash <sup>(1)</sup>    |                                                        | 100 |     |     | k cycles           |
| $N_{WEC(NORMAL\_ENDURANCE)}$ | Erase/program cycle endurance (Flash not used for HI_ENDURANCE) <sup>(1)</sup> |                                                        | 10  |     |     | k cycles           |
| $NE_{(MAX)}$                 | Total erase operations before failure <sup>(2)</sup>                           |                                                        | 802 |     |     | k erase operations |
| $NW_{(MAX)}$                 | Write operations per word line before sector erase <sup>(3)</sup>              |                                                        |     |     | 83  | write operations   |
| <b>Retention</b>             |                                                                                |                                                        |     |     |     |                    |
| $t_{RET\_85}$                | Flash memory data retention                                                    | $-40^{\circ}\text{C} \leq T_J \leq 85^{\circ}\text{C}$ | 60  |     |     | years              |

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                       |                                                           | TEST CONDITIONS                                     | MIN  | TYP | MAX | UNIT  |
|---------------------------------|-----------------------------------------------------------|-----------------------------------------------------|------|-----|-----|-------|
| t <sub>RET_105</sub>            | Flash memory data retention                               | -40°C ≤ T <sub>j</sub> ≤ 105°C                      | 11.4 |     |     | years |
| <b>Program and Erase Timing</b> |                                                           |                                                     |      |     |     |       |
| t <sub>PROG</sub> (WORD, 64)    | Program time for flash word <sup>(4)</sup> <sup>(6)</sup> |                                                     |      | 50  | 275 | μs    |
| t <sub>PROG</sub> (SEC, 64)     | Program time for 1kB sector <sup>(5)</sup> <sup>(6)</sup> |                                                     |      | 6.4 |     | ms    |
| t <sub>ERASE</sub> (SEC)        | Sector erase time                                         | ≤2k erase/program cycles,<br>T <sub>j</sub> ≥ 25°C  |      | 4   | 20  | ms    |
| t <sub>ERASE</sub> (SEC)        | Sector erase time                                         | ≤10k erase/program cycles,<br>T <sub>j</sub> ≥ 25°C |      | 20  | 150 | ms    |
| t <sub>ERASE</sub> (SEC)        | Sector erase time                                         | ≤10k erase/program cycles                           |      | 20  | 200 | ms    |
| t <sub>ERASE</sub> (BANK)       | Bank erase time                                           | ≤10k erase/program cycles                           |      | 22  | 220 | ms    |

- (1) Up to 32 application-chosen sectors from the main flash bank(s) or data bank can be used as high endurance sectors. This enables applications that frequently update flash data such as EEPROM emulation.
- (2) Total number of cumulative erase operations supported by the flash before failure. A sector erase or bank erase operation is considered to be one erase operation.
- (3) Maximum number of write operations allowed per word line before the word line must be erased. If additional writes to the same word line are required, a sector erase is required once the maximum number of write operations per word line is reached.
- (4) Program time is defined as the time from when the program command is triggered until the command completion interrupt flag is set in the flash controller.
- (5) Sector program time is defined as the time from when the first word program command is triggered until the final word program command completes and the interrupt flag is set in the flash controller. This time includes the time needed for software to load each flash word (after the first flash word) into the flash controller during programming of the sector.
- (6) Flash word size is 64 data bits (8 bytes). On devices with ECC, the total flash word size is 72 bits (64 data bits plus 8 ECC bits).

## 7.8 Timing Characteristics

VDD=5V, T<sub>a</sub>=25 °C (unless otherwise noted)

| PARAMETER                              |                                                                       | TEST CONDITIONS    | MIN | TYP  | MAX | UNIT   |
|----------------------------------------|-----------------------------------------------------------------------|--------------------|-----|------|-----|--------|
| Wakeup Timing                          |                                                                       |                    |     |      |     |        |
| t <sub>WAKE, SLEEP</sub>               | Wakeup time from SLEEP0 to RUN <sup>(1)</sup>                         |                    |     | 2    |     | cycles |
|                                        | Wakeup time from SLEEP1 to RUN <sup>(1)</sup>                         |                    |     | 1.7  |     | us     |
|                                        | Wakeup time from SLEEP2 to RUN <sup>(1)</sup>                         |                    |     | 2.3  |     | us     |
| t <sub>WAKE, STOP</sub>                | Wakeup time from STOP0 to RUN (SYSOSC enabled) <sup>(1)</sup>         |                    |     | 8.1  |     | us     |
|                                        | Wakeup time from STOP2 to RUN (SYSOSC disabled) <sup>(1)</sup>        |                    |     | 8.8  |     | us     |
| t <sub>WAKE, STBY</sub>                | Wakeup time from STANDBY0 to RUN <sup>(1)</sup>                       |                    |     | 12.8 |     | us     |
|                                        | Wakeup time from STANDBY1 to RUN <sup>(1)</sup>                       |                    |     | 12.8 |     | us     |
| Asynchronous Fast Clock Request Timing |                                                                       |                    |     |      |     |        |
| t <sub>DELAY</sub>                     | Delay time from edge of asynchronous request to first 32MHz MCLK edge | Mode is SLEEP1     |     | 0.3  |     | us     |
|                                        |                                                                       | Mode is SLEEP2     |     | 0.9  |     | us     |
|                                        |                                                                       | Mode is STOP0      |     | 0.9  |     | us     |
|                                        |                                                                       | Mode is STOP2      |     | 0.9  |     | us     |
|                                        |                                                                       | Mode is STANDBY0   |     | 5.0  |     | us     |
|                                        |                                                                       | Mode is STANDBY1   |     | 5.0  |     | us     |
| Startup Timing                         |                                                                       |                    |     |      |     |        |
| t <sub>START, RESET</sub>              | Device cold start-up time from reset/ power-up <sup>(2)</sup>         | Fast boot enabled  |     | 252  |     | us     |
|                                        |                                                                       | Fast boot disabled |     | 292  |     | us     |
| NRST Timing                            |                                                                       |                    |     |      |     |        |

VDD=5V, T<sub>a</sub>=25 °C (unless otherwise noted)

| PARAMETER                     |                                              | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-------------------------------|----------------------------------------------|-----------------|-----|-----|-----|------|
| t <sub>RST</sub> ,<br>BOOTRST | Pulse length on NRST pin to generate BOOTRST | ULPCLK=SYSOSC   |     | 2   |     | us   |
|                               |                                              | ULPCLK=LFOSC    |     | 100 |     | us   |
| t <sub>RST</sub> , POR        | Pulse length on NRST pin to generate POR     |                 |     | 1   |     | s    |

- (1) The wake-up time is measured from the edge of an external wake-up signal (GPIO wake-up event) to the time that the first instruction of the user program is executed, with glitch filter disabled (FILTEREN=0x0) and fast wake enabled (FASTWAKEONLY=1).
- (2) The start-up time is measured from the time that VDD crosses VBOR0+ (cold start-up) to the time that the first instruction of the user program is executed.

## 7.9 Clock Specifications

### 7.9.1 System Oscillator (SYSOSC)

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                       |                                                                                                                               | TEST CONDITIONS                                                  | MIN  | TYP | MAX | UNIT |
|---------------------------------|-------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------|------|-----|-----|------|
| f <sub>SYSOSC</sub>             | Factory trimmed SYSOSC frequency                                                                                              | SYSOSCCFG.FREQ=00 (BASE)                                         |      | 32  |     | MHz  |
| f <sub>SYSOSC</sub>             | SYSOSC frequency accuracy when frequency correction loop (FCL) is enabled when the internal ROSC resistor is used (1) (2) (3) | SETUSEFCL=1, T <sub>a</sub> = 25 °C                              | 0    |     | 1   | %    |
|                                 |                                                                                                                               | SETUSEFCL=1 -40 °C ≤ T <sub>a</sub> ≤ 125 °C                     | -2.1 |     | 1.6 |      |
| f <sub>SYSOSC</sub>             | SYSOSC accuracy when frequency correction loop (FCL) is disabled, 32MHz                                                       | SETUSEFCL=0, SYSOSCCFG.FREQ=00, -40 °C ≤ T <sub>a</sub> ≤ 125 °C | -2.6 |     | 1.8 | %    |
| t <sub>settle</sub> ,<br>SYSOSC | Settling time to target accuracy                                                                                              | SETUSEFCL=1                                                      |      |     | 36  | us   |

- (1) The SYSOSC frequency correction loop (FCL) enables high SYSOSC accuracy via an internal reference resistor when using the FCL. See the SYSOSC section of the technical reference manual for details on computing SYSOSC accuracy.
- (2) SYSOSC Accuracy is measured in the default power-up state, with MCLK = SYSOSC, and the CPU running a while(1) loop.
- (3) SYSOSC is measured with the internal FCC counter using an external 1ms pulse as the measurement trigger.

### 7.9.2 Low Frequency Oscillator (LFOSC)

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                     |                           | TEST CONDITIONS                  | MIN | TYP   | MAX | UNIT |
|-------------------------------|---------------------------|----------------------------------|-----|-------|-----|------|
| f <sub>LFOSC</sub>            | LFOSC frequency           |                                  |     | 32768 |     | Hz   |
| f <sub>LFOSC</sub>            | LFOSC accuracy            | -40 °C ≤ T <sub>a</sub> ≤ 125 °C | -5  |       | 5   | %    |
| f <sub>LFOSC</sub>            | LFOSC accuracy            | -40 °C ≤ T <sub>a</sub> ≤ 85 °C  | -3  |       | 3   | %    |
| I <sub>LFOSC</sub>            | LFOSC current consumption |                                  |     | 300   |     | nA   |
| t <sub>start</sub> ,<br>LFOSC | LFOSC start-up time       |                                  |     | 1     |     | ms   |

### 7.9.3 High Frequency Crystal/Clock

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                                       |                 | TEST CONDITIONS | MIN   | TYP | MAX | UNIT |
|-------------------------------------------------|-----------------|-----------------|-------|-----|-----|------|
| <b>High frequency crystal oscillator (HFXT)</b> |                 |                 |       |     |     |      |
| f <sub>HFXT</sub>                               | HFXT frequency  | HFXTTRSEL=00    | 4     |     | 8   | MHz  |
| f <sub>HFXT</sub>                               | HFXT frequency  | HFXTTRSEL=01    | 8.01  |     | 16  | MHz  |
| f <sub>HFXT</sub>                               | HFXT frequency  | HFXTTRSEL=10    | 16.01 |     | 32  | MHz  |
| DC <sub>HFXT</sub>                              | HFXT duty cycle | HFXTTRSEL=00    | 40    |     | 65  | %    |
| DC <sub>HFXT</sub>                              | HFXT duty cycle | HFXTTRSEL=01    | 40    |     | 60  | %    |

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                                            |                                                      | TEST CONDITIONS                                                                                                                 | MIN | TYP | MAX | UNIT |
|------------------------------------------------------|------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|------|
| DC <sub>HFXT</sub>                                   | HFXT duty cycle                                      | HFXTRSEL=10                                                                                                                     | 40  |     | 60  | %    |
| OA <sub>HFXT</sub>                                   | HFXT crystal oscillation allowance                   | HFXTRSEL=00<br>(4 to 8MHz range)                                                                                                |     | 2   |     | kΩ   |
| C <sub>L, eff</sub>                                  | Integrated effective load capacitance <sup>(1)</sup> |                                                                                                                                 |     | 1   |     | pF   |
| t <sub>start, HFXT</sub>                             | HFXT start-up time <sup>(2)</sup>                    | HFXTRSEL=11,<br>32MHz crystal                                                                                                   |     | 0.5 |     | ms   |
| I <sub>HFXT</sub>                                    | HFXT current consumption <sup>(2)</sup>              | f <sub>HFXT</sub> =4MHz,<br>R <sub>m</sub> =300Ω,<br>C <sub>L</sub> =12pF                                                       |     | 100 |     | uA   |
| I <sub>HFXT</sub>                                    | HFXT current consumption <sup>(2)</sup>              | f <sub>HFXT</sub> =32MHz,<br>R <sub>m</sub> =30Ω,<br>C <sub>L</sub> =12pF,<br>C <sub>m</sub> =6.26fF,<br>L <sub>m</sub> =1.76mH |     | 600 |     | uA   |
| <b>High frequency digital clock input (HFCLK_IN)</b> |                                                      |                                                                                                                                 |     |     |     |      |
| f <sub>HFIN</sub>                                    | HFCLK_IN frequency <sup>(3)</sup>                    | USEEXTHFCLK<br>=1                                                                                                               | 4   |     | 32  | MHz  |
| DC <sub>HFIN</sub>                                   | HFCLK_IN duty cycle <sup>(3)</sup>                   | USEEXTHFCLK<br>=1                                                                                                               | 40  |     | 60  | %    |

- (1) This includes parasitic bond and package capacitance (≈2pF per pin), calculated as  $C_{HFXIN} \times C_{HFXOUT} / (C_{HFXIN} + C_{HFXOUT})$ , where  $C_{HFXIN}$  and  $C_{HFXOUT}$  are the total capacitance at HFXIN and HFXOUT, respectively.
- (2) The HFXT startup time (t<sub>start, HFXT</sub>) is measured from the time the HFXT is enabled until stable oscillation for a typical crystal. Start-up time is dependent upon crystal frequency and crystal specifications. Refer to the HFXT section of the [MSPM0 H-Series 32-MHz Microcontrollers Technical Reference Manual](#). Current consumption increases with higher RSEL and start up time is decreases with higher RSEL.
- (3) The digital clock input (HFCLK\_IN) accepts a logic level square wave clock.

### 7.9.4 Low Frequency Crystal/Clock

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                                           |                                                      | TEST CONDITIONS         | MIN   | TYP   | MAX   | UNIT |
|-----------------------------------------------------|------------------------------------------------------|-------------------------|-------|-------|-------|------|
| <b>Low frequency crystal oscillator (LFXT)</b>      |                                                      |                         |       |       |       |      |
| f <sub>LFXT</sub>                                   | LFXT frequency                                       |                         |       | 32768 |       | Hz   |
| DC <sub>LFXT</sub>                                  | LFXT duty cycle                                      |                         | 30    |       | 70    | %    |
| OA <sub>LFXT</sub>                                  | LFXT crystal oscillation allowance                   |                         |       | 419   |       | kΩ   |
| C <sub>L, eff</sub>                                 | Integrated effective load capacitance <sup>(1)</sup> |                         |       | 1     |       | pF   |
| t <sub>start, LFXT</sub>                            | LFXT start-up time <sup>(2)</sup>                    |                         |       | 200   |       | ms   |
| I <sub>LFXT</sub>                                   | LFXT current consumption                             | XT1DRIVE=0,<br>LOWCAP=1 |       | 200   |       | nA   |
| <b>Low frequency digital clock input (LFCLK_IN)</b> |                                                      |                         |       |       |       |      |
| f <sub>LFIN</sub>                                   | LFCLK_IN frequency <sup>(3)</sup>                    | SETUSEEXLF=1            | 29491 | 32768 | 36045 | Hz   |
| DC <sub>LFIN</sub>                                  | LFCLK_IN duty cycle <sup>(3)</sup>                   | SETUSEEXLF=1            | 40    |       | 60    | %    |
| <b>LFCLK Monitor</b>                                |                                                      |                         |       |       |       |      |
| f <sub>FAULTLF</sub>                                | LFCLK monitor fault frequency <sup>(4)</sup>         | MONITOR=1               | 2800  | 4200  | 8400  | Hz   |

- (1) This includes parasitic bond and package capacitance (≈2pF per pin), calculated as  $C_{LFXIN} \times C_{LFXOUT} / (C_{LFXIN} + C_{LFXOUT})$ , where  $C_{LFXIN}$  and  $C_{LFXOUT}$  are the total capacitance at LFXIN and LFXOUT, respectively.
- (2) The user must ensure that the crystal is properly rated to support the start-up drive load (e.g. 0.1uW)
- (3) The digital clock input (LFCLK\_IN) accepts a logic level square wave clock.
- (4) The LFCLK monitor may be used to monitor the LFXT or LFCLK\_IN. It will always fault below the MIN fault frequency, and will never fault above the MAX fault frequency.

## 7.10 Digital IO

### 7.10.1 Electrical Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER        |                                                    | TEST CONDITIONS         |                                                     | MIN     | TYP | MAX                 | UNIT |
|------------------|----------------------------------------------------|-------------------------|-----------------------------------------------------|---------|-----|---------------------|------|
| V <sub>IH</sub>  | High level input voltage                           |                         | VDD ≥ 4.5V                                          | 0.7*VDD |     | VDD                 | V    |
| V <sub>IL</sub>  | Low level input voltage                            |                         | VDD ≥ 4.5V                                          | -0.3    |     | 0.3*VDD             | V    |
| V <sub>HYS</sub> | Hysteresis                                         |                         |                                                     | 0.1*VDD |     |                     | V    |
| I <sub>lkg</sub> | High-Z leakage current                             | HSIO <sup>(1)</sup>     | VDD = 5.5V                                          |         |     | 0.79 <sup>(4)</sup> | uA   |
|                  | High-Z leakage current (all pins except PA1, PA28) | SDIO <sup>(2) (3)</sup> | VDD = 5.5V                                          |         |     | 0.42 <sup>(4)</sup> |      |
|                  | High-Z leakage current (PA1, PA28)                 | SDIO <sup>(2) (3)</sup> | VDD = 5.5V                                          |         |     | 2.0                 |      |
| R <sub>PU</sub>  | Pull up resistance                                 |                         | VIN = VSS                                           |         | 40  |                     | kΩ   |
| C <sub>I</sub>   | Input capacitance                                  |                         | VDD = 5V                                            |         | 20  |                     | pF   |
| V <sub>OH</sub>  | High level output voltage                          | HSIO                    | VDD ≥ 4.5V,  I <sub>IO</sub>   <sub>max</sub> = 6mA | VDD-0.4 |     |                     | V    |
|                  | High level output voltage                          | SDIO                    | VDD ≥ 4.5V,  I <sub>IO</sub>   <sub>max</sub> = 3mA | VDD-0.4 |     |                     |      |
| V <sub>OL</sub>  | Low level output voltage                           | HSIO                    | VDD ≥ 4.5V,  I <sub>IO</sub>   <sub>max</sub> = 6mA |         |     | 0.4                 | V    |
|                  | Low level output voltage                           | SDIO                    | VDD ≥ 4.5V,  I <sub>IO</sub>   <sub>max</sub> = 3mA |         |     | 0.4                 |      |

- (1) I/O Types: SDIO = Standard-Drive (8-MHz), HSIO = High-Speed (16-MHz)  
(2) The leakage current is measured with VSS or VDD applied to the corresponding pin(s), unless otherwise noted.  
(3) The leakage of the digital port pins is measured individually. The port pin is selected for input and the pullup/pulldown resistor is disabled.  
(4) This value is for IOs not muxed with any analog inputs. If the IO is muxed with analog inputs then the leakage can be higher.

### 7.10.2 Switching Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                       |                       | TEST CONDITIONS     |                                   | MIN | TYP | MAX                  | UNIT |
|---------------------------------|-----------------------|---------------------|-----------------------------------|-----|-----|----------------------|------|
| f <sub>max</sub>                | Port output frequency | SDIO <sup>(1)</sup> | VDD ≥ 4.5V, C <sub>L</sub> = 20pF |     |     | 8                    | MHz  |
| f <sub>max</sub>                | Port output frequency | HSIO                | VDD ≥ 2.7V, C <sub>L</sub> = 20pF |     |     | 16                   | MHz  |
| t <sub>r</sub> , t <sub>f</sub> | Output rise/fall time | All output ports    | VDD ≥ 4.5V                        |     |     | 0.3/f <sub>max</sub> | s    |

- (1) I/O Types: SDIO = Standard-Drive, HSIO = High-Speed

## 7.11 ADC

### 7.11.1 Electrical Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted), all TYP values are measured at 25°C and all accuracy parameters are measured using 12-bit resolution mode (unless otherwise noted)

| PARAMETER            |                                            | TEST CONDITIONS                                                                            |  | MIN | TYP  | MAX  | UNIT |
|----------------------|--------------------------------------------|--------------------------------------------------------------------------------------------|--|-----|------|------|------|
| V <sub>IN(ADC)</sub> | Analog input voltage range <sup>(1)</sup>  | Applies to all ADC analog input pins                                                       |  | 0   |      | VDD  | V    |
| V <sub>R+</sub>      | Positive ADC reference voltage             | V <sub>R+</sub> sourced from VDD                                                           |  |     | VDD  |      | V    |
|                      |                                            | V <sub>R+</sub> sourced from internal reference (VREF)                                     |  |     | 4.05 |      | V    |
| V <sub>R-</sub>      | Negative ADC reference voltage             |                                                                                            |  |     | 0    |      | V    |
| F <sub>S</sub>       | ADC sampling frequency                     | RES = 0x0 (12-bit mode), External Reference                                                |  |     |      | 1.6  | MSPS |
|                      |                                            | RES = 0x1 (10-bit mode), External Reference                                                |  |     |      | 1.77 |      |
|                      |                                            | RES = 0x2 (8-bit mode), External Reference                                                 |  |     |      | 2    |      |
| F <sub>S</sub>       | ADC sampling frequency                     | RES = 0x0 (12-bit mode), Internal Reference                                                |  |     |      | 0.9  | MSPS |
|                      |                                            | RES = 0x1 (10-bit mode), Internal Reference                                                |  |     |      | 1    |      |
|                      |                                            | RES = 0x2 (8-bit mode), Internal Reference                                                 |  |     |      | 1.2  |      |
| I <sub>(ADC)</sub>   | Operating supply current into VDD terminal | F <sub>S</sub> = 1.6MSPS, V <sub>R+</sub> = VDD                                            |  |     | 350  |      | μA   |
|                      |                                            | F <sub>S</sub> = 0.9MSPS, V <sub>R+</sub> = VREF = 4.05V (VREF power consumption included) |  |     | 400  |      |      |

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted), all TYP values are measured at 25°C and all accuracy parameters are measured using 12-bit resolution mode (unless otherwise noted)

| PARAMETER              |                                                    | TEST CONDITIONS                                                                                          | MIN  | TYP  | MAX  | UNIT |
|------------------------|----------------------------------------------------|----------------------------------------------------------------------------------------------------------|------|------|------|------|
| C <sub>S/H</sub>       | ADC sample-and-hold capacitance                    |                                                                                                          |      | 0.22 |      | pF   |
| R <sub>in</sub>        | ADC switch resistance                              |                                                                                                          |      | 15   |      | kΩ   |
| ENOB <sub>AC</sub>     | Effective number of bits, AC                       | Internal reference, V <sub>R+</sub> = VREF = 4.05V, f <sub>in</sub> = 5kHz                               | 9.2  | 10.2 |      | bit  |
|                        |                                                    | External reference <sup>(2)</sup> , f <sub>in</sub> = 5kHz                                               | 10.0 | 10.7 |      |      |
|                        |                                                    | External reference with over sampling, f <sub>in</sub> = 1kHz                                            |      | 11.4 |      |      |
| SNR                    | Signal-to-noise ratio                              | External reference <sup>(2)</sup>                                                                        |      | 68   |      | dB   |
|                        |                                                    | External reference with over sampling                                                                    |      | 74   |      |      |
|                        |                                                    | Internal reference, V <sub>R+</sub> = VREF = 4.05V                                                       |      | 64   |      |      |
| PSRR <sub>DC</sub>     | Power supply rejection ratio, DC                   | VDD = VDD <sub>(min)</sub> to VDD <sub>(max)</sub><br>Internal reference, V <sub>R+</sub> = VREF = 4.05V |      | 60   |      | dB   |
| PSRR <sub>DC</sub>     | Power supply rejection ratio, DC                   | External reference (4), VDD = VDD <sub>(min)</sub> to VDD <sub>(max)</sub>                               |      | 64   |      | dB   |
| PSRR <sub>AC</sub>     | Power supply rejection ratio, AC                   | ΔVDD = 0.1 V at 1 kHz<br>Internal reference, V <sub>R+</sub> = VREF = 4.05V                              |      | 48.6 |      | dB   |
| PSRR <sub>AC</sub>     | Power supply rejection ratio, AC                   | ΔVDD = 0.1 V at 1 kHz<br>External reference, V <sub>R+</sub> = VREF = 4.05V                              |      | 61   |      | dB   |
| T <sub>wakeup</sub>    | ADC Wakeup Time                                    | Assumes internal reference is active                                                                     |      |      | 5    | us   |
| V <sub>SupplyMon</sub> | Supply Monitor voltage divider (VDD/3) accuracy    | ADC input channel: Supply Monitor <sup>(3)</sup>                                                         | -1.5 |      | +1.5 | %    |
| I <sub>SupplyMon</sub> | Supply Monitor voltage divider current consumption | ADC input channel: Supply Monitor                                                                        |      | 16   |      | uA   |

- (1) The analog input voltage range must be within the selected ADC reference voltage range V<sub>R+</sub> to V<sub>R-</sub> for valid conversion results.
- (2) All external reference specifications are measured with V<sub>R+</sub> = VREF+ = VDD = 5V and V<sub>R-</sub> = VREF- = VSS = 0V and external 1uF cap on VREF+ pin
- (3) Analog power supply monitor. Analog input on channel 31 is disconnected and is internally connected to the voltage divider which is VDD/3.

### 7.11.2 Switching Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                     |                                         | TEST CONDITIONS                                                                    | MIN   | TYP | MAX | UNIT          |
|-------------------------------|-----------------------------------------|------------------------------------------------------------------------------------|-------|-----|-----|---------------|
| f <sub>ADCCLK</sub>           | ADC clock frequency                     |                                                                                    | 4     |     | 32  | MHz           |
| t <sub>ADC trigger</sub>      | Software trigger minimum width          |                                                                                    | 3     |     |     | ADCCLK cycles |
| t <sub>Sample_step</sub>      | Sampling time for step input            | 12-bit mode, R <sub>S</sub> = 50Ω, C <sub>pext</sub> = 10pF, V <sub>step</sub> =4V | 0.188 |     |     | μs            |
| t <sub>Sample_step</sub>      | Sampling time for step input            | 12-bit mode, R <sub>S</sub> = 50Ω, C <sub>pext</sub> = 10pF, V <sub>step</sub> =5V | 0.400 |     |     | μs            |
| t <sub>Sample_VREF</sub>      | Sample time with internal VREF input    | ADC CHANNEL=29, 12-bit mode, VDD as reference                                      | 10    |     |     | μs            |
| t <sub>Sample_SupplyMon</sub> | Sample time with Supply Monitor (VDD/3) |                                                                                    | 3     |     |     | μs            |

### 7.11.3 Linearity Parameters

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted), all TYP values are measured at 25°C and all linearity parameters are measured using 12-bit resolution mode (unless otherwise noted) <sup>(1)</sup>

| PARAMETER      |                                    | TEST CONDITIONS                           | MIN  | TYP | MAX  | UNIT |
|----------------|------------------------------------|-------------------------------------------|------|-----|------|------|
| E <sub>I</sub> | Integral linearity error (INL)     | External reference, 12-bit <sup>(2)</sup> | -2.5 |     | +2.5 | LSB  |
| E <sub>D</sub> | Differential linearity error (DNL) | External reference, 12-bit <sup>(2)</sup> | -1   |     | +1.5 | LSB  |
|                | Differential linearity error (DNL) | External reference, 10-bit <sup>(2)</sup> | -1   |     | +0.4 |      |
| E <sub>O</sub> | Offset error                       | External reference, 12-bit <sup>(2)</sup> | -5   |     | 5    | mV   |
| E <sub>G</sub> | Gain error                         | External reference, 12-bit <sup>(2)</sup> | -6   |     | 6    | LSB  |

- (1) Total Unadjusted Error (TUE) can be calculated from E<sub>I</sub>, E<sub>O</sub>, and E<sub>G</sub> using the following formula: TUE = √(E<sub>I</sub><sup>2</sup> + |E<sub>O</sub>|<sup>2</sup> + E<sub>G</sub><sup>2</sup>)  
Note: You must convert all of the errors into the same unit, usually LSB, for the above equation to be accurate
- (2) All external reference specifications are measured with V<sub>R+</sub> = VREF+ = VDD = 5V and V<sub>R-</sub> = VREF- = VSS = 0V and external 1uF cap on VREF+ pin

## 7.11.4 Typical Connection Diagram

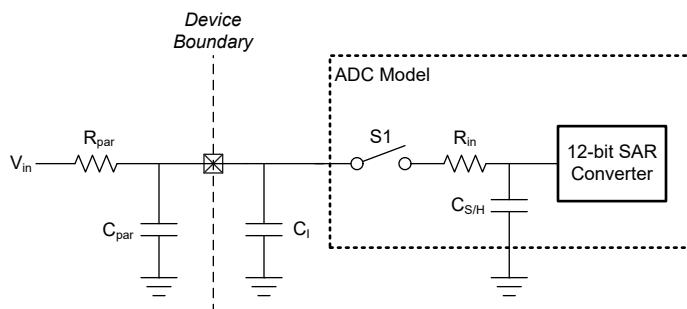


**Figure 7-2. ADC Input Network**

1. Refer to [Electrical Characteristics](#) for the values of  $R_{in}$  and  $C_{S/H}$
2. Refer to [Electrical Characteristics](#) for the value of  $C_I$
3.  $C_{par}$  and  $R_{par}$  represent the parasitic capacitance and resistance of the external ADC input circuitry

Use the following equations to solve for the minimum sampling time (T) required for an ADC conversion:

1.  $\tau = (R_{par} + R_{in}) \times C_{S/H} + R_{par} \times (C_{par} + C_I)$
2.  $K = \ln(2^n / \text{Settling error}) - \ln((C_{par} + C_I) / C_{S/H})$
3.  $T \text{ (minimum sampling time)} = K \times \tau$

## 7.12 Temperature Sensor

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

| PARAMETER            | TEST CONDITIONS                                                                                                                                     | MIN   | TYP  | MAX   | UNIT  |
|----------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------|-------|------|-------|-------|
| TS <sub>TRIM</sub>   | Factory trim temperature <sup>(2)</sup><br>ADC and VREF configuration: RES=0 (12-bit mode), VRSEL=2h (VREF=1.4V), ADC tSample=12.5μs                | 27    | 30   | 33    | °C    |
| TS <sub>c</sub>      | Temperature coefficient<br>-40 °C ≤ T <sub>j</sub> ≤ 130 °C                                                                                         | -2.05 | -1.9 | -1.75 | mV/°C |
| t <sub>SET, TS</sub> | Temperature sensor settling time <sup>(3)</sup><br>ADC and VREF configuration: RES=0 (12-bit mode), VRSEL=4h (VREF+=4.05V, VREF-=0), ADC CHANNEL=28 |       | 5    | 10    | us    |

- (1) Effective absolute temperature accuracy may be computed by combining the relative temperature accuracy together with the trim accuracy, and accounting for any analog to digital conversion error.
- (2) Higher absolute accuracy may be achieved through user calibration.
- (3) This is the minimum required ADC sampling time when measuring the temperature sensor.

## 7.13 VREF

### 7.13.1 Voltage Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER          | TEST CONDITIONS                                  | MIN  | TYP  | MAX  | UNIT |
|--------------------|--------------------------------------------------|------|------|------|------|
| VDD <sub>min</sub> | Minimum supply voltage needed for VREF operation | 4.5  | 5    | 5.5  | V    |
| VREF               | Voltage reference output voltage                 | 3.98 | 4.05 | 4.12 | V    |

### 7.13.2 Electrical Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER         | TEST CONDITIONS                                                                                                                                       | MIN | TYP | MAX | UNIT |
|-------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|------|
| I <sub>VREF</sub> | VREF operating supply current (this spec is an estimation and will be more reliable once the IP is further in the design phase)<br>No load<br>No load |     | 150 | 200 | μA   |

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER            |                                                | TEST CONDITIONS                  |                             | MIN | TYP | MAX | UNIT   |
|----------------------|------------------------------------------------|----------------------------------|-----------------------------|-----|-----|-----|--------|
| TC <sub>VREF</sub>   | Temperature coefficient of VREF <sup>(1)</sup> |                                  |                             |     |     | 80  | ppm/°C |
| TC <sub>drift</sub>  | Long term VREF drift                           | Time = 1000 hours, T = 25°C      | Time = 1000 hours, T = 25°C |     |     | 300 | ppm    |
| PSRR <sub>DC</sub>   | VREF Power supply rejection ratio, DC          | VDD 4.5 to VDDmax, BUFCONFIG = 1 |                             | 49  | 60  |     | dB     |
| T <sub>startup</sub> | VREF startup time                              | VDD = 5 V                        | VDD = 5 V                   |     |     | 30  | us     |

(1) The temperature coefficient of the VREF output is the sum of TC<sub>V<sub>R</sub>BUF</sub> and the temperature coefficient of the internal bandgap reference.

## 7.14 I2C

### 7.14.1 I2C Characteristics

over operating free-air temperature range (unless otherwise noted)

| PARAMETERS          |                                                  | TEST CONDITIONS      | Standard mode |      | Fast mode |     | Fast mode plus |      | UNIT |
|---------------------|--------------------------------------------------|----------------------|---------------|------|-----------|-----|----------------|------|------|
|                     |                                                  |                      | MIN           | MAX  | MIN       | MAX | MIN            | MAX  |      |
| f <sub>I2C</sub>    | I2C input clock frequency                        | I2C in Power Domain0 |               | 32   |           | 32  |                | 32   | MHz  |
| f <sub>SCL</sub>    | SCL clock frequency                              |                      |               | 100  |           | 400 |                | 1000 | kHz  |
| t <sub>HD,STA</sub> | Hold time (repeated) START                       |                      | 4             |      | 0.6       |     | 0.26           |      | us   |
| t <sub>LOW</sub>    | LOW period of the SCL clock                      |                      | 4.7           |      | 1.3       |     | 0.5            |      | us   |
| t <sub>HIGH</sub>   | High period of the SCL clock                     |                      | 4             |      | 0.6       |     | 0.26           |      | us   |
| t <sub>SU,STA</sub> | Setup time for a repeated START                  |                      | 4.7           |      | 0.6       |     | 0.26           |      | us   |
| t <sub>HD,DAT</sub> | Data hold time                                   |                      | 0             |      | 0         |     | 0              |      | ns   |
| t <sub>SU,DAT</sub> | Data setup time                                  |                      | 250           |      | 100       |     | 50             |      | ns   |
| t <sub>SU,STO</sub> | Setup time for STOP                              |                      | 4             |      | 0.6       |     | 0.26           |      | us   |
| t <sub>BUF</sub>    | bus free time between a STOP and START condition |                      | 4.7           |      | 1.3       |     | 0.5            |      | us   |
| t <sub>VD,DAT</sub> | data valid time                                  |                      |               | 3.45 |           | 0.9 |                | 0.45 | us   |
| t <sub>VD,ACK</sub> | data valid acknowledge time                      |                      |               | 3.45 |           | 0.9 |                | 0.45 | us   |

### 7.14.2 I2C Filter

over operating free-air temperature range (unless otherwise noted)

| PARAMETERS      |                                                     | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------------|-----------------------------------------------------|-----------------|-----|-----|-----|------|
| f <sub>SP</sub> | Pulse duration of spikes suppressed by input filter | AGFSELx = 0     |     | 6   |     | ns   |
|                 |                                                     | AGFSELx = 1     |     | 14  | 35  | ns   |
|                 |                                                     | AGFSELx = 2     |     | 22  | 60  | ns   |
|                 |                                                     | AGFSELx = 3     |     | 35  | 90  | ns   |

### 7.14.3 I<sup>2</sup>C Timing Diagram

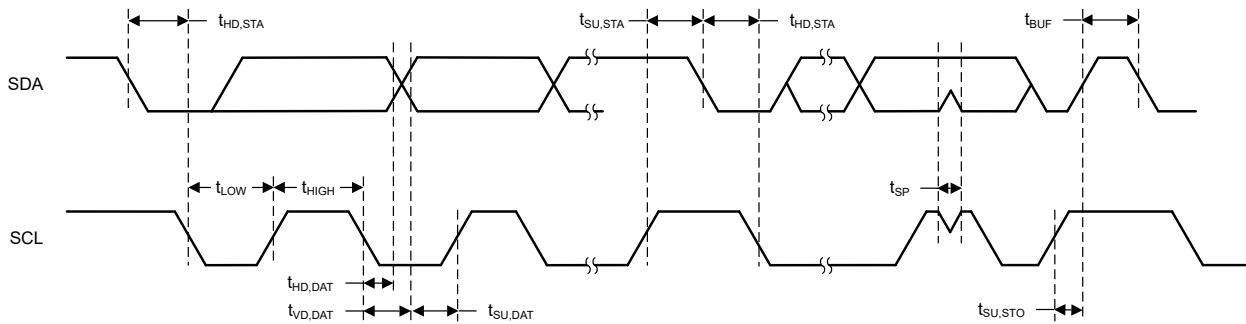


Figure 7-3. I2C Timing Diagram

## 7.15 SPI

### 7.15.1 SPI

over operating free-air temperature range (unless otherwise noted)

| PARAMETERS            |                                                        | TEST CONDITIONS                                                   | MIN                       | TYP                  | MAX                       | UNIT |
|-----------------------|--------------------------------------------------------|-------------------------------------------------------------------|---------------------------|----------------------|---------------------------|------|
| <b>SPI</b>            |                                                        |                                                                   |                           |                      |                           |      |
| f <sub>SPI</sub>      | SPI clock frequency                                    | MCLK = 32MHz<br>4.5 < VDD < 5.5V<br>Peripheral or Controller mode |                           |                      | 16 <sup>(4)</sup>         | MHz  |
| DC <sub>SCK</sub>     | SCK Duty Cycle                                         |                                                                   | 40                        | 50                   | 60                        | %    |
| <b>Controller</b>     |                                                        |                                                                   |                           |                      |                           |      |
| t <sub>SCLK_H/L</sub> | SCLK High or Low time                                  |                                                                   | (t <sub>SPI</sub> /2) - 1 | t <sub>SPI</sub> / 2 | (t <sub>SPI</sub> /2) + 1 | ns   |
| t <sub>CS,LEAD</sub>  | CS lead-time, CS active to clock                       | SPH=0                                                             | 1 SPI<br>CLOCK            |                      |                           | ns   |
| t <sub>CS,LEAD</sub>  | CS lead-time, CS active to clock                       | SPH=1                                                             | 1/2 SPI<br>CLOCK          |                      |                           |      |
| t <sub>CS,LAG</sub>   | CS lag time, Last clock to CS<br>inactive              | SPH=0                                                             | 1/2 SPI<br>CLOCK          |                      |                           | ns   |
| t <sub>CS,LAG</sub>   | CS lag time, Last clock to CS<br>inactive              | SPH=1                                                             | 1 SPI<br>CLOCK            |                      |                           |      |
| t <sub>CS,ACC</sub>   | CS access time, CS active to PICO<br>data out          |                                                                   |                           |                      | 1/2 SPI<br>CLOCK          | ns   |
| t <sub>CS,DIS</sub>   | CS disable time, CS inactive to<br>PICO high impedance |                                                                   |                           |                      | 1 SPI<br>CLOCK            | ns   |
| t <sub>SU,CI</sub>    | POCI input data setup time <sup>(1)</sup>              | delayed sampling enabled                                          | 3                         |                      |                           | ns   |
| t <sub>SU,CI</sub>    | POCI input data setup time <sup>(1)</sup>              | no delayed sampling                                               | 34                        |                      |                           | ns   |
| t <sub>HD,CI</sub>    | POCI input data hold time                              | delayed sampling enabled                                          | 23                        |                      |                           | ns   |
| t <sub>HD,CI</sub>    | POCI input data hold time                              | no delayed sampling                                               | 0                         |                      |                           | ns   |
| t <sub>VALID,CO</sub> | PICO output data valid time <sup>(2)</sup>             |                                                                   |                           |                      | 10                        | ns   |
| t <sub>HD,CO</sub>    | PICO output data hold time <sup>(3)</sup>              |                                                                   | 0                         |                      |                           | ns   |
| <b>Peripheral</b>     |                                                        |                                                                   |                           |                      |                           |      |
| t <sub>CS,LEAD</sub>  | CS lead-time, CS active to clock                       |                                                                   | 15                        |                      |                           | ns   |
| t <sub>CS,LAG</sub>   | CS lag time, Last clock to CS<br>inactive              |                                                                   | 1                         |                      |                           | ns   |
| t <sub>CS,ACC</sub>   | CS access time, CS active to POCI<br>data out          |                                                                   |                           |                      | 45                        | ns   |
| t <sub>CS,DIS</sub>   | CS disable time, CS inactive to<br>POCI high impedance |                                                                   |                           |                      | 45                        | ns   |
| t <sub>SU,PI</sub>    | PICO input data setup time                             |                                                                   | 15                        |                      |                           | ns   |

over operating free-air temperature range (unless otherwise noted)

| PARAMETERS     | TEST CONDITIONS                            | MIN | TYP | MAX | UNIT |
|----------------|--------------------------------------------|-----|-----|-----|------|
| $t_{HD,PI}$    | PICO input data hold time                  | 3   |     |     | ns   |
| $t_{VALID,PO}$ | POCI output data valid time <sup>(2)</sup> |     |     | 33  | ns   |
| $t_{HD,PO}$    | POCI output data hold time <sup>(3)</sup>  | 7   |     |     | ns   |

- (1) The POCI input data setup time can be fully compensated when delayed sampling feature is enabled.
- (2) Specifies the time to drive the next valid data to the output after the output changing SCLK clock edge
- (3) Specifies how long data on the output is valid after the output changing SCLK clock edge
- (4)  $f_{SPIClk} = 1/2t_{LO/HI}$  with  $t_{LO/HI} = \max(t_{VALID,CO} + t_{SU,PI}, t_{SU,CI} + t_{VALID,PO})$ .

### 7.15.2 SPI Timing Diagram

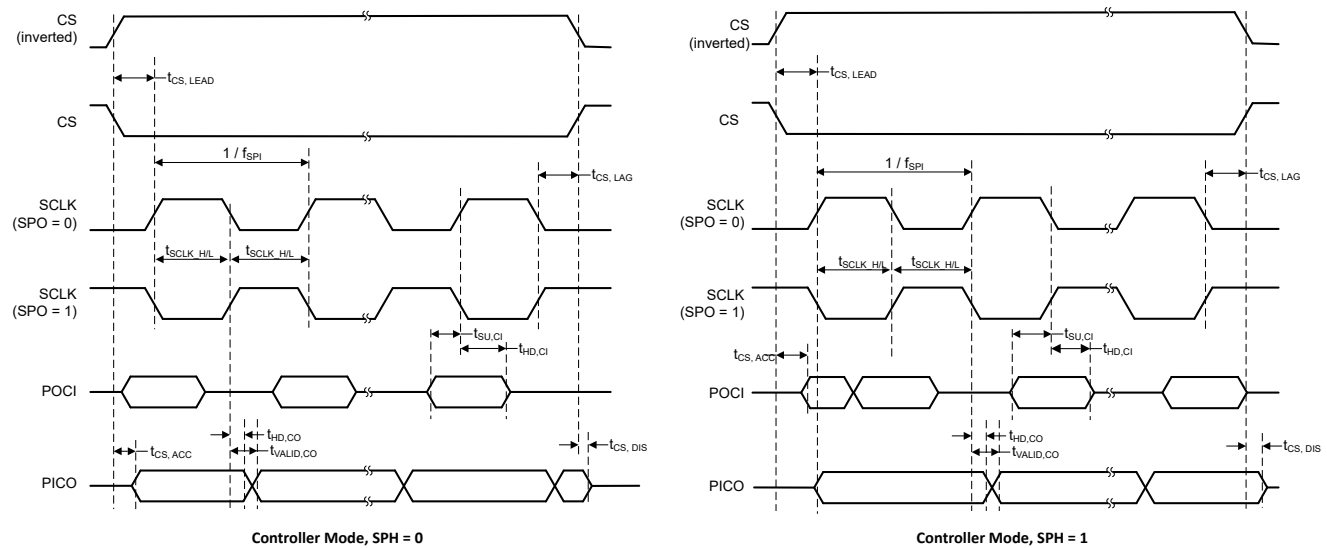


**Figure 7-4. SPI timing diagram - Controller Mode**

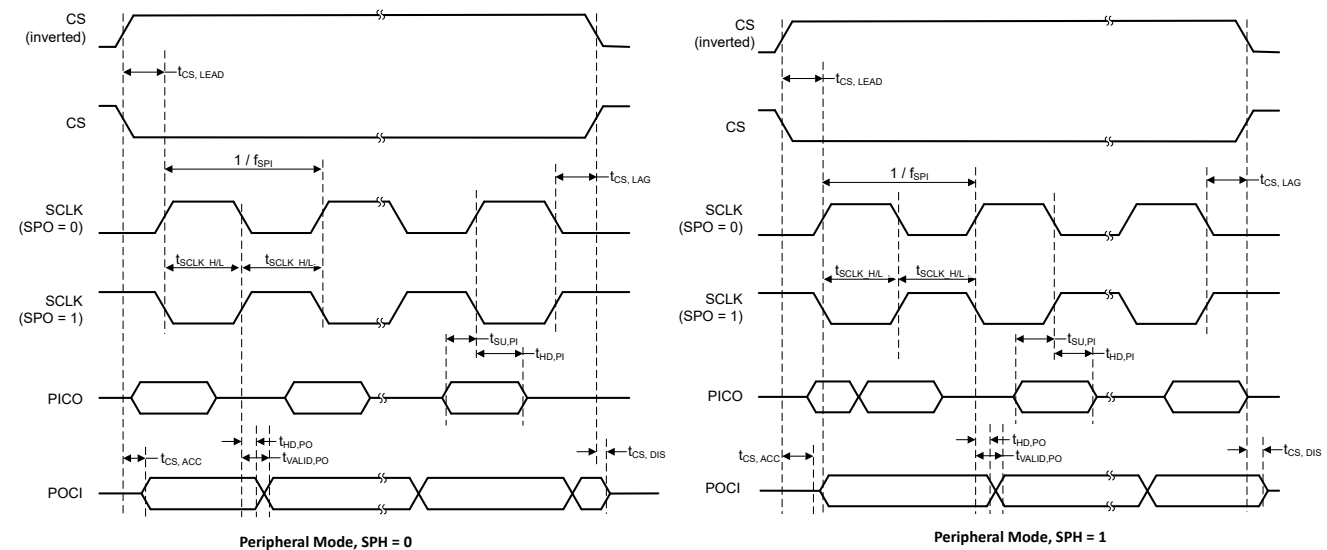


**Figure 7-5. SPI timing diagram - Peripheral Mode**

## 7.16 UART

over operating free-air temperature range (unless otherwise noted)

| PARAMETERS          |                                                                    | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---------------------|--------------------------------------------------------------------|-----------------|-----|-----|-----|------|
| $f_{\text{UART}}$   | UART input clock frequency                                         |                 |     |     | 32  | MHz  |
| $f_{\text{BITCLK}}$ | BITCLK clock frequency(equals baud rate in MBaud)                  |                 |     |     | 4   | MHz  |
| $t_{\text{SP}}$     | Pulse duration of spikes suppressed by input filter <sup>(1)</sup> | AGFSELx = 0     |     | 6   |     | ns   |
|                     |                                                                    | AGFSELx = 1     |     | 14  | 35  | ns   |
|                     |                                                                    | AGFSELx = 2     |     | 22  | 60  | ns   |
|                     |                                                                    | AGFSELx = 3     |     | 35  | 90  | ns   |

- (1) Pulses on the UART receive input (RX) that are shorter than the UART receive deglitch time are suppressed. Thus the selected deglitch time can limit the maximum useable baud rate. To ensure that pulses are correctly recognized, their duration should exceed the maximum specification of the deglitch time.

## 7.17 TIMx

over operating free-air temperature range (unless otherwise noted)

| PARAMETERS           |                             | TEST CONDITIONS                                    | MIN     | TYP | MAX   | UNIT                 |
|----------------------|-----------------------------|----------------------------------------------------|---------|-----|-------|----------------------|
| $t_{\text{res}}$     | Timer resolution time       | $f_{\text{TIMxCLK}} = 64\text{MHz}$ <sup>(1)</sup> | 15.625  |     |       | ns                   |
| $t_{\text{res}}$     | Timer resolution time       | $f_{\text{TIMxCLK}} = 32\text{MHz}$                | 31.25   |     |       | ns                   |
|                      |                             |                                                    | 1       |     |       | $t_{\text{TIMxCLK}}$ |
| $t_{\text{COUNTER}}$ | 16-bit counter clock period | $f_{\text{TIMxCLK}} = 64\text{MHz}$ <sup>(1)</sup> | 0.01563 |     | 1024  | us                   |
| $t_{\text{COUNTER}}$ | 16-bit counter clock period | $f_{\text{TIMxCLK}} = 32\text{MHz}$                | 0.03125 |     | 2048  | us                   |
|                      |                             |                                                    | 1       |     | 65536 | $t_{\text{TIMxCLK}}$ |

- (1)  $f_{\text{TIMxCLK}} = 64\text{MHz}$  only applies to TIMA0 with clock doubler configured

## 7.18 Emulation and Debug

### 7.18.1 SWD Timing

over operating free-air temperature range (unless otherwise noted)

| PARAMETER        |               | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|------------------|---------------|-----------------|-----|-----|-----|------|
| $f_{\text{SWD}}$ | SWD frequency |                 |     |     | 10  | MHz  |

## 8 Detailed Description

The following sections describe all of the components that make up the devices in this data sheet. The peripherals integrated into these devices are configured by software through Memory Mapped Registers (MMRs). For more details, see the corresponding chapter of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#).

## 8.1 Overview

MSPM0H321x microcontrollers (MCUs) are part of the MSP highly-integrated 5V power supply and 32-bit MCU family based on the enhanced Arm® Cortex®-M0+ core platform operating at up to 32MHz frequency. These cost-optimized MCUs offer high-performance analog peripheral integration, support extended temperature ranges from -40°C to 125°C, and operate with supply voltages from 4.5V.

The MSPM0H321x devices provide up to 64KB embedded flash program memory with 8KB SRAM. These MCUs incorporate a high-speed on-chip oscillator with an accuracy up to -2.1 to 1.6%, eliminating the need for an external crystal. Additional features include a 3-channel DMA, CRC-16 accelerator, and a variety of high-performance analog peripherals such as one 12-bit 1.6-Msps ADC with VDD as the voltage reference, and an on-chip temperature sensor. These devices also offer intelligent digital peripherals such as one 16-bit advanced timer, four 16-bit general purpose timer, one windowed watchdog timer, one independent watchdog timer, a real-time clock (RTC) and a variety of communication peripherals including three UART, one SPI, and two I<sup>2</sup>C. These communication peripherals offer protocol support for LIN, IrDA, DALI, Manchester, smart card, SMBus, and PMBus.

The TI MSPM0 family of low-power MCUs consists of devices with varying degrees of analog and digital integration enabling customers to find the MCU that meets their project needs. The architecture combined with extensive low-power modes is optimized to achieve extended battery life in portable measurement applications.

MSPM0H321x MCUs are supported by an extensive hardware and software ecosystem with reference designs and code examples to get the design started quickly. Development kits include a LaunchPad™ kit available for purchase and design files for a target-socket board. TI also provides a free MSP Software Development Kit (SDK), which is available as a component of [Code Composer Studio™ IDE](#) desktop and cloud version within the [TI Resource Explorer](#). MSPM0 MCUs are also supported by extensive online collateral, training with [MSP Academy](#), and online support through the [TI E2E™ support forums](#).

For complete module descriptions, see the [MSPM0H-Series 32MHz Microcontrollers Technical Reference Manual](#).

## 8.2 CPU

The CPU subsystem (MCPUSS) implements an Arm Cortex-M0+ CPU, a system timer, and interrupt management features. The Arm Cortex-M0+ is a cost-optimized 32-bit CPU that delivers high performance and low power to embedded applications. Key features of the CPU Sub System include:

- Arm Cortex-M0+ CPU supports clock frequencies from 32kHz to 32MHz
  - ARMv6-M Thumb instruction set (little endian) with 32-cycle 32x32 fast multiply instruction
- Prefetch logic to improve sequential code execution, and I-cache with 2 64-bit cache lines
- System timer (SysTick) with 24-bit down counter and automatic reload
- Nested vectored interrupt controller (NVIC) with 4 programmable priority levels and tail chaining

## 8.3 Operating Modes

MSPM0H MCUs provide four main operating modes (power modes) to allow for optimization of the device power consumption based on application requirements. In order of decreasing power, the modes are: RUN, SLEEP, STOP and STANDBY. The CPU is active executing code in RUN mode. Peripheral interrupt events can wake the device from SLEEP, STOP, or STANDBY mode to the RUN mode.

To further balance performance and power consumption, MSPM0H devices implement two power domains: PD1 (for the CPU, memories, and high performance peripherals), and PD0 (for low speed, low power peripherals). PD1 is always powered in RUN and SLEEP modes, but is disabled in all other modes. PD0 is always powered in RUN, SLEEP, STOP, and STANDBY modes.

### 8.3.1 Functionality by Operating Mode (MSPM0H321x)

[Table 8-1](#) lists the supported functionality in each operating mode.

Functional key:

- **EN:** The function is enabled in the specified mode.
- **DIS:** The function is disabled (either clock or power gated) in the specified mode, but the function's configuration is retained.
- **OPT:** The function is optional in the specified mode, and remains enabled if configured to be enabled.
- **NS:** The function is not automatically disabled in the specified mode, but it is not supported.
- **OFF:** The function is fully powered off in the specified mode, and no configuration information is retained.

**Table 8-1. Supported Functionality by Operating Mode**

| Operating Mode  |                                             | RUN        |      |      | SLEEP  |        |        | STOP                    |       | STANDBY   |                    |
|-----------------|---------------------------------------------|------------|------|------|--------|--------|--------|-------------------------|-------|-----------|--------------------|
|                 |                                             | RUN0       | RUN1 | RUN2 | SLEEP0 | SLEEP1 | SLEEP2 | STOP0                   | STOP2 | STANDBY0  | STANDBY1           |
| Oscillators     | SYSOSC                                      | EN         | EN   | DIS  | EN     | EN     | DIS    | OPT <sup>(1)</sup>      | DIS   | DIS       | DIS                |
|                 | LFOSC                                       | EN         |      |      |        |        |        |                         |       |           |                    |
| Clocks          | CPUCLK                                      | 32M        | 32k  | 32k  | DIS    |        |        |                         |       |           |                    |
|                 | MCLK to PD1                                 | 32M        | 32k  | 32k  | 32M    | 32k    | 32k    | DIS                     |       |           |                    |
|                 | ULPCLK to PD0                               | 32M        | 32k  | 32k  | 32M    | 32k    | 32k    | 4M <sup>(1)</sup>       | 32k   | DIS       |                    |
|                 | ULPCLK to TIMG14, TIMG8                     | 32M        | 32k  | 32k  | 32M    | 32k    | 32k    | 4M <sup>(1)</sup>       | 32k   |           |                    |
|                 | MFCLK                                       | OPT        | DIS  |      | OPT    | DIS    |        | OPT                     | DIS   |           |                    |
|                 | LFCLK                                       | 32k        |      |      |        |        |        |                         |       |           | DIS                |
|                 | LFCLK to TIMG14, TIMG1, TIMG2, TIMG8, TIMA0 | 32k        |      |      |        |        |        |                         |       |           |                    |
|                 | MCLK Monitor                                | OPT        |      |      |        |        |        |                         |       |           | DIS                |
|                 | LFCLK Monitor                               | OPT        |      |      |        |        |        |                         |       |           |                    |
| PMU             | POR Monitor                                 | EN         |      |      |        |        |        |                         |       |           |                    |
|                 | BOR Monitor                                 | EN         |      |      |        |        |        |                         |       |           |                    |
|                 | Core Regulator                              | Full drive |      |      |        |        |        |                         |       | Low drive |                    |
| Core Functions  | CPU                                         | EN         |      |      | DIS    |        |        |                         |       |           |                    |
|                 | DMA                                         | OPT        |      |      |        |        |        | NS (triggers supported) |       |           |                    |
|                 | Flash                                       | EN         |      |      |        |        |        | OPT                     |       | DIS       |                    |
|                 | SRAM                                        | EN         |      |      |        |        |        | OPT                     |       | DIS       |                    |
| PD1 Peripherals | SPI0                                        | OPT        |      |      |        |        |        | DIS                     |       |           |                    |
|                 | CRC                                         | OPT        |      |      |        |        |        | DIS                     |       |           |                    |
| PD0 Peripherals | TIMG14                                      | OPT        |      |      |        |        |        |                         |       |           |                    |
|                 | TIMG1                                       | OPT        |      |      |        |        |        |                         |       |           | DIS                |
|                 | TIMG2                                       | OPT        |      |      |        |        |        |                         |       |           | DIS                |
|                 | TIMG8                                       | OPT        |      |      |        |        |        |                         |       |           | DIS                |
|                 | TIMA0                                       | OPT        |      |      |        |        |        |                         |       |           | DIS                |
|                 | UART0                                       | OPT        |      |      |        |        |        |                         |       |           | DIS                |
|                 | UART1                                       | OPT        |      |      |        |        |        |                         |       |           | DIS                |
|                 | UART2                                       | OPT        |      |      |        |        |        |                         |       |           | DIS                |
|                 | I2C0                                        | OPT        |      |      |        |        |        |                         |       |           | DIS                |
|                 | I2C1                                        | OPT        |      |      |        |        |        |                         |       |           | DIS                |
|                 | GPIOA                                       | OPT        |      |      |        |        |        |                         |       |           | OPT <sup>(2)</sup> |
|                 | GPIOB                                       | OPT        |      |      |        |        |        |                         |       |           | OPT <sup>(2)</sup> |
|                 | WWDT0                                       | OPT        |      |      |        |        |        |                         |       |           | OPT <sup>(2)</sup> |

**Table 8-1. Supported Functionality by Operating Mode (continued)**

| Operating Mode      |                    | RUN  |      |      | SLEEP   |        |        | STOP    |                         | STANDBY  |          |
|---------------------|--------------------|------|------|------|---------|--------|--------|---------|-------------------------|----------|----------|
|                     |                    | RUN0 | RUN1 | RUN2 | SLEEP0  | SLEEP1 | SLEEP2 | STOP0   | STOP2                   | STANDBY0 | STANDBY1 |
| Analog              | ADC0               | OPT  |      |      |         |        |        |         | NS (triggers supported) |          |          |
|                     | VREF               | OPT  |      |      |         |        |        |         | NS                      |          |          |
|                     | Temperature Sensor | OPT  |      |      |         |        |        |         |                         | OFF      |          |
| IOMUX and IO Wakeup |                    | EN   |      |      |         |        |        |         |                         |          |          |
| Wake Sources        |                    | N/A  |      |      | ANY IRQ |        |        | PD0 IRQ |                         |          |          |

- (1) If STOP0 is entered from RUN1 (SYSOSC enabled but MCLK sourced from LFCLK), SYSOSC remains enabled as it was in RUN1, and ULPClk remains at 32kHz as it was in RUN1. If STOP0 is entered from RUN2 (SYSOSC was disabled and MCLK was sourced from LFCLK), SYSOSC remains disabled as it was in RUN2, and ULPClk remains at 32kHz as it was in RUN2.
- (2) When using the STANDBY1 policy for STANDBY, only TIMG14 is clocked. These PD0 peripherals can generate an asynchronous fast clock request upon external activity but are not actively clocked.

## 8.4 Power Management Unit (PMU)

The power management unit (PMU) generates the internally regulated core supplies for the device and provides supervision of the external supply (VDD). The PMU also contains the bandgap voltage reference used by the PMU itself as well as analog peripherals. Key features of the PMU include:

- Power-on reset (POR) supply monitor
- Brown-out reset (BOR) supply monitor
- Core regulator with support for RUN, SLEEP, STOP, and STANDBY operating modes to dynamically balance performance with power consumption
- Parity-protected trim to immediately generate a power-on reset (POR) in the event that a power management trim is corrupted

For more details, see the PMU chapter of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#).

## 8.5 Clock Module (CKM)

The clock module provides the following oscillators:

- **LFOSC**: Internal low-frequency oscillator (32kHz)
- **SYSOSC**: Internal high-frequency oscillator (32MHz)
- **LFXT**: Low frequency, low power crystal oscillator (32kHz typical frequency)
- **HFXT**: High frequency crystal oscillator (4-32MHz typical frequency)
- **LFCKIN**: low-frequency digital clock input (32KHz)
- **HFCKIN**: high-frequency digital clock input (4 to 32MHz)

The following clocks are distributed by the clock module for use by the processor, bus, and peripherals:

- **MCLK**: Main system clock for PD1 peripherals, derived from SYSOSC or LFCLK, active in RUN and SLEEP modes
- **CPUCLK**: Clock for the processor (derived from MCLK), active in RUN mode
- **HFCLK**: High frequency external clock
- **HSCLK**: High speed clock derived from HFCLK, available in RUN and SLEEP mode
- **ULPCLK**: Ultra-low power clock for PD0 peripherals, active in RUN, SLEEP, STOP, and STANDBY modes
- **MFCLK**: 4MHz fixed mid-frequency clock for peripherals, available in RUN, SLEEP, and STOP modes
- **LFCLK**: 32kHz fixed low-frequency clock for peripherals or MCLK, active in RUN, SLEEP, STOP, and STANDBY modes
- **ADCCLK**: ADC clock, available in RUN, SLEEP and STOP modes
- **RTCCLK**: Fixed 32kHz clock direct to RTC

- **CLK\_OUT:** Used to output a clock externally, available in RUN, SLEEP, STOP, and STANDBY modes

For more details, see the CKM chapter of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#).

## 8.6 DMA\_B

The direct memory access (DMA) controller allows movement of data from one memory address to another without CPU intervention. For example, the DMA can be used to move data from ADC conversion memory to SRAM. The DMA reduces system power consumption by allowing the CPU to remain in low power mode, without having to awaken to move data to or from a peripheral.

The DMA\_B in these devices support the following key features:

- 3 DMA transfer channel
  - 2 full-feature channels, supporting repeated transfer modes
  - 1 basic channel, supporting single transfer mode
- Configurable DMA channel priorities
- Direct peripheral to DMA trigger is supported from ADC, UART, SPI or timer triggers.
- Byte (8-bit), short word (16-bit) and word (32-bit) or mixed byte and word transfer capability
- Transfer counter block size supports up to 64k transfers of any data type
- Configurable DMA transfer trigger selection
- Active channel interruption to service other channels
- Early interrupt generation for ping-pong buffer architecture
- Cascading channels upon completion of activity on another channel
- Stride mode to support data re-organization, such as 3-phase metering applications
- Gather mode

[DMA\\_B Channel Features](#) shows the DMA features that are supported and the corresponding DMA channel numbers.

**Table 8-2. DMA\_B Channel Features**

| DMA Feature                  | DMA_B                |               |
|------------------------------|----------------------|---------------|
|                              | Full-Feature Channel | Basic Channel |
| Channel Number               | 0, 1                 | 2             |
| Repeated mode                | ✓                    | –             |
| Table & fill mode            | ✓                    | –             |
| Gather mode                  | ✓                    | –             |
| Early IRQ notification       | ✓                    | –             |
| Auto enable                  | ✓                    | ✓             |
| Long long (128-bit) transfer | ✓                    | ✓             |
| Stride mode                  | ✓                    | ✓             |
| Cascading channel support    | ✓                    | ✓             |

[DMA Trigger Mapping](#) lists the available triggers for the DMA which are configured using the DMATCTL.DMATSEL control bits in the DMA memory mapped registers.

**Table 8-3. DMA Trigger Mapping**

| DMACTL.DMATSEL | TRIGGER SOURCE                |
|----------------|-------------------------------|
| 0              | Software                      |
| 1              | Generic Subscriber 0 (FSUB_0) |
| 2              | Generic Subscriber 0 (FSUB_1) |
| 9              | UART0 PUBLISHER 1             |
| 10             | UART0 PUBLISHER 2             |
| 13             | UART2 PUBLISHER 1             |
| 14             | UART2 PUBLISHER 2             |

**Table 8-3. DMA Trigger Mapping (continued)**

| DMACTL.DMATSEL | TRIGGER SOURCE    |
|----------------|-------------------|
| 7              | SPI0 PUBLISHER 1  |
| 8              | SPI0 PUBLISHER 2  |
| 5              | I2C1 PUBLISHER 1  |
| 6              | I2C1 PUBLISHER 2  |
| 3              | I2C0 PUBLISHER 1  |
| 4              | I2C0 PUBLISHER 2  |
| 15             | ADC0 EVT g        |
| 11             | UART1 PUBLISHER 1 |
| 12             | UART1 PUBLISHER 2 |

## 8.7 Events

The event manager transfers digital events from one entity (for example, a peripheral) to another (for example, a second peripheral, the DMA or the CPU). The event manager implements event transfer through a defined set of event publishers (generators) and subscribers (receivers) that are interconnected through an event fabric containing a combination of static and programmable routes.

Events that are transferred by the event manager include:

- Peripheral event transferred to the CPU as an interrupt request (IRQ) (Static Event)
  - Example: GPIO interrupt is sent to the CPU
- Peripheral event transferred to the DMA as a DMA trigger (DMA Event)
  - Example: ADC trigger to DMA to request a DMA transfer
- Peripheral event transferred to another peripheral to directly trigger an action in hardware (Generic Event)
  - Example: TIMx timer peripheral publishes a periodic event to the ADC subscriber port, and the ADC uses the event to trigger start-of-sampling

For more details, see the Event chapter of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#).

**Table 8-4. Generic Event Channels**

A generic route is either a point-to-point (1:1) route or a point-to-two (1:2) splitter route in which the peripheral publishing the event is configured to use one of several available generic route channels to publish the event to another entity (or entities, in the case of a splitter route). An entity can be another peripheral, a generic DMA trigger event, or a generic CPU event.

| CHANID | Generic Route Channel Selection   | Channel Type     |
|--------|-----------------------------------|------------------|
| 0      | No generic event channel selected | N/A              |
| 1      | Generic event channel 1 selected  | 1 : 1            |
| 2      | Generic event channel 2 selected  | 1 : 1            |
| 3      | Generic event channel 3 selected  | 1 : 1            |
| 4      | Generic event channel 4 selected  | 1 : 1            |
| 5      | Generic event channel 5 selected  | 1 : 1            |
| 6      | Generic event channel 6 selected  | 1 : 2 (splitter) |
| 7      | Generic event channel 6 selected  | 1 : 2 (splitter) |

## 8.8 Memory

### 8.8.1 Memory Organization

[Table 8-5](#) summarizes the memory map of the devices. For more information about the memory region detail, see the [Platform Memory Map](#) section in the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#).

**Table 8-5. Memory Organization**

| Memory Region | Subregion              | MSPM0H3215                                        | MSPM0H3216                                        |
|---------------|------------------------|---------------------------------------------------|---------------------------------------------------|
| Code (Flash)  | Flash                  | 32KB <sup>(1)</sup><br>0x0000.0000 to 0x0000.7FFF | 64KB <sup>(1)</sup><br>0x0000.0000 to 0x0000.FFFF |
| SRAM (SRAM)   | SRAM                   | 8KB<br>0x2000.0000 to 0x2000.1FFF                 | 8KB<br>0x2000.0000 to 0x2000.1FFF                 |
| Peripheral    | Peripherals            | 0x4000.0000 to 0x40FF.FFFF                        | 0x4000.0000 to 0x40FF.FFFF                        |
|               | Flash                  | 0x0040.0000 to 0x0040.7FFF                        | 0x0040.0000 to 0x0040.FFFF                        |
|               | NONMAIN <sup>(2)</sup> | 512 bytes<br>0x41C0.0000 to 0x41C0.07FF           | 512 bytes<br>0x41C0.0000 to 0x41C0.07FF           |
|               | FACTORY                | 0x41C4.0000 to 0x41C4.03FF                        | 0x41C4.0000 to 0x41C4.03FF                        |
| Subsystem     |                        | 0x6000.0000 to 0x7FFF.FFFF                        | 0x6000.0000 to 0x7FFF.FFFF                        |
| System PPB    |                        | 0xE000.0000 to 0xE00F.FFFF                        | 0xE000.0000 to 0xE00F.FFFF                        |

(1) First 32KB flash memory (address 0x0000.0000 to 0x0000.8000) has up to 100000 program/erase cycles.

(2) Modifying the NONMAIN configuration region can result in permanent device lockout if the region is not reprogrammed with a valid configuration. Valid configurations must include accurate CRC values and appropriate debug policies in order to maintain device access.

### 8.8.2 Peripheral File Map

Table 8-6 lists the available peripherals and the register base address for each.

**Table 8-6. Peripherals Summary**

| Peripheral name | Base Address | Size       |
|-----------------|--------------|------------|
| VREF            | 0x40030000   | 0x00001F00 |
| WWDT0           | 0x40080000   | 0x00001500 |
| TIMG14          | 0x40084000   | 0x00001F00 |
| TIMG1           | 0x40086000   | 0x00001F00 |
| TIMG2           | 0x40088000   | 0x00001F00 |
| TIMG8           | 0x40090000   | 0x00001F00 |
| LFSS            | 0x40094000   | 0x00001600 |
| RTC_B           | 0x40094000   | 0x00001600 |
| IWDT            | 0x40094000   | 0x00001600 |
| GPIOA           | 0x400A0000   | 0x00001F00 |
| GPIOB           | 0x400A2000   | 0x00001F00 |
| SYSCTL          | 0x400AF000   | 0x00003100 |
| DEBUGSS         | 0x400C7000   | 0x00001F00 |
| EVENT           | 0x400C9000   | 0x00003000 |
| FLASHCTL        | 0x400CD000   | 0x00002000 |
| I2C0            | 0x400F0000   | 0x00001F00 |
| I2C1            | 0x400F2000   | 0x00001F00 |
| UART1           | 0x40100000   | 0x00001F00 |
| UART2           | 0x40102000   | 0x00001F00 |
| UART0           | 0x40108000   | 0x00001F00 |
| CPUSS           | 0x40400000   | 0x00001F00 |
| WUC             | 0x40424000   | 0x00000500 |
| IOMUX           | 0x40428000   | 0x00002000 |
| DMA             | 0x4042A000   | 0x00001F00 |
| CRC             | 0x40440000   | 0x00002000 |
| SPI0            | 0x40468000   | 0x00001F00 |

**Table 8-6. Peripherals Summary (continued)**

| Peripheral name | Base Address | Size       |
|-----------------|--------------|------------|
| ADC0            | 0x4055A000   | 0x00001000 |
| TIMA0           | 0x40860000   | 0x00001F00 |

### 8.8.3 Peripheral Interrupt Vector

[Interrupt Vector Number](#) shows the IRQ number for each peripheral.

**Table 8-7. Interrupt Vector Number**

| Peripheral name | NVIC IRQ |
|-----------------|----------|
| SYSCTL          | 0        |
| DEBUGSS         | 1        |
| TIMG8           | 2        |
| UART1           | 3        |
| ADC0            | 4        |
| UART2           | 8        |
| SPI0            | 9        |
| UART0           | 15       |
| TIMG14          | 16       |
| TIMG2           | 17       |
| TIMA0           | 18       |
| TIMG1           | 19       |
| GPIOA           | 22       |
| GPIOB           | 23       |
| I2C0            | 24       |
| I2C1            | 25       |
| FLASHCTL        | 27       |
| WWDT0           | 29       |
| LFSS            | 30       |
| RTC_B           | 30       |
| IWDT            | 30       |
| DMA             | 31       |

## 8.9 Flash Memory

A single bank of nonvolatile flash memory is provided for storing executable program code and application data.

Key features of the flash include:

- In-circuit program and erase operations supported across the entire recommended supply range
- Small 1KB sector sizes (minimum erase resolution of 1KB)
- Up to 100,000 program/erase cycles on 32 selected sectors of the flash memory, with up to 10,000 program/erase cycles on the remaining flash memory (devices with 32kB support 100,000 cycles on the entire flash memory)

For a complete description of the flash memory, see the NVM chapter of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#).

## 8.10 SRAM

MSPM0Hxx MCUs include a low-power high-performance SRAM memory with zero wait state access across the supported CPU frequency range of the device. SRAM memory can be used for storing volatile information such as the call stack, heap, global data, and code. The SRAM memory content is fully retained in RUN, SLEEP, STOP, and STANDBY operating modes. A write protection mechanism is provided to allow the application to dynamically write protect the SRAM memory with 1KB resolution. Write protection is useful when placing executable code into SRAM to provide a level of protection against unintentional overwrites of code by either the CPU or DMA. Placing code in SRAM can improve performance of critical loops by enabling zero wait state operation and lower power consumption.

## 8.11 GPIO

The general purpose input/output (GPIO) peripheral lets the application write data out and read data in through the device pins. Through the use of the Port A and Port B GPIO peripheral, these devices support up to 45 GPIO pins.

The key features of the GPIO module include:

- 0 wait state MMR access from CPU
- Set, clear, or toggle multiple bits without the need of a read-modify-write construct in software
- "FastWake" feature enables low-power wakeup from STOP and STANDBY modes for any GPIO port
- User controlled input filtering

## 8.12 IOMUX

The IOMUX peripheral enables IO pad configuration and controls digital data flow to and from the device pins. The key features of the IOMUX include:

- IO pad configuration registers allow for programmable drive strength, speed, pullup, and more
- Digital pin muxing allows for multiple peripheral signals to be routed to the same IO pad
- Pin functions and capabilities are user-configured using the PINCM register

For more details, see the IOMUX chapter of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#).

## 8.13 ADC

The 12-bit analog-to-digital converter (ADC) module in these devices support fast 12-bit conversions with single-ended inputs.

ADC features include:

- 12-bit output resolution at up to 1.6-Msps with greater than 10-bit ENOB
- Up to 27 external input channels
- Internal channels for temperature sensing, supply monitoring, and analog signal chain
- Software selectable reference:
  - Configurable internal dedicated ADC reference voltage of 4.05V (VREF)
  - MCU supply voltage (VDD)
  - Support for bringing in an external reference on VREF+/- device pins
- Operates in RUN, SLEEP, and STOP modes and supports triggers from STANDBY mode

**Table 8-8. ADC0 Channel Mapping**

| CHANNEL[0:7] | SIGNAL NAME | CHANNEL[8:15] | SIGNAL NAME |
|--------------|-------------|---------------|-------------|
| 0            | A0          | 16            | A16         |
| 1            | A1          | 17            | A17         |
| 2            | A2          | 18            | A18         |
| 3            | A3          | 19            | A19         |
| 4            | A4          | 20            | A20         |
| 5            | A5          | 21            | A21         |
| 6            | A6          | 22            | A22         |
| 7            | A7          | 23            | A23         |
| 8            | A8          | 24            | A24         |
| 9            | A9          | 25            | A25         |
| 10           | A10         | 26            | A26         |
| 11           | A11         | 27            | Reserved    |

**Table 8-8. ADC0 Channel Mapping (continued)**

| CHANNEL[0:7] | SIGNAL NAME | CHANNEL[8:15] | SIGNAL NAME                   |
|--------------|-------------|---------------|-------------------------------|
| 12           | A12         | 28            | <i>Temperature Sensor</i>     |
| 13           | A13         | 29            | VREF                          |
| 14           | A14         | 30            | Reserved                      |
| 15           | A15         | 31            | <i>Supply/Battery Monitor</i> |

*Italicized* signal names are internal to the SoC. These signals are used for internal peripheral interconnections.

For more details, see the ADC chapter of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#).

## 8.14 Temperature Sensor

The temperature sensor provides a voltage output that changes linearly with device temperature. The temperature sensor output is internally connected to one of ADC input channels to enable a temperature-to-digital conversion.

A unit-specific single-point calibration value for the temperature sensor is provided in the factory constants memory region. This calibration value represents the ADC conversion result (in ADC code format) corresponding to the temperature sensor being measured in 12-bit mode with the 4.05V internal VREF at the factory trim temperature ( $TS_{TRIM}$ ). This calibration value can be used with the temperature sensor temperature coefficient ( $TS_C$ ) to estimate the device temperature. See the temperature sensor section of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#) for guidance on estimating the device temperature with the factory trim value.

## 8.15 VREF

The voltage reference module (VREF) in these devices contains a configurable voltage reference buffer dedicated for the on-board ADC.

VREF features include:

- 4.05V internal reference
- Internal reference supports ADC operation up to 0.9Msps at 12-bit mode

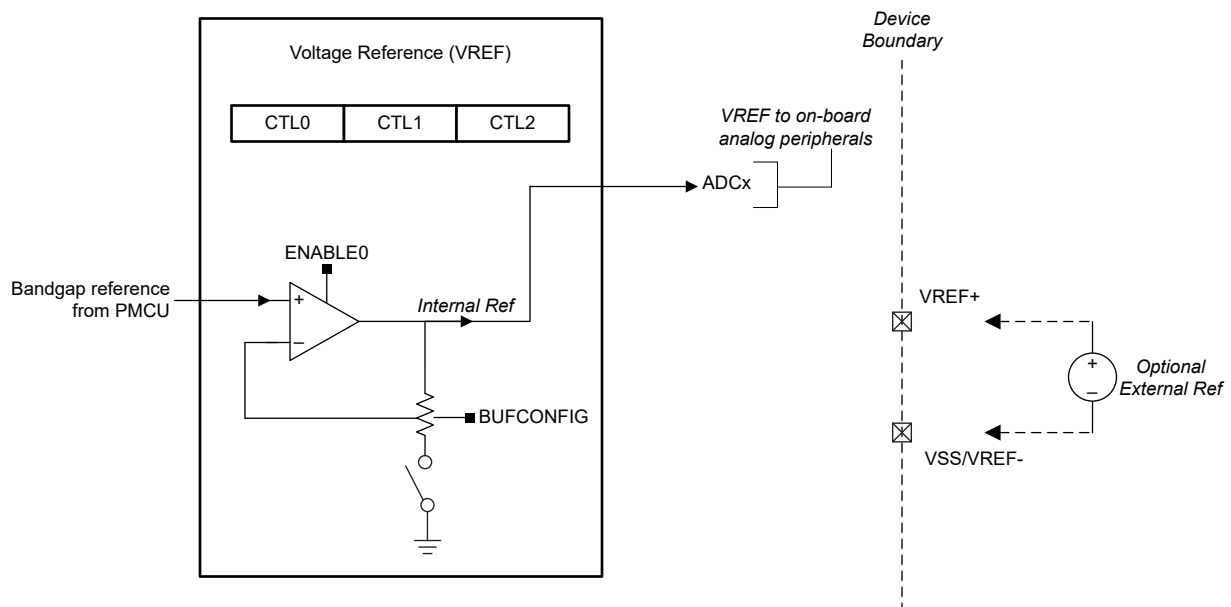


**Figure 8-1. VREF module**

For more details, see the VREF chapter of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#).

## 8.16 Security

This device offers several security features, including:

- Debug security
- Unique Die ID
- Flexible firewalls for protecting code and data
  - Flash write-erase protection
  - Flash read-execute protection
  - Flash IP protection
  - SRAM write-execute mutual exclusion
- Secure boot
- Secure firmware update
- Customer secure code
- Cyclic redundancy checker (CRC-16) with support for custom polynomial

For more details, see the Security chapter of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#)

## 8.17 CRC

The cyclical redundancy check (CRC) module provides a signature for an input data sequence. Key features of the CRC module include:

- Support for 16-bit CRC based on CRC16-CCITT
- Support for bit reversal

For more details, see the CRC chapter of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#).

## 8.18 UART

The UART peripherals provide the following key features:

- Standard asynchronous communication bits for start, stop, and parity
- Fully programmable serial interface
  - 5, 6, 7, or 8 data bits
  - Even, odd, stick, or no-parity bit generation and detection
  - 1 or 2 stop bit generation
  - Line-break detection
  - Glitch filter on the input signals
  - Programmable baud rate generation with oversampling by 16, 8, or 3
  - Local Interconnect Network (LIN) mode support
- Separated 4-entry transmit and receive FIFOs
- Support transmit and receive loopback mode operation
- See [Table 8-9](#) for detail information on supported protocols

**Table 8-9. UART Features**

| UART FEATURES                       | UART0 (ADV) | UART1 (MAIN) | UART2 (MAIN) |
|-------------------------------------|-------------|--------------|--------------|
| Active in stop and standby modes    | Yes         | Yes          | Yes          |
| Separate transmit and receive FIFOs | Yes         | Yes          | Yes          |
| Support hardware flow control       | Yes         | Yes          | Yes          |

**Table 8-9. UART Features (continued)**

| UART FEATURES               | UART0<br>(ADV) | UART1<br>(MAIN) | UART2<br>(MAIN) |
|-----------------------------|----------------|-----------------|-----------------|
| Support 9-bit configuration | Yes            | Yes             | Yes             |
| Support LIN mode            | Yes            | No              | No              |
| Support DALI                | Yes            | No              | No              |
| Support IrDA                | Yes            | No              | No              |
| Support ISO7816 Smart Card  | Yes            | No              | No              |
| Support Manchester coding   | Yes            | No              | No              |

For more details, see the UART chapter of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#).

## 8.19 SPI

The serial peripheral interface (SPI) peripherals in these devices support the following key features:

- Support ULPClk/2 bit rate and up to 16 Mbits/s in both controller and peripheral modes
- Configurable as a controller or a peripheral
- Configurable chip select for both controller and peripheral
- Programmable clock prescaler and bit rate
- Programmable data frame size from 4 bits to 16 bits (controller mode)
- Programmable data frame size from 7 bits to 16 bits (peripheral mode)
- Separated 4-entry transmit and receive FIFOs
- Supports TI mode, Motorola mode, and National Microwire format

For more details, see the SPI chapter of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#).

## 8.20 I2C

The inter-integrated circuit interface (I<sup>2</sup>C) peripherals in these devices provide bidirectional data transfer with other I2C devices on the bus and support the following key features:

- 7-bit and 10-bit addressing mode with multiple 7-bit target addresses
- Multiple-controller transmitter or receiver mode
- Target receiver or transmitter mode with configurable clock stretching
- Support Standard-mode (Sm), with a bit rate up to 100 kbit/s
- Support Fast-mode (Fm), with a bit rate up to 400 kbit/s
- Support Fast-mode Plus (Fm+), with a bit rate up to 1 Mbit/s
- Separated 8-entry transmit and receive FIFOs
- Support SMBus 3.0 with PEC, ARP, timeout detection, and host support
- Support analog and digital glitch filter for input signal glitch suppression

For more details, see the I2C chapter of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#).

## 8.21 Low-Frequency Sub System (LFSS)

The Low-Frequency Sub-System (LFSS) is a sub-system which combines several functional peripherals under one shared subsystem. These peripherals are clocked by the low frequency clock (LFCLK) or need to be active during low power modes. The LFCLK has a typical frequency of 32kHz and is mainly intended for long-term timekeeping.

LFSS in this device contains following components:

- *Real Time Clock* with additional prescaler extension and timestamp captures

- An asynchronous *IWDT*

For more details, see the LFSS chapter of the [MSPM0 C-Series Microcontrollers Technical Reference Manual](#).

## 8.22 RTC\_B

The RTC\_B instance of the real-time clock operates off of a 32kHz input clock source (typically a low frequency crystal) and provides a time base to the application with multiple options for interrupts to the CPU. The RTC\_B provides common key features in relation to the Low-Frequency Sub System (LFSS).

Common key features of the RTC\_B include:

- Counters for seconds, minutes, hours, day of the week, day of the month, month, and year
- Binary or BCD format
- Leap-year handling
- One customizable alarm interrupt based on minute, hour, day of the week, and day of the month
- Interval alarm interrupt to wake every minute, every hour, at midnight, or at noon
- Interval alarm interrupt providing periodic wake-up at 4096, 2048, 1024, 512, 256, or 128 Hz
- Interval alarm interrupt providing periodic wake-up at 64, 32, 16, 8, 4, 2, 1, and 0.5 Hz
- Calibration for crystal offset error (up to +/- 240ppm)
- Compensation for temperature drift (up to +/- 240ppm)
- RTC clock output to pin for calibration

[RTC\\_B Key Features #none#](#) shows the RTC features supported in this device.

**Table 8-10. RTC\_B Key Features**

| RTC Features                                                                                                                                                     | RTC_B |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|
| Power enable register                                                                                                                                            | -     |
| Real-time clock and calendar mode providing seconds, minutes, hours, day of week, day of month, and year                                                         | Yes   |
| Selectable binary or binary-coded decimal (BCD) format                                                                                                           | Yes   |
| Leap-year correction (valid for year 1901 through 2099)                                                                                                          | Yes   |
| Two customizable calendar alarm interrupts based on minute, hour, day of the week, and day of the month                                                          | Yes   |
| Interval alarm interrupt to wake every minute, every hour, at midnight, or at noon                                                                               | Yes   |
| Periodic interrupt to wake at 4096, 2048, 1024, 512, 256, or 128Hz                                                                                               | Yes   |
| Periodic interrupt to wake at 64, 32, 16, 8, 4, 2, 1, and 0.5Hz                                                                                                  | Yes   |
| Interrupt capability down to STANDBY mode with STOPCLKSTBY                                                                                                       | Yes   |
| Calibration for crystal offset error and crystal temperature drift (up to ±240 ppm total)                                                                        | Yes   |
| RTC clock output to pin for calibration (GPIO)                                                                                                                   | Yes   |
| RTC clock output to pin for calibration (TIO)                                                                                                                    | -     |
| Three -bit prescaler for heartbeat function with interrupt generation                                                                                            | -     |
| RTC external clock selection of untrimmed 32kHz, trimmed 512Hz, 256Hz or 1Hz                                                                                     | -     |
| RTC time stamp capture upon detection of a timer stamp event, including: <ul style="list-style-type: none"> <li>• TIO event</li> <li>• VDD fail event</li> </ul> | -     |
| RTC counter lock function                                                                                                                                        | -     |

For more details, see the RTC chapter of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#).

### 8.23 IWDTC\_B

The independent watchdog timer (IWDTC) in the LFSS is a device-independent supervisor which monitors code execution and overall hang up scenarios of the device. Due to the nature of LFSS, this IWDTC has its own system independent clock source. If the application software does not successfully reset the watchdog within the programmed time, the watchdog generates a POR reset to the device.

Key features of the IWDTC include:

- A 25-bit counter
- Counter driven from LFOSC (fixed 32kHz clock path) with a programmable clock divider
- Eight selectable watchdog timer periods (2ms to 2hr)

For more details, see the IWDTC chapter of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#).

### 8.24 WWDT

The windowed watchdog timer (WWDT) can be used to supervise the operation of the device, specifically code execution. The WWDT can be used to generate a reset or an interrupt if the application software does not successfully reset the watchdog within a specified window of time. Key features of the WWDT include:

- 25-bit counter
- Programmable clock divider
- Eight software selectable watchdog timer periods
- Eight software selectable window sizes
- Support for stopping the WWDT automatically when entering a sleep mode
- Interval timer mode for applications which do not require watchdog functionality

For more details, see the WWDT chapter of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#)

### 8.25 Timers (TIMx)

The timer peripherals in these devices support the following key features. For specific configuration, see [Table 8-11](#).

Specific features for the **general-purpose timer (TIMGx)** include:

- 16-bit down, up/down, or up counter with repeat-reload mode
- Selectable and configurable clock source
- 8-bit programmable prescaler to divide the counter clock frequency
- Up to four independent CC channels for
  - Output compare
  - Input capture
  - PWM output
  - One-shot mode
- Support quadrature encoder interface (QEI) for positioning and movement sensing
- Support synchronization and cross trigger among different TIMx instances in the same power domain
- Support interrupt trigger generation and cross peripherals (such as ADC) trigger capability
- Cross-trigger event logic for Hall sensor inputs

Specific features for the **advanced timer (TIMAx)** include:

- 16-bit down or up-down counter, with repeat-reload mode
- Selectable and configurable clock source
- 8-bit programmable prescaler to divide the counter clock frequency
- Clock doubler to provide 2x clock source for improved timer resolution

- Repeat counter to generate an interrupt or event only after a given number of cycles of the counter
- Up to four independent CC channels for
  - Output compare
  - Input capture
  - PWM output
  - One-shot mode
- Shadow register for load and CC register available
- Complementary output PWM
- Asymmetric PWM with programmable dead band insertion
- Fault handling mechanism to keep the output signals in a safe user-defined state when a fault condition is encountered
- Support synchronization and cross trigger among different TIMx instances in the same power domain
- Support interrupt trigger generation and cross peripherals (such as ADC) trigger capability
- Two additional capture/compare channels for internal events

**Table 8-11. TIMx Configurations**

| TIMER NAME | POWER DOMAIN | RESOLUTION | PRESCALER | REPEAT COUNTER | CAPTURE / COMPARE CHANNELS | PHASE LOAD | SHADOW LOAD | SHADOW CC | DEAD-BAND | FAULT | QEI |
|------------|--------------|------------|-----------|----------------|----------------------------|------------|-------------|-----------|-----------|-------|-----|
| TIMG14     | PD0          | 16 bit     | 8 bit     | –              | 4                          | –          | –           | –         | –         | –     | –   |
| TIMG1      | PD0          | 16 bit     | 8 bit     | –              | 2                          | –          | –           | –         | –         | –     | –   |
| TIMG2      | PD0          | 16 bit     | 8 bit     | –              | 2                          | –          | –           | –         | –         | –     | –   |
| TIMG8      | PD0          | 16 bit     | 8 bit     | –              | 2                          | –          | –           | –         | –         | –     | Yes |
| TIMA0      | PD0          | 16 bit     | 8 bit     | 8-bit          | 4                          | Yes        | Yes         | Yes       | Yes       | Yes   | –   |

For more details, see the timer chapters of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#).

## 8.26 Device Analog Connections

Figure 8-2 shows the internal analog connection of the device.

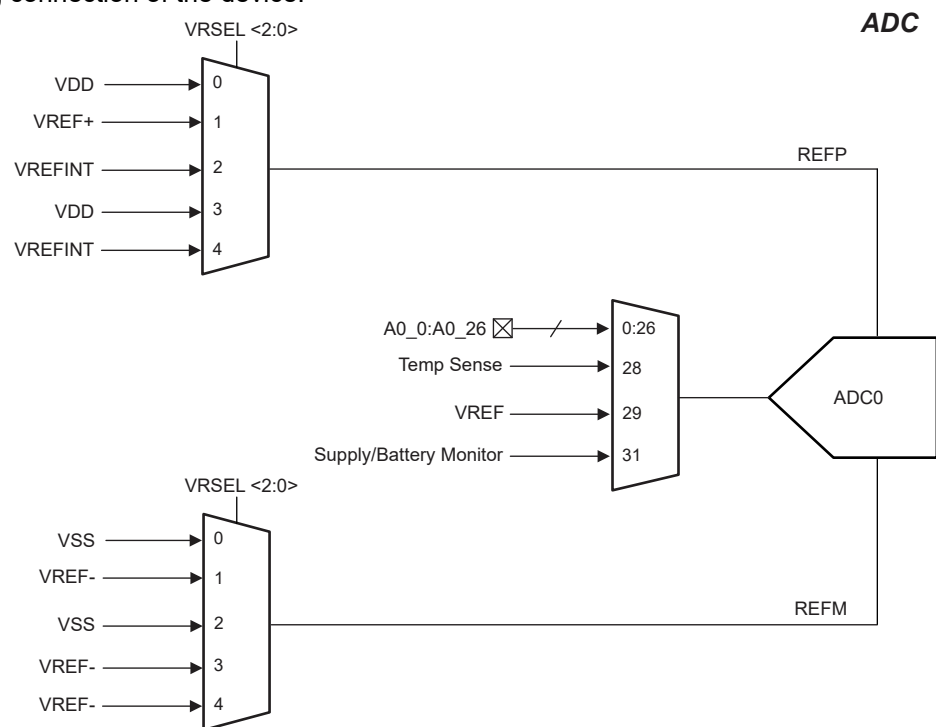


**Figure 8-2. Analog Connections**

## 8.27 Input/Output Diagrams

The IOMUX manages the selection of which peripheral function is to be used on a digital IO and provides the controls for the output driver and input path. For more information, see the IOMUX section of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#).

The mixed-signal IO pin slice diagram for a full featured IO pin is shown in [Figure 8-3](#). Not all pins have analog functions, drive strength control, and pullup resistors available. See [Section 6.2](#) for detailed information on the features that are supported for a specific pin.

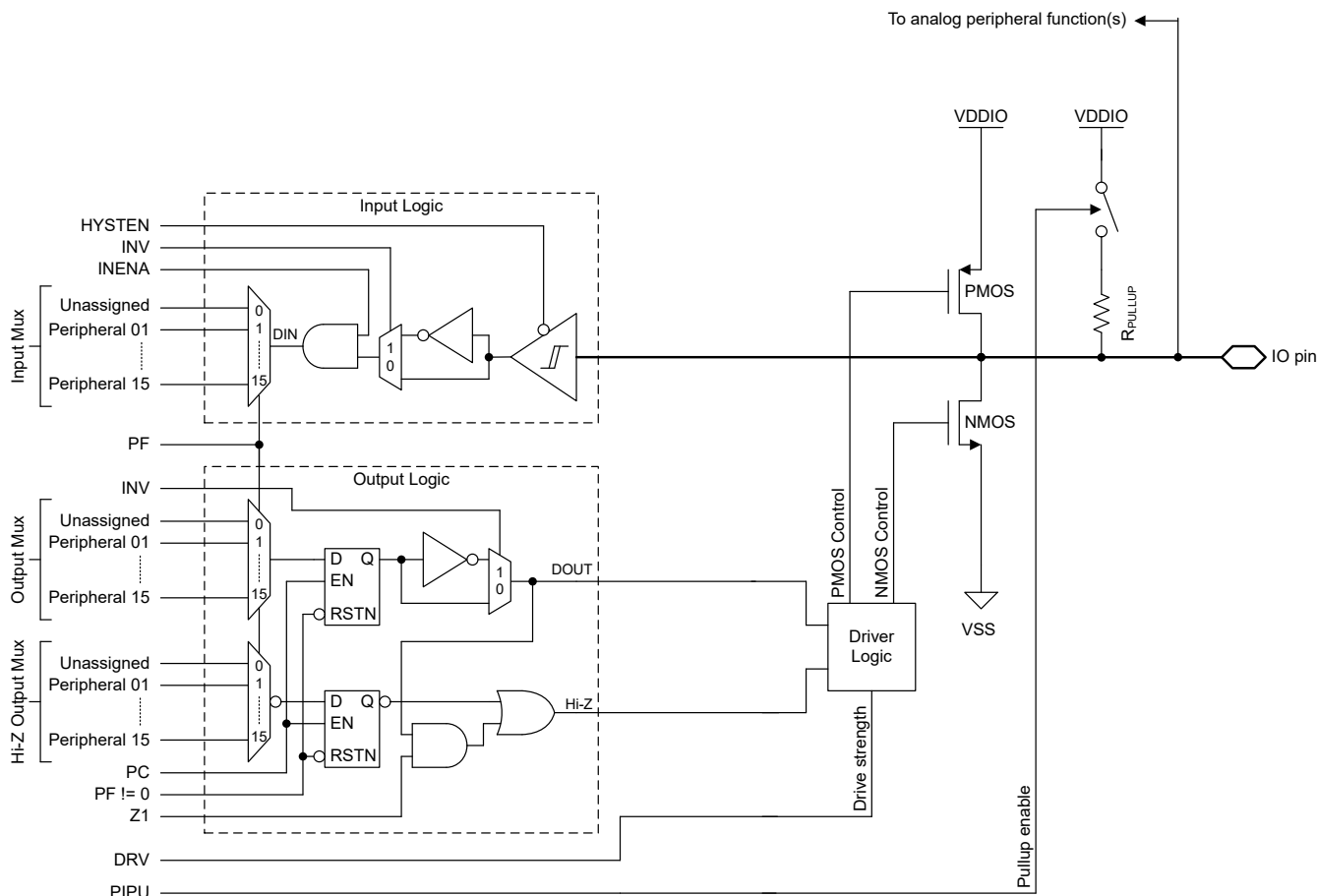


**Figure 8-3. Superset Input/Output Diagram**

## 8.28 Serial Wire Debug Interface

A serial wire debug (SWD) two-wire interface is provided via an Arm compatible serial wire debug port (SW-DP) to enable access to multiple debug functions within the device. For a complete description of the debug functionality offered on MSPM0 devices, see the debug chapter of the technical reference manual.

**Table 8-12. Serial Wire Debug Pin Requirements and Functions**

| DEVICE SIGNAL | DIRECTION    | SWD FUNCTION                             |
|---------------|--------------|------------------------------------------|
| SWCLK         | Input        | Serial wire clock from debug probe       |
| SWDIO         | Input/Output | Bi-directional (shared) serial wire data |

## 8.29 DEBUGSS

The debug subsystem (DEBUGSS) interfaces the ARM Serial Wire Debug (SWD) two-wire physical interface to multiple debug functions within the device. MSPM0 devices support debugging of processor execution and the device state. The DEBUGSS also provides a mailbox system for communicating with software through SWD.

Key features provided by the debug subsystem include:

- The ARM Serial Wire Debug (SWD) two-wire (SWDIO, SWCLK) debug interface, compatible with both TI and 3<sup>rd</sup> party debug probes
  - On-chip pullup and pulldown resistors for SWDIO and SWCLK, respectively, enabled by default
  - Support for disabling SWD functions to use SWD pins as general-purpose input/output pins
  - Support for debug on all low power modes
- Debug of the processor
  - Run, halt, and step debug support
  - 2 hardware breakpoints (BPU)
  - 1 hardware watchpoints (DWT)
  - Supporting software breakpoints
- Software-configurable peripheral behavior during processor debug
  - Ability to free run select peripherals through debug halt
  - Ability to halt select peripherals on a debug halt
  - Ability to request reset and mode changes to the PMCU
- Mailbox (DSSM) for passing data and control signals between the SWD interface and boot ROM (as well as application software)
- Support for various security features, including SWD lockout and password authenticated debugging

For more details, see the DEBUGSS chapter of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#).

## 8.30 Device Factory Constants

All devices include a memory-mapped FACTORY region which provides read-only data describing the capabilities of a device as well as any factory-provided trim information for use by application software. See the *Factory Constants* section of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#).

**Table 8-13. DEVICEID**

DEVICEID address is 0x41C4.0004, PARTNUM is bit 12 to 27, MANUFACTURER is bit 1 to 11.

| Device     | DEVICEID.PARTNUM | DEVICEID.MANUFACTURER |
|------------|------------------|-----------------------|
| MSPM0H3215 | 0x0BBA           | 0x17                  |
| MSPM0H3216 | 0x0BBA           | 0x17                  |

**Table 8-14. USERID**

USERID address is 0x41C4.0008, PART is bit 0 to 15, VARIANT is bit 16 to 23

| Device           | PART | VARIANT | Device           | PART | VARIANT |
|------------------|------|---------|------------------|------|---------|
| M0H3216QPTRQ1    | 4840 | 24      | M0H3215QPTRQ1    | AA69 | 2C      |
| M0H3216QRGZRQ1   | 4840 | 25      | M0H3215QRGZRQ1   | AA69 | 2D      |
| M0H3216QDGS20RQ1 | 4840 | 28      | M0H3215QDGS20RQ1 | AA69 | 30      |
| M0H3216QRHBRQ1   | 4840 | 29      | M0H3215QRHBRQ1   | AA69 | 31      |
| M0H3216QRGERQ1   | 4840 | 2A      | M0H3215QRGERQ1   | AA69 | 32      |
| M0H3216QRUKRQ1   | 4840 | 2B      | M0H3215QRUKRQ1   | AA69 | 33      |

## 8.31 Identification

### Revision and Device Identification

The hardware revision and device identification values are stored in the memory-mapped FACTORY region (see the Device Factory Constants section) which provides read-only data describing the capabilities of a device as well as any factory-provided trim information for use by application software. For more information, see the *Factory Constants* chapter of the [MSPM0 H-Series 32MHz Microcontrollers Technical Reference Manual](#).

The device revision and identification information are also included as part of the top-side marking on the device package. The device-specific errata describes these markings.

## 9 Applications, Implementation, and Layout

### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 9.1 Typical Application

#### 9.1.1 Schematic

TI recommends connecting a combination of a 10- $\mu$ F and a 0.1- $\mu$ F low-ESR ceramic decoupling capacitor to the VDD and VSS pins. Higher-value capacitors can be used but can affect the supply rail ramp-up time. Decoupling capacitors must be placed as close as possible to the pins (within a few millimeters).

The NRST reset pin must connect an external 47-k $\Omega$  pullup resistor with a 10-nF pulldown capacitor.

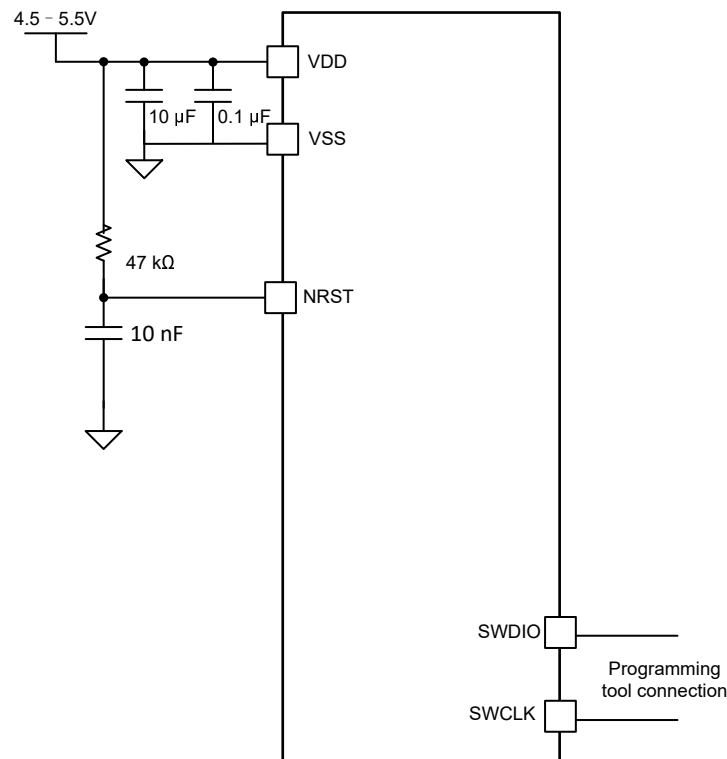


**Figure 9-1. Typical Application Schematic**

## 10 Device and Documentation Support

TI offers an extensive line of development tools. Tools and software to evaluate the performance of the device, generate code, and develop solutions are listed below.

### 10.1 Device Nomenclature

To designate the stages in the product development cycle, TI assigns prefixes to the part numbers of all MSP MCU devices and support tools. Each MSP MCU commercial family member has one of two prefixes: MSP or X. These prefixes represent evolutionary stages of product development from engineering prototypes (X) through fully qualified production devices (MSP).

**X** – Experimental device that is not necessarily representative of the final device's electrical specifications

**MSP** – Fully qualified production device

**X** devices are shipped against the following disclaimer:

"Developmental product is intended for internal evaluation purposes." MSP devices have been characterized fully, and the quality and reliability of the device have been demonstrated fully. TI's standard warranty applies. Predictions show that prototype devices (X) have a greater failure rate than the standard production devices. TI recommends that these devices not be used in any production system because their expected end-use failure rate still is undefined. Only qualified production devices are to be used.

TI device nomenclature also includes a suffix with the device family name. This suffix indicates the temperature range, package type, and distribution format. [Figure 10-1](#) provides a legend for reading the complete device name.

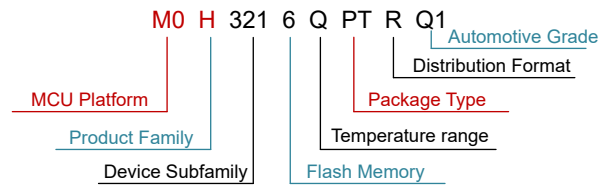


**Figure 10-1. Device Nomenclature**

**Table 10-1. Device Nomenclature**

|                            |                                                                                                  |
|----------------------------|--------------------------------------------------------------------------------------------------|
| <b>Processor Family</b>    | MSP = Mixed-signal processor<br>X= Experimental silicon                                          |
| <b>MCU Platform</b>        | M0 = Arm-based 32-bit M0+                                                                        |
| <b>Product Family</b>      | H = 5V                                                                                           |
| <b>Device Subfamily</b>    | 321 = 32MHz frequency, ADC, RTC                                                                  |
| <b>Flash Memory</b>        | 5 = 32KB<br>6 = 64KB                                                                             |
| <b>Temperature Range</b>   | Q = –40°C to 125°C                                                                               |
| <b>Package Type</b>        | See <a href="#">Table 5-1</a> and <a href="http://www.ti.com/packaging">www.ti.com/packaging</a> |
| <b>Distribution Format</b> | T = Small reel<br>R = Large reel<br>No marking = Tube or tray                                    |

For orderable part numbers of MSP devices in different package types, see the Package Option Addendum of this document, [ti.com](http://ti.com), or contact your TI sales representative.

## 10.2 Tools and Software

### Design Kits and Evaluation Modules

#### MSPM0 LaunchPad (LP) Boards: LP-MSPM0H3216

Empowers you to immediately start developing on the industry's best integrated analog and most cost-optimized general purpose MSPM0 MCU family. Exposes all device pins and functionality; includes some built-in circuitry, out-of-box software demos, and on-board XDS110 debug probe for programming, debugging, and EnergyTrace™ technology.

The LP ecosystem includes dozens of [BoosterPack™](#) stackable plug-in modules to extend functionality.

### Embedded Software

#### MSPM0 Software Development Kit (SDK)

Contains software drivers, middleware libraries, documentation, tools, and code examples that create a familiar and easy user experience for all MSPM0 devices.

### Software Development Tools

#### TI Cloud Tools

Start your evaluation and development on a web browser without any installation. Cloud tools also have a downloadable, offline version.

#### TI Resource Explorer SysConfig

Online portal to TI SDKs. Accessible in CCS IDE or in TI Cloud Tools.

Intuitive GUI to configure device and peripherals, resolve system conflicts, generate configuration code, and automate pin mux settings. Accessible in CCS IDE or in TI Cloud Tools. ([offline version](#))

#### MSP Academy

Great starting point for all developers to learn about the MSPM0 MCU Platform with training modules that span a wide range of topics. Part of TIRex.

#### GUI Composer

GUIs that simplify evaluation of certain MSPM0 features, such as configuring and monitoring a fully integrated analog signal chain without any code needed.

### IDE & compiler tool chains

#### Code Composer Studio™ (CCS)

Includes [TI Arm-Clang](#) compiler. Supports all TI Arm Cortex MCUs and boasts competitive code size performance advantages, fast compile time, code coverage support, safety certification support, and completely free to use.

#### IAR Embedded Workbench® IDE

#### Keil® MDK IDE

#### GNU Arm Embedded Tool Chain

## 10.3 Documentation Support

To receive notification of documentation updates, navigate to the device product folder on [ti.com](https://www.ti.com). Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

The following documents describe the MSPM0 MCUs. Copies of these documents are available on the Internet at [www.ti.com](https://www.ti.com).

### Technical Reference Manual

#### MSPM0 H-Series 32- MHz Microcontrollers Technical Reference Manual

This manual describes the modules and peripherals of the MSPM0H family of devices. Each description presents the module or peripheral in a general sense. Not all features and functions of all modules or peripherals are present on all devices. In addition, modules or peripherals can differ in their exact implementation on different

devices. Pin functions, internal signal connections, and operational parameters differ from device to device. See the device-specific data sheet for these details.

## Errata

### MSPM0H321x Mixed-Signal Microcontrollers Errata

This document describes the known exceptions to the functional specifications (advisories).

## 10.4 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

## 10.5 Trademarks

LaunchPad™, Code Composer Studio™, TI E2E™, EnergyTrace™, and BoosterPack™ are trademarks of Texas Instruments.

Arm® and Cortex® are registered trademarks of Arm Limited.

All trademarks are the property of their respective owners.

## 10.6 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## 10.7 Glossary

### TI Glossary

This glossary lists and explains terms, acronyms, and definitions.

## 11 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

### Changes from July 30, 2025 to July 31, 2026 (from Revision \* (July 2025) to Revision A (July 2026))

Page

|                                                                                                              |    |
|--------------------------------------------------------------------------------------------------------------|----|
| • Updated features.....                                                                                      | 1  |
| • Removed VSSOP32 package from datasheet.....                                                                | 1  |
| • Updated description with updated values.....                                                               | 2  |
| • Updated functional block diagram.....                                                                      | 3  |
| • Removed NNA/VFC package from datasheet device comparison and package information, mechanical drawings..... | 5  |
| • Removed LFXT function on PA26/PA27 and foot notes (1) and (2).....                                         | 9  |
| • Split signal descriptions table to include VREF and PMU.....                                               | 9  |
| • Added pin attributes overview.....                                                                         | 9  |
| • Updated digital IO features by IO type.....                                                                | 9  |
| • Added test conditions for temperature sensor trim temperature and temperature coefficient.....             | 31 |
| • Updated the IO port output frequency test conditions .....                                                 | 31 |
| • Updated LFXT current consumption from 300nA to 200nA typical.....                                          | 31 |
| • Corrected Power Supply Ramp figure BOR assertion.....                                                      | 31 |
| • Added SYSOSC footnote indicating sysosc accuracy test conditions.....                                      | 31 |

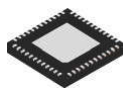
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|                                                                                                                                                          |    |
|----------------------------------------------------------------------------------------------------------------------------------------------------------|----|
| • Updated Flash Endurance Parameters from "UPPER" and "LOWER" to "HI_ENDURANCE" and "NORMAL_ENDURANCE" respectively and added a clarifying footnote..... | 31 |
| • Updated specifications.....                                                                                                                            | 31 |
| • Updated chapter sections.....                                                                                                                          | 46 |
| • Added table note 2 regarding proper NONMAIN configuration policy.....                                                                                  | 50 |
| • Clarified the FIFO entries description.....                                                                                                            | 56 |
| • Clarified the FIFO entries description.....                                                                                                            | 57 |
| • Clarified the FIFO entries description.....                                                                                                            | 57 |
| • Added the DEGUGSS section.....                                                                                                                         | 63 |
| • Updated mechanical section.....                                                                                                                        | 70 |

---

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

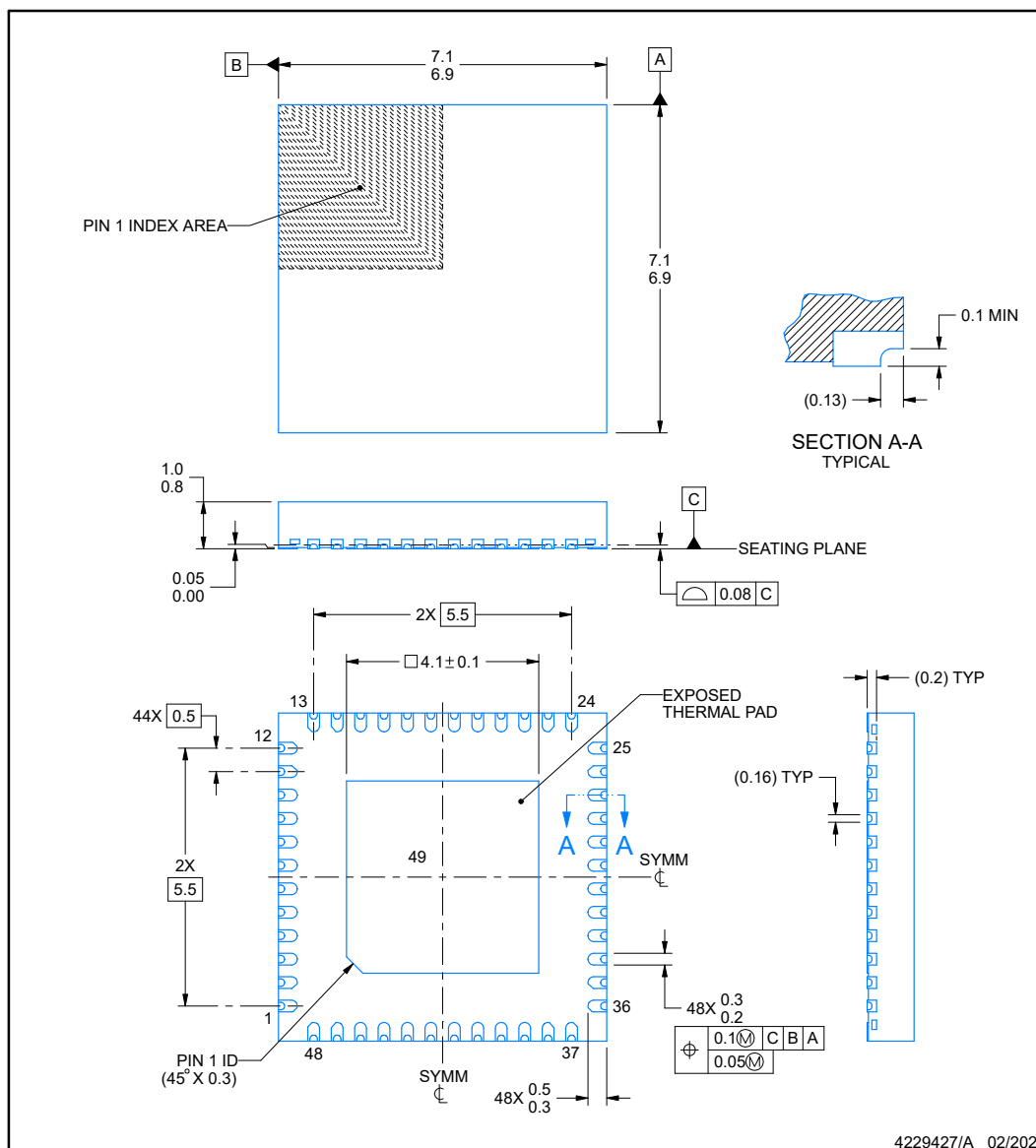


**RGZ0048F**

## PACKAGE OUTLINE

**VQFN - 1 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



### NOTES:

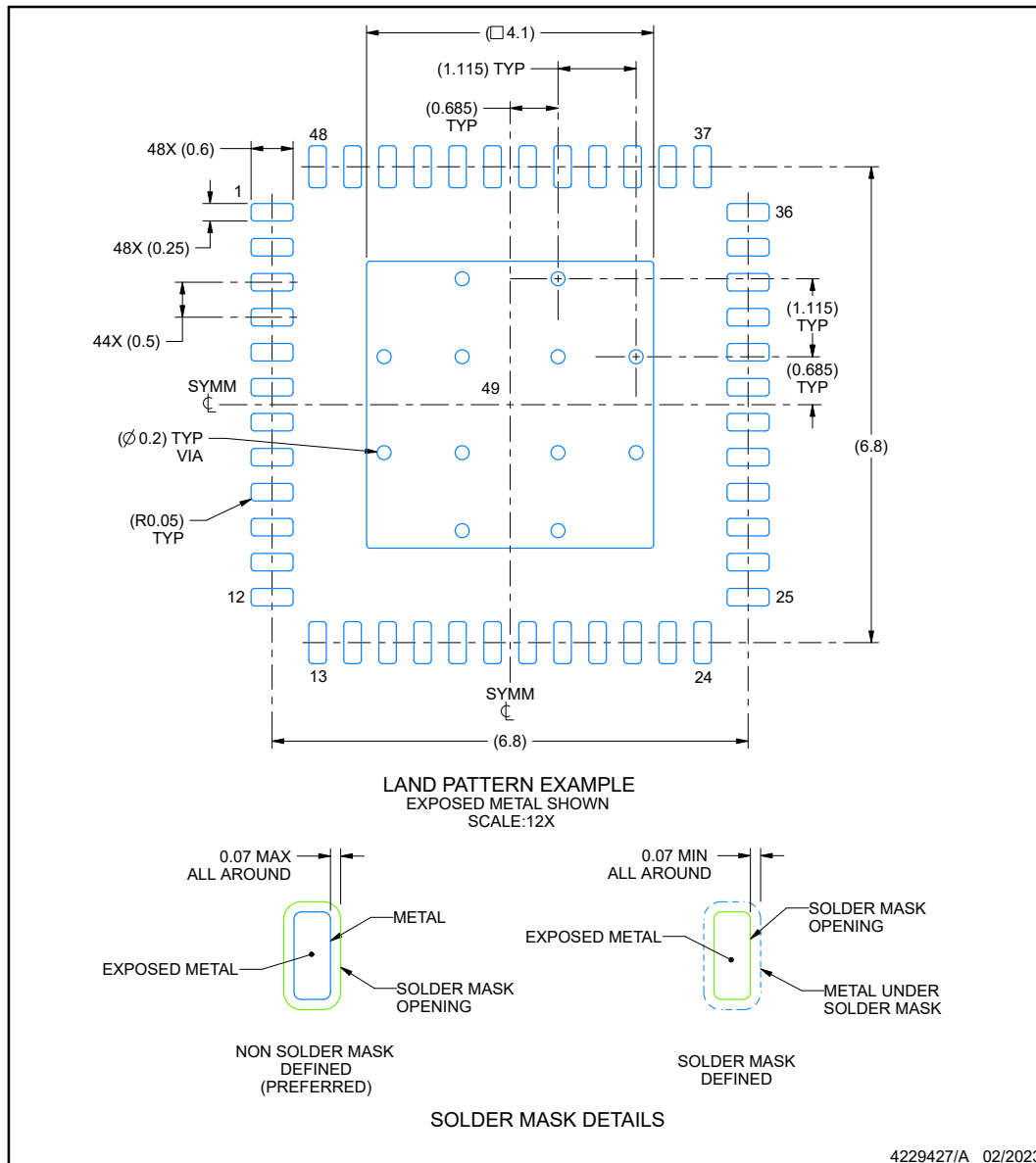
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

## EXAMPLE BOARD LAYOUT

**RGZ0048F**

**VQFN - 1 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

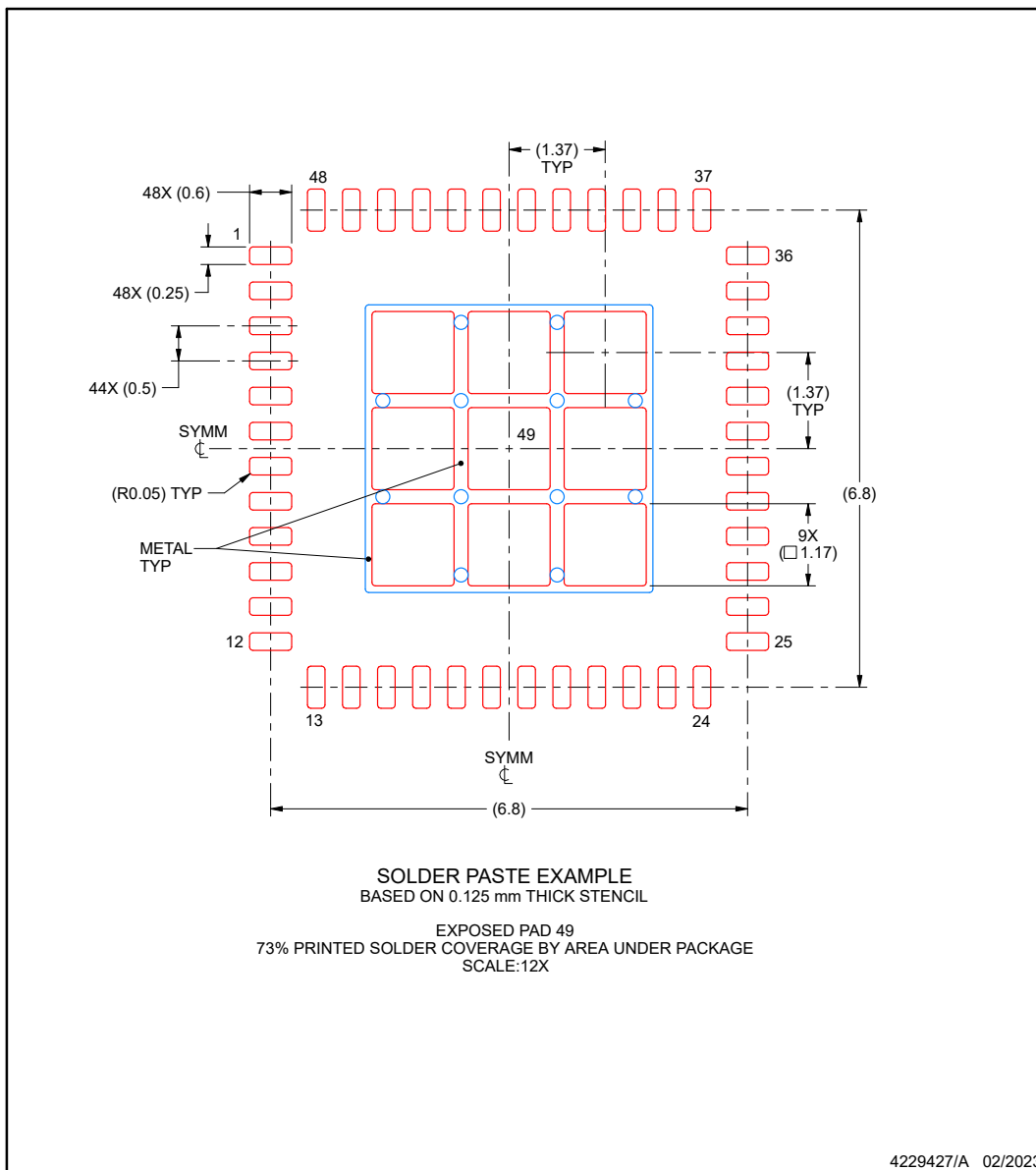
- This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).
- Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

## EXAMPLE STENCIL DESIGN

**RGZ0048F**

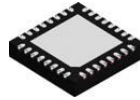
**VQFN - 1 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

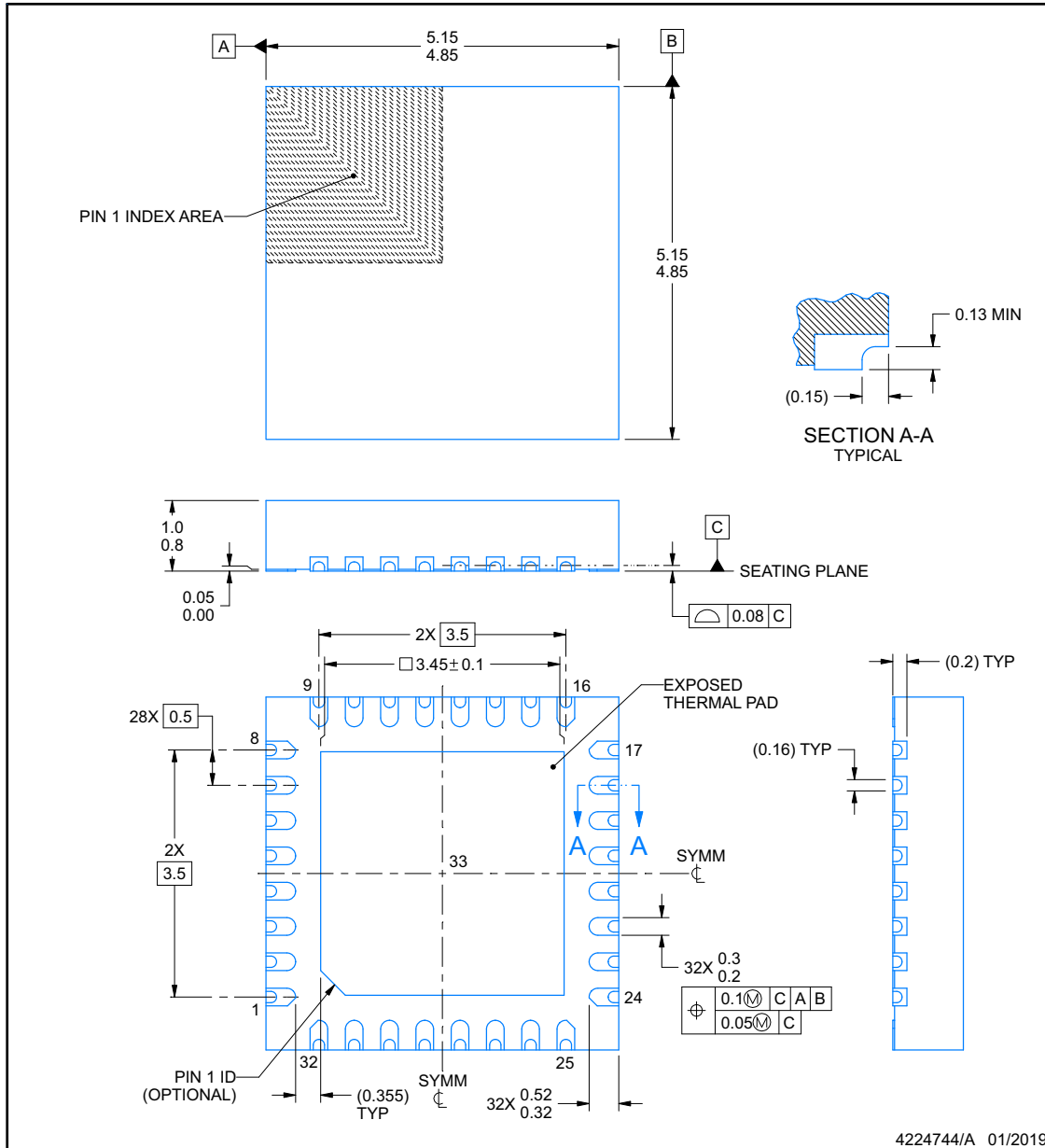


## RHB0032T

## PACKAGE OUTLINE

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



### NOTES:

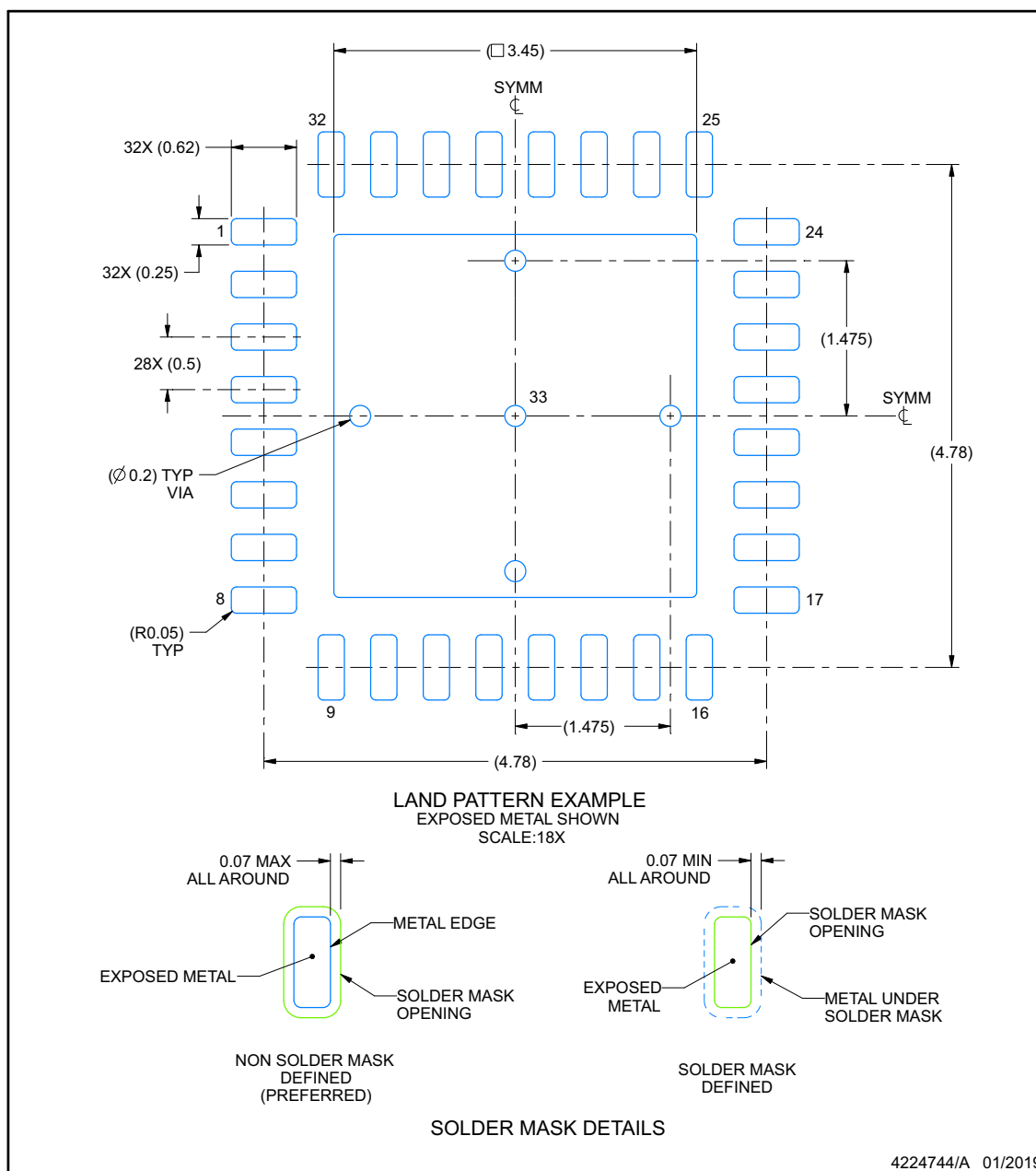
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

## EXAMPLE BOARD LAYOUT

**RHB0032T**

## VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

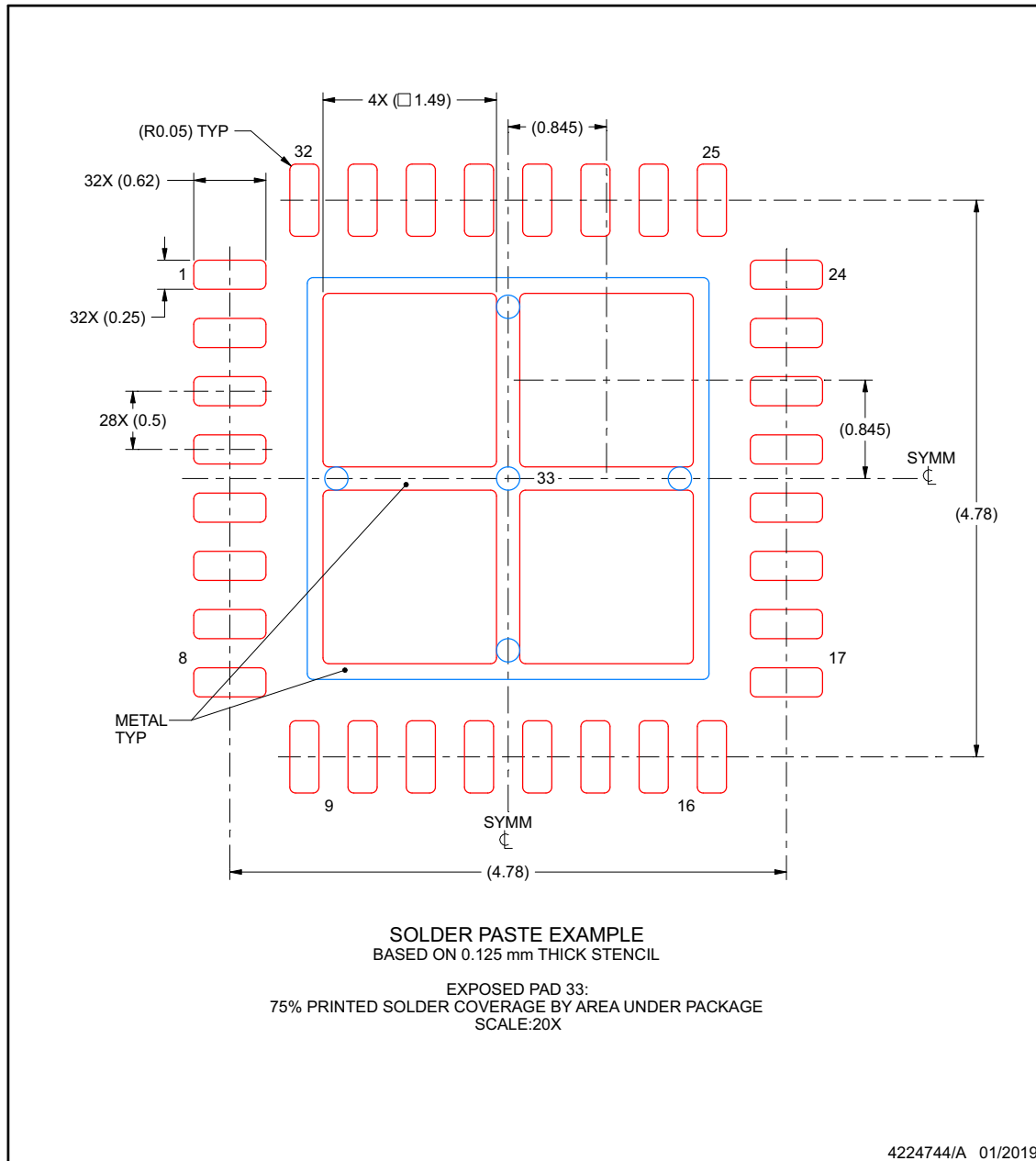
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sl原因271](http://www.ti.com/lit/sl原因271)).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

## EXAMPLE STENCIL DESIGN

**RHB0032T**

**VQFN - 1 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

**VQFN - 1 mm max height**

Technical drawing of a square connector. The main view shows a square with a central square hole. Dimensions include a width of 4.1 (3.9) and a height of 4.1 (3.9). A shaded area is labeled "PIN 1 INDEX AREA". A section view "SECTION A-A TYPICAL" shows a cross-section with a width of (0.13) and a height of 0.1 MIN. A side view shows a row of pins with a width of 2X 2.5 and a height of 1 MAX. A bottom view shows a square with a central square hole, with dimensions 2X 2.5, 2.45±0.1, 7, 12, 6, 13, 25, 19, 24, 18, 24X 0.3 0.2, 20X 0.5, 1, 24X 0.5 0.3, and 1 MAX. A section view "SECTION A-A TYPICAL" shows a cross-section with a width of (0.16) and a height of (0.2) TYP. A table of dimensions is provided at the bottom right.

|          |   |   |   |
|----------|---|---|---|
| 0.1 (M)  | C | A | B |
| 0.05 (M) | C |   |   |

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for optimal thermal and mechanical performance.

**RGE0024N**

LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 18X

SOLDER MASK DETAILS

NON SOLDER MASK DEFINED (PREFERRED)

SOLDER MASK DEFINED

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slua271](http://www.ti.com/lit/slua271)).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

**VQFN - 1 mm max height**

**SOLDER PASTE EXAMPLE**  
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD  
78% PRINTED COVERAGE BY AREA  
SCALE: 18X

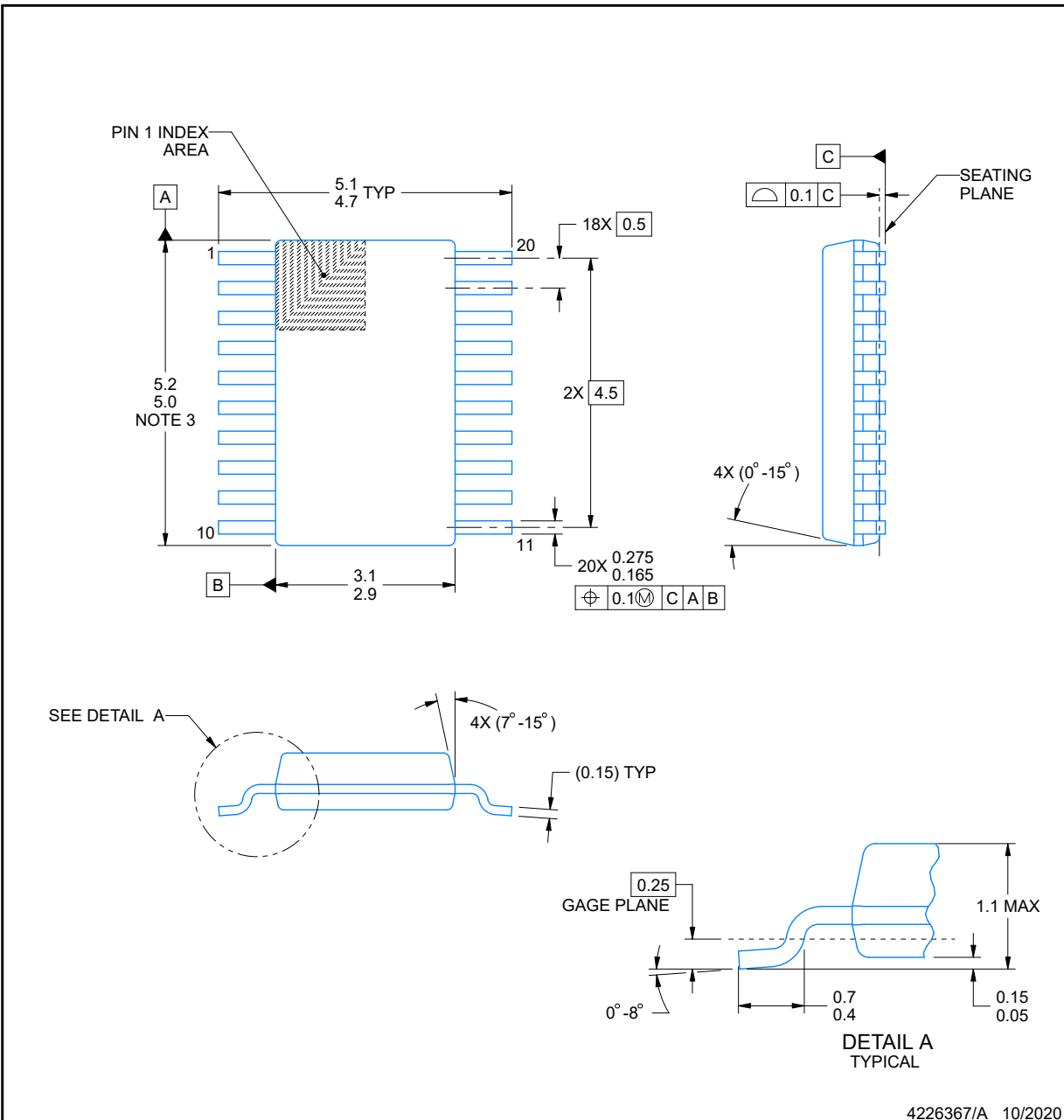
6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



## DGS0020A

## PACKAGE OUTLINE VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



4226367/A 10/2020

### NOTES:

PowerPAD is a trademark of Texas Instruments.

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. No JEDEC registration as of September 2020.
5. Features may differ or may not be present.

## VSSOP - 1.1 mm max height

The diagram illustrates a land pattern example and solder mask details. The top portion shows a symmetrical layout with dimensions and labels. The bottom portion provides detailed views of the solder mask opening and exposed metal.

**LAND PATTERN EXAMPLE**  
SCALE: 16X

**SOLDER MASK DETAILS**

The diagram shows two cross-sectional views of a solder mask opening. The left view is labeled "NON-SOLDER MASK DEFINED (PREFERRED)" and shows a "SOLDER MASK OPENING" with a "METAL" layer underneath. The "EXPOSED METAL" is defined by a "0.05 MAX ALL AROUND" dimension. The right view is labeled "SOLDER MASK DEFINED" and shows a "SOLDER MASK OPENING" with a "METAL UNDER SOLDER MASK" layer underneath. The "EXPOSED METAL" is defined by a "0.05 MIN ALL AROUND" dimension.

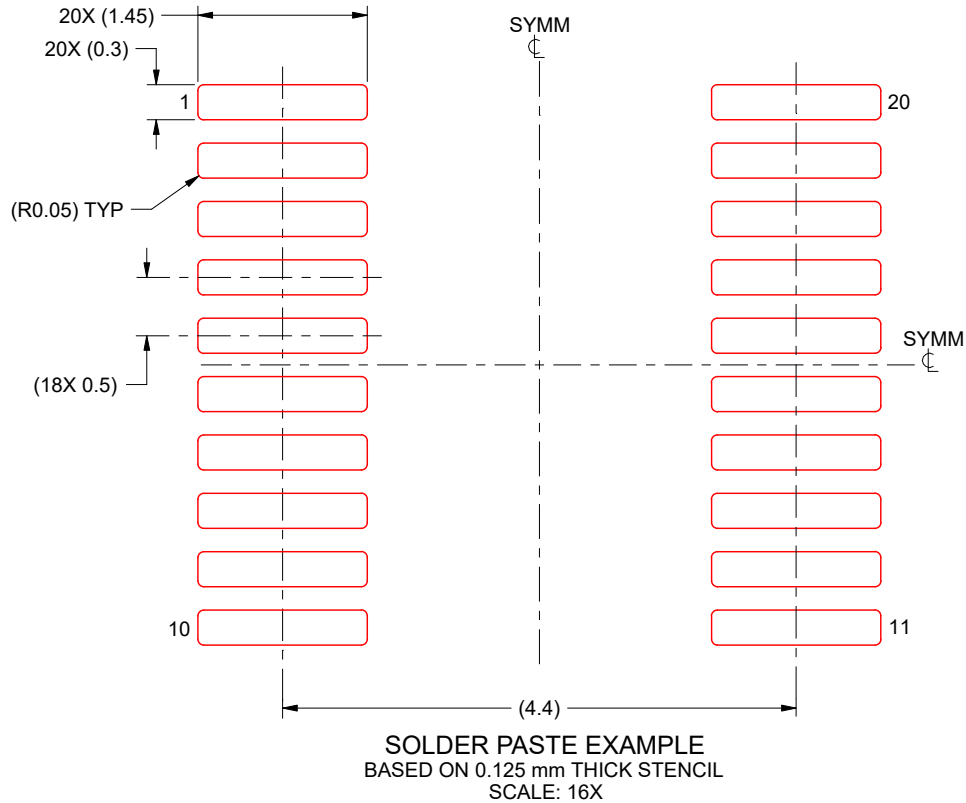
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
8. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature numbers SLMA002 ([www.ti.com/lit/slma002](http://www.ti.com/lit/slma002)) and SLMA004 ([www.ti.com/lit/slma004](http://www.ti.com/lit/slma004)).
9. Size of metal pad may vary due to creepage requirement.
10. Vias are optional depending on application, refer to device data sheet. It is recommended that vias under paste be filled, plugged or tented.

## EXAMPLE STENCIL DESIGN

**DGS0020A**

**VSSOP - 1.1 mm max height**

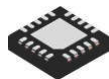
SMALL OUTLINE PACKAGE



4226367/A 10/2020

NOTES: (continued)

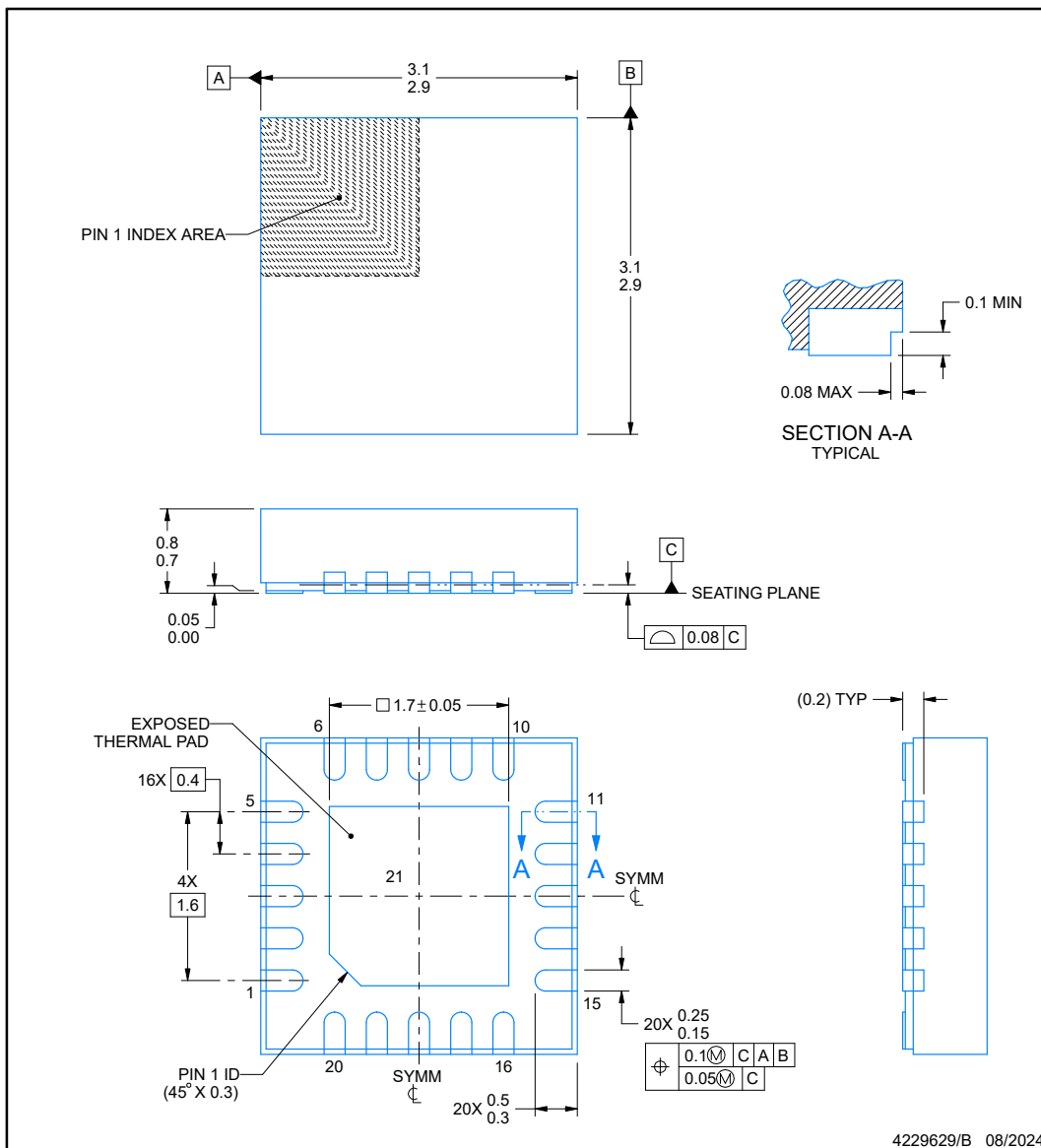
11. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
12. Board assembly site may have different recommendations for stencil design.



**RUK0020C**

**PACKAGE OUTLINE**  
**WQFN - 0.8 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



**NOTES:**

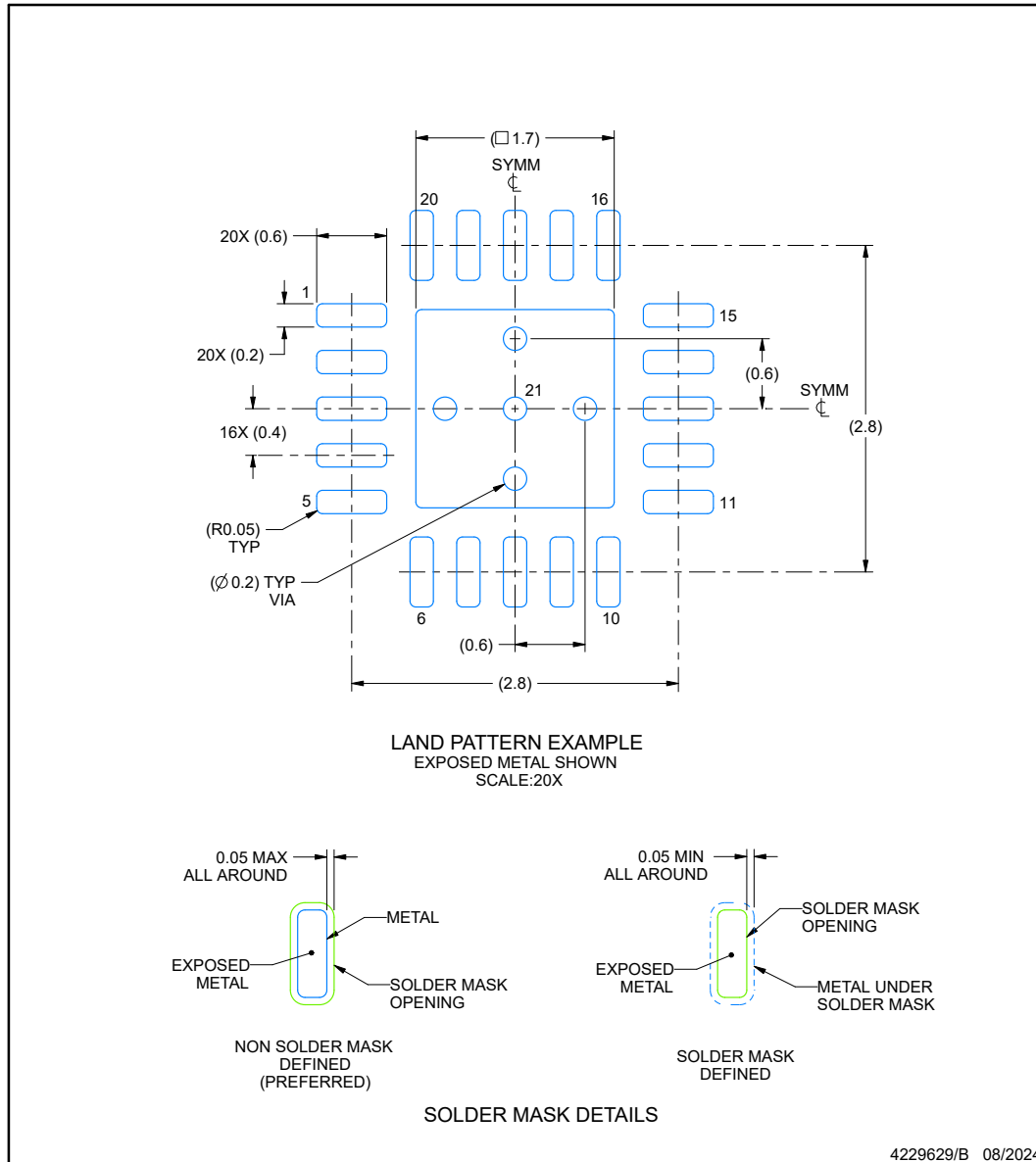
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

## EXAMPLE BOARD LAYOUT

**RUK0020C**

**WQFN - 0.8 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



## PACKAGING INFORMATION

| Orderable part number          | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|--------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">M0H3215QPTRQ1</a>  | Active        | Production           | LQFP (PT)   48  | 1000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | M0H3215Q            |
| <a href="#">M0H3215QRGERQ1</a> | Active        | Production           | VQFN (RGE)   24 | 5000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | MSPM0<br>H3215Q     |
| <a href="#">M0H3215QRGZRQ1</a> | Active        | Production           | VQFN (RGZ)   48 | 4000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | MSPM0<br>H3215Q     |
| <a href="#">M0H3215QRHBRQ1</a> | Active        | Production           | VQFN (RHB)   32 | 5000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | MSPM0<br>H3215Q     |
| <a href="#">M0H3215QRUKRQ1</a> | Active        | Production           | WQFN (RUK)   20 | 5000   LARGE T&R      | Yes         | Call TI                              | Level-1-260C-UNLIM                | -40 to 125   | H3215Q              |
| <a href="#">M0H3216QPTRQ1</a>  | Active        | Production           | LQFP (PT)   48  | 1000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | M0H3216Q            |
| <a href="#">M0H3216QRGERQ1</a> | Active        | Production           | VQFN (RGE)   24 | 5000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | MSPM0<br>H3216Q     |
| <a href="#">M0H3216QRGZRQ1</a> | Active        | Production           | VQFN (RGZ)   48 | 4000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | MSPM0<br>H3216Q     |
| <a href="#">M0H3216QRHBRQ1</a> | Active        | Production           | VQFN (RHB)   32 | 5000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | MSPM0<br>H3216Q     |
| <a href="#">M0H3216QRUKRQ1</a> | Active        | Production           | WQFN (RUK)   20 | 5000   LARGE T&R      | Yes         | Call TI                              | Level-1-260C-UNLIM                | -40 to 125   | H3216Q              |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

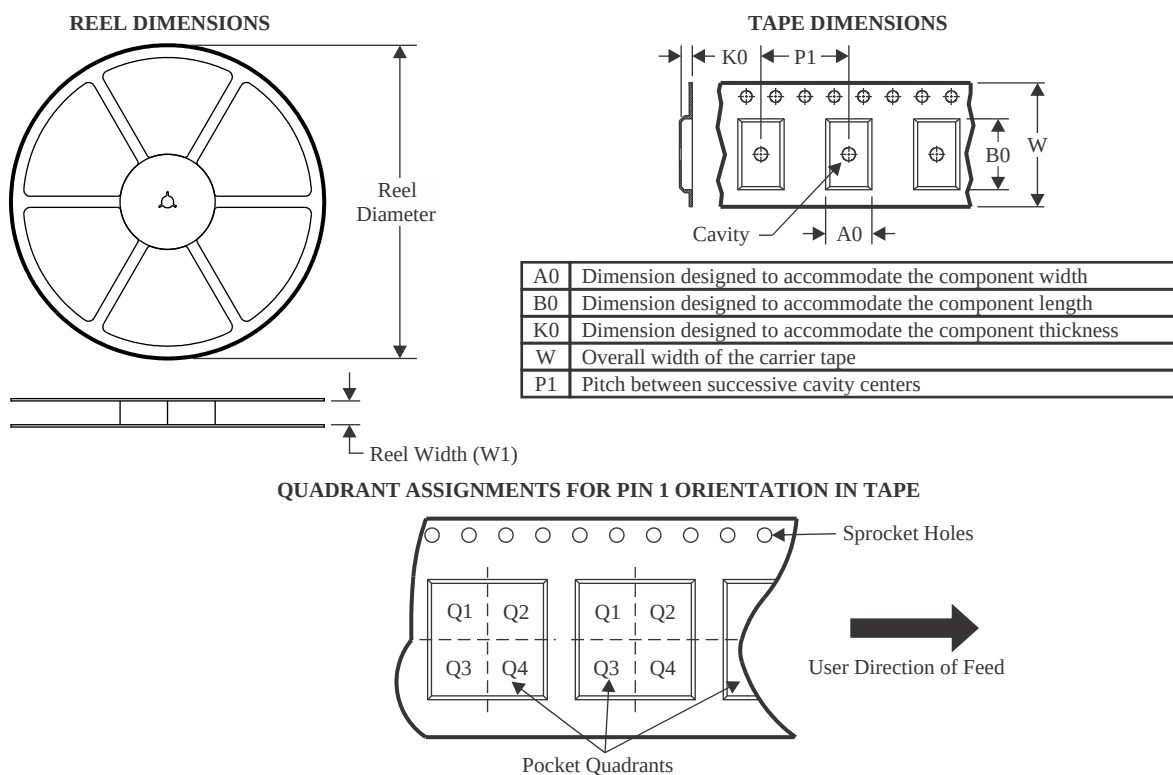
**OTHER QUALIFIED VERSIONS OF MSPM0H3215-Q1, MSPM0H3216-Q1 :**

- Catalog : [MSPM0H3215](#), [MSPM0H3216](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

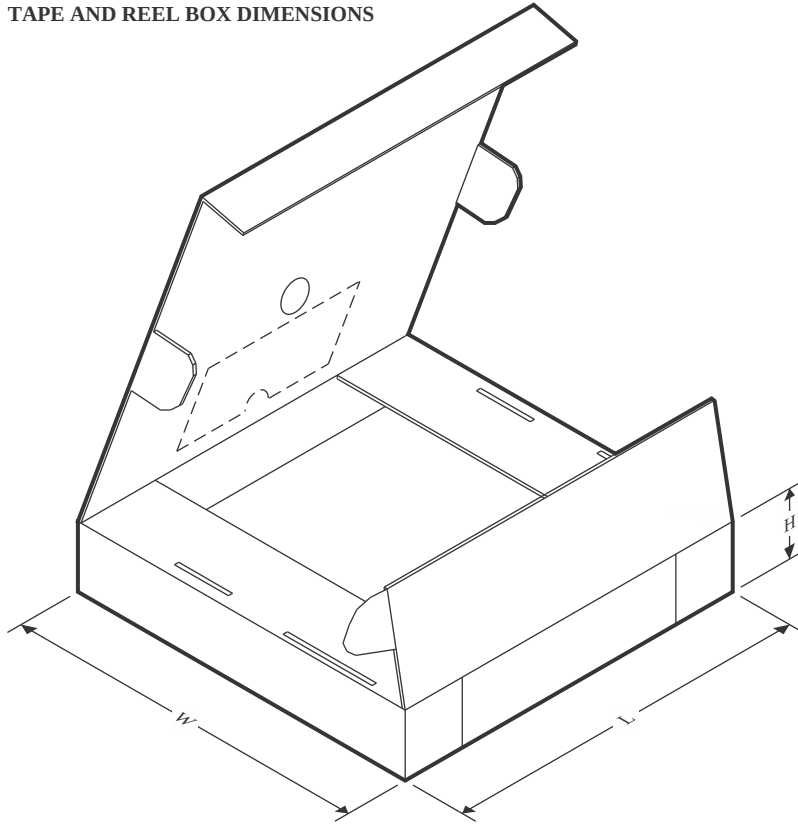
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| M0H3215QPTRQ1  | LQFP         | PT              | 48   | 1000 | 330.0              | 16.4               | 9.6     | 9.6     | 1.9     | 12.0    | 16.0   | Q2            |
| M0H3215QRGERQ1 | VQFN         | RGE             | 24   | 5000 | 330.0              | 12.4               | 4.25    | 4.25    | 1.15    | 8.0     | 12.0   | Q2            |
| M0H3215QRGZRQ1 | VQFN         | RGZ             | 48   | 4000 | 330.0              | 16.4               | 7.3     | 7.3     | 1.1     | 12.0    | 16.0   | Q2            |
| M0H3215QRHBRQ1 | VQFN         | RHB             | 32   | 5000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| M0H3215QRUKRQ1 | WQFN         | RUK             | 20   | 5000 | 330.0              | 12.4               | 3.3     | 3.3     | 1.1     | 8.0     | 12.0   | Q2            |
| M0H3216QPTRQ1  | LQFP         | PT              | 48   | 1000 | 330.0              | 16.4               | 9.6     | 9.6     | 1.9     | 12.0    | 16.0   | Q2            |
| M0H3216QRGERQ1 | VQFN         | RGE             | 24   | 5000 | 330.0              | 12.4               | 4.25    | 4.25    | 1.15    | 8.0     | 12.0   | Q2            |
| M0H3216QRGZRQ1 | VQFN         | RGZ             | 48   | 4000 | 330.0              | 16.4               | 7.3     | 7.3     | 1.1     | 12.0    | 16.0   | Q2            |
| M0H3216QRHBRQ1 | VQFN         | RHB             | 32   | 5000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| M0H3216QRUKRQ1 | WQFN         | RUK             | 20   | 5000 | 330.0              | 12.4               | 3.3     | 3.3     | 1.1     | 8.0     | 12.0   | Q2            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| M0H3215QPTRQ1  | LQFP         | PT              | 48   | 1000 | 336.6       | 336.6      | 31.8        |
| M0H3215QRGERQ1 | VQFN         | RGE             | 24   | 5000 | 360.0       | 360.0      | 36.0        |
| M0H3215QRGZRQ1 | VQFN         | RGZ             | 48   | 4000 | 360.0       | 360.0      | 36.0        |
| M0H3215QRHBRQ1 | VQFN         | RHB             | 32   | 5000 | 360.0       | 360.0      | 36.0        |
| M0H3215QRUKRQ1 | WQFN         | RUK             | 20   | 5000 | 360.0       | 360.0      | 36.0        |
| M0H3216QPTRQ1  | LQFP         | PT              | 48   | 1000 | 336.6       | 336.6      | 31.8        |
| M0H3216QRGERQ1 | VQFN         | RGE             | 24   | 5000 | 360.0       | 360.0      | 36.0        |
| M0H3216QRGZRQ1 | VQFN         | RGZ             | 48   | 4000 | 360.0       | 360.0      | 36.0        |
| M0H3216QRHBRQ1 | VQFN         | RHB             | 32   | 5000 | 360.0       | 360.0      | 36.0        |
| M0H3216QRUKRQ1 | WQFN         | RUK             | 20   | 5000 | 360.0       | 360.0      | 36.0        |

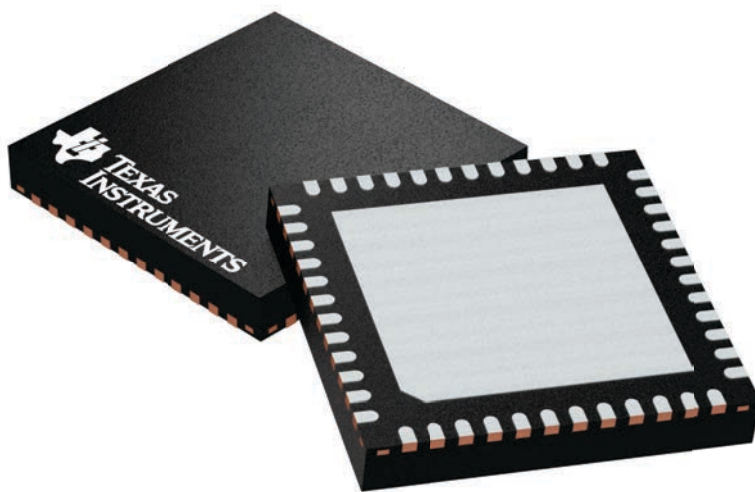
## GENERIC PACKAGE VIEW

**RGZ 48**

**VQFN - 1 mm max height**

7 x 7, 0.5 mm pitch

PLASTIC QUADFLAT PACK- NO LEAD



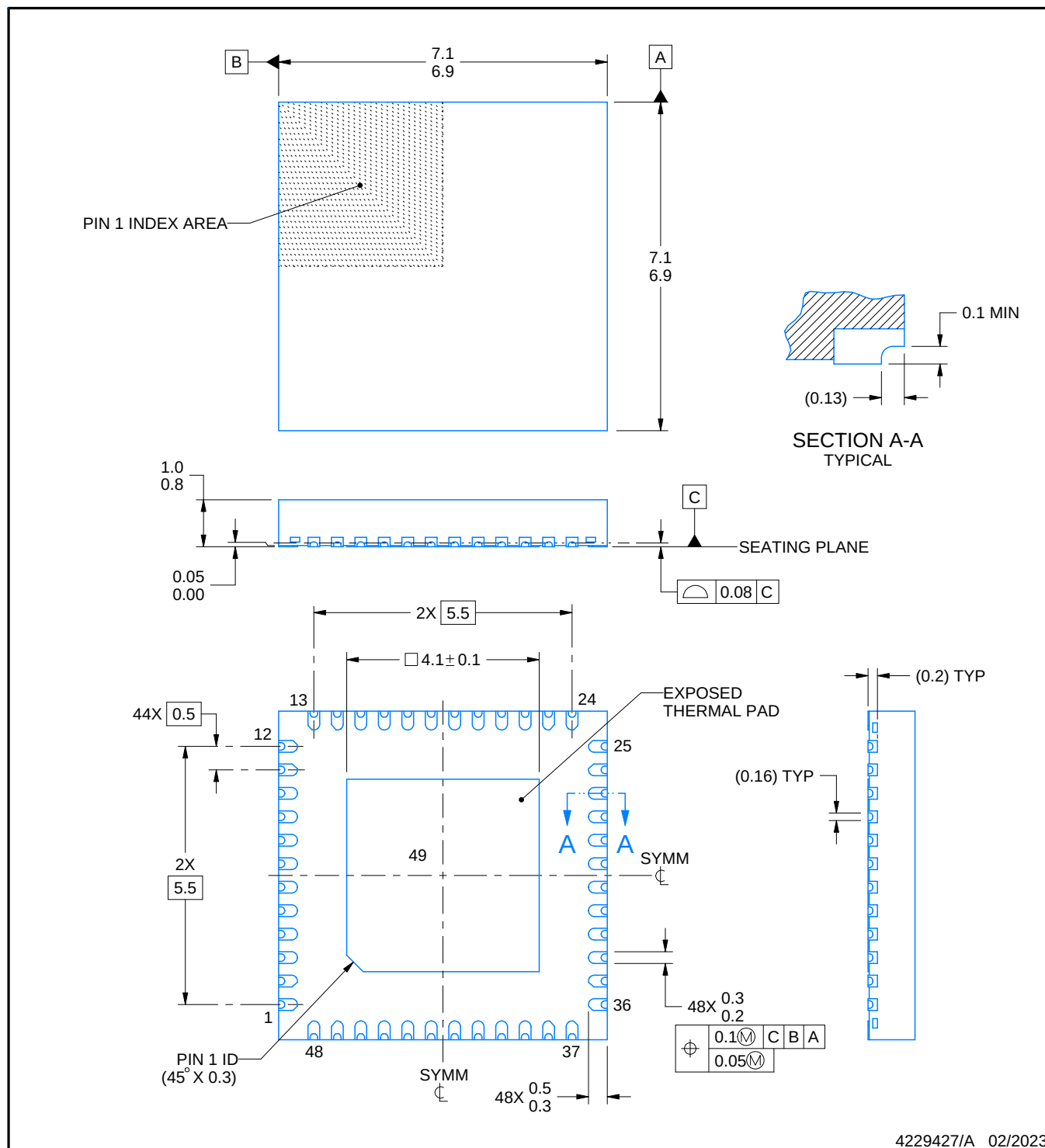
Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4224671/A



### VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES:

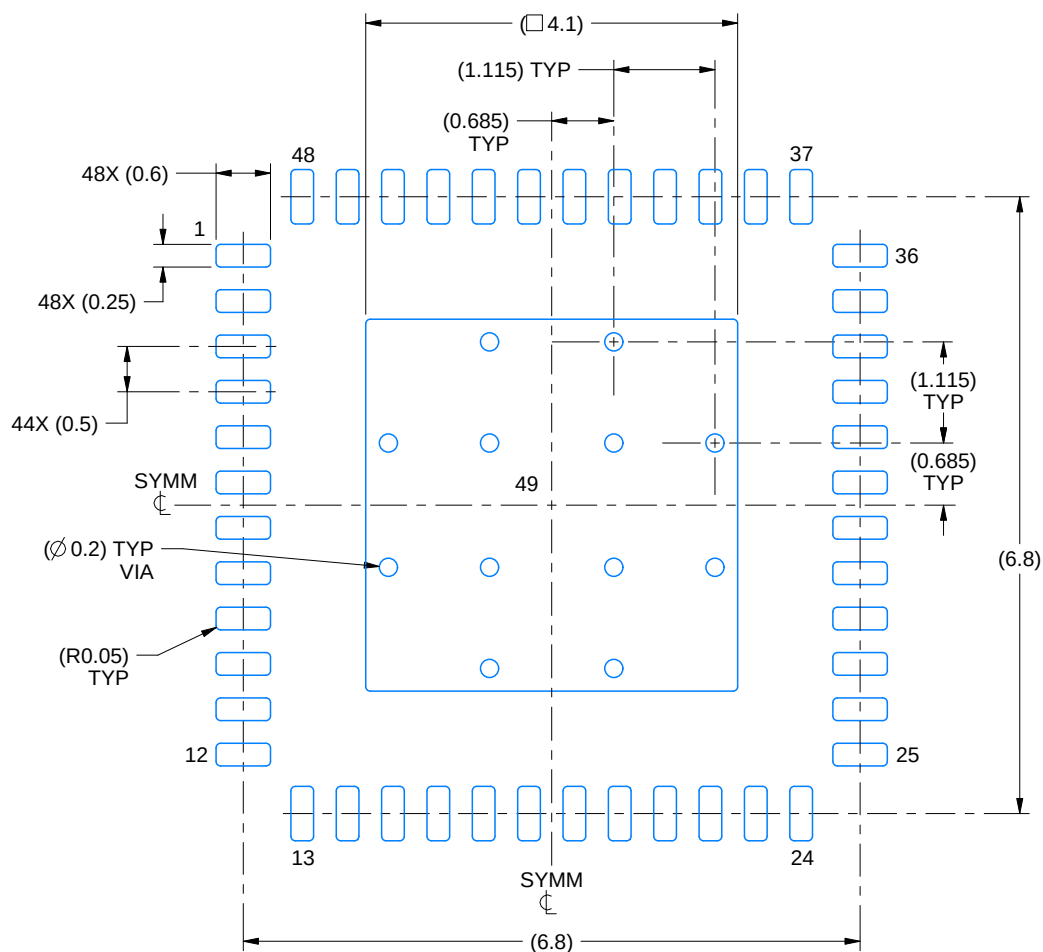
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

# EXAMPLE BOARD LAYOUT

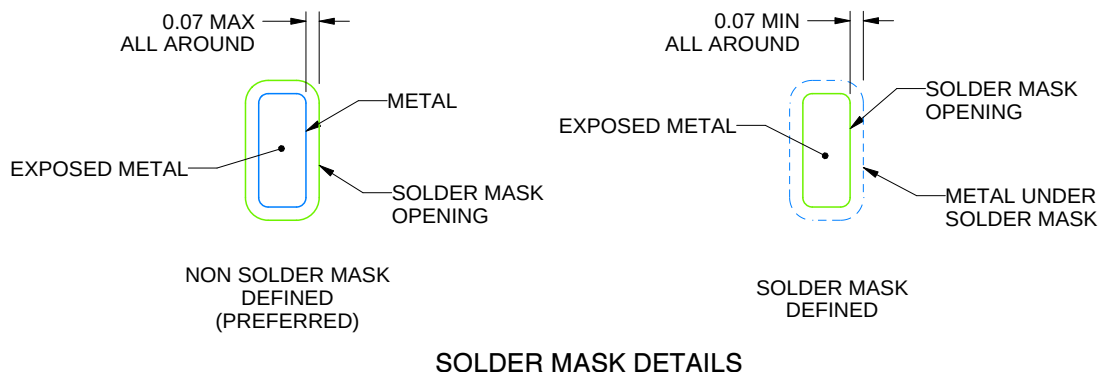
RGZ0048F

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:12X



4229427/A 02/2023

NOTES: (continued)

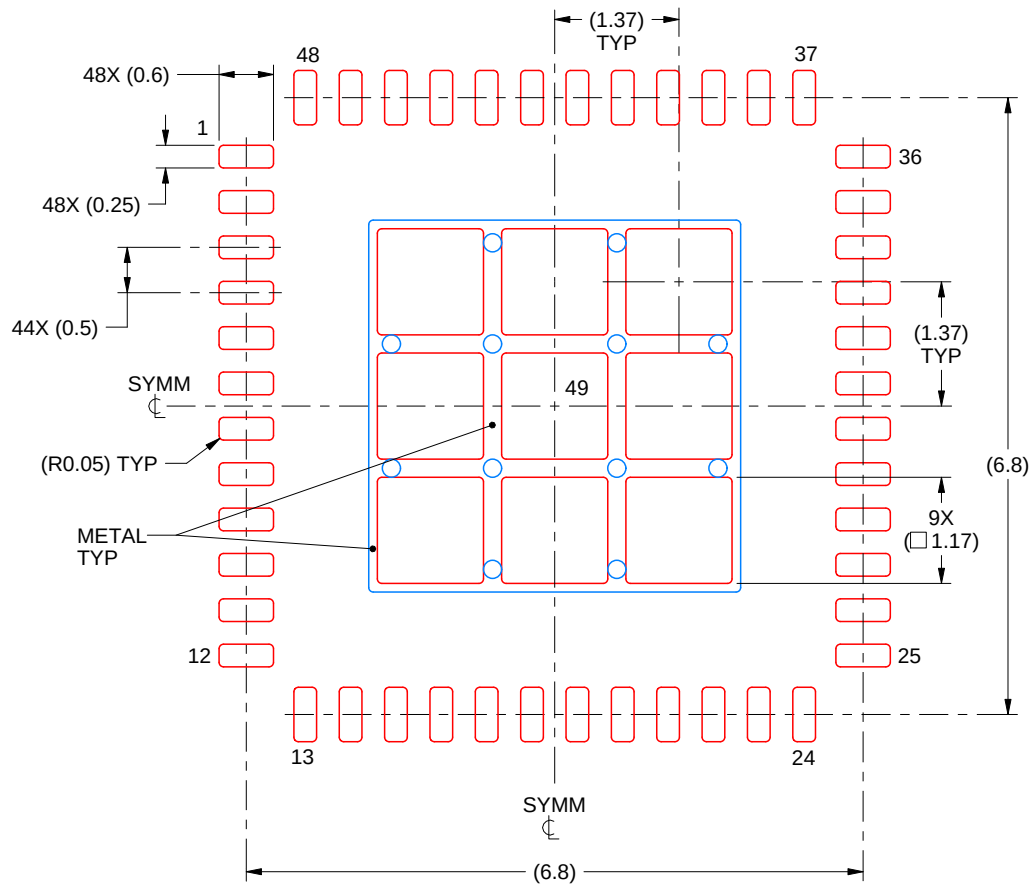
- This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).
- Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

# EXAMPLE STENCIL DESIGN

RGZ0048F

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



## SOLDER PASTE EXAMPLE BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 49  
73% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE  
SCALE:12X

4229427/A 02/2023

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

## GENERIC PACKAGE VIEW

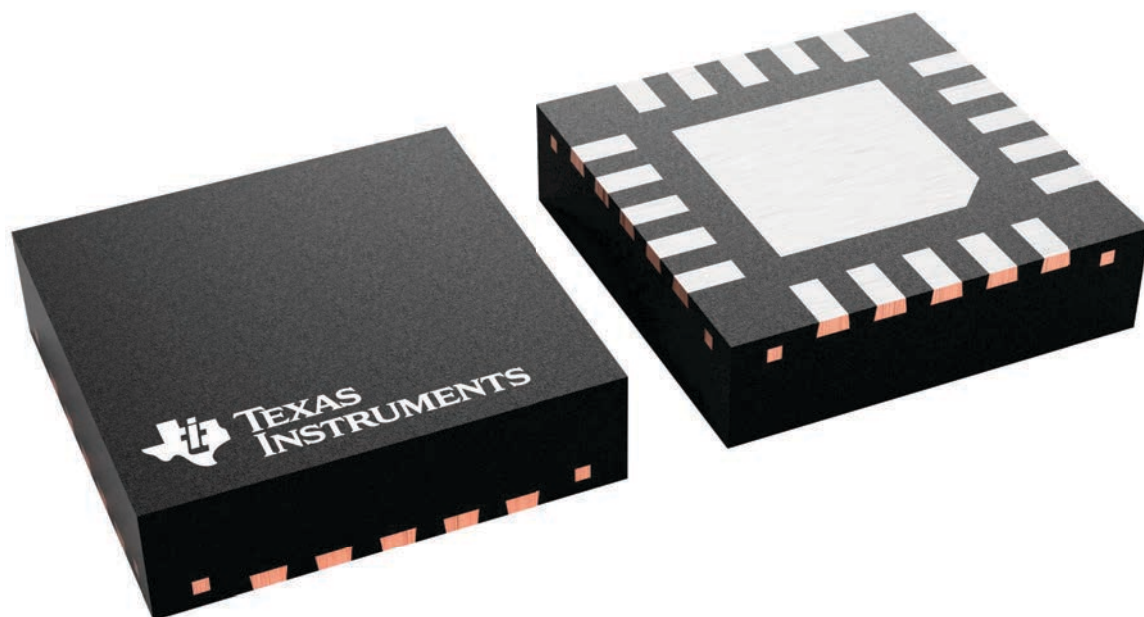
**RUK 20**

**WQFN - 0.8 mm max height**

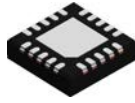
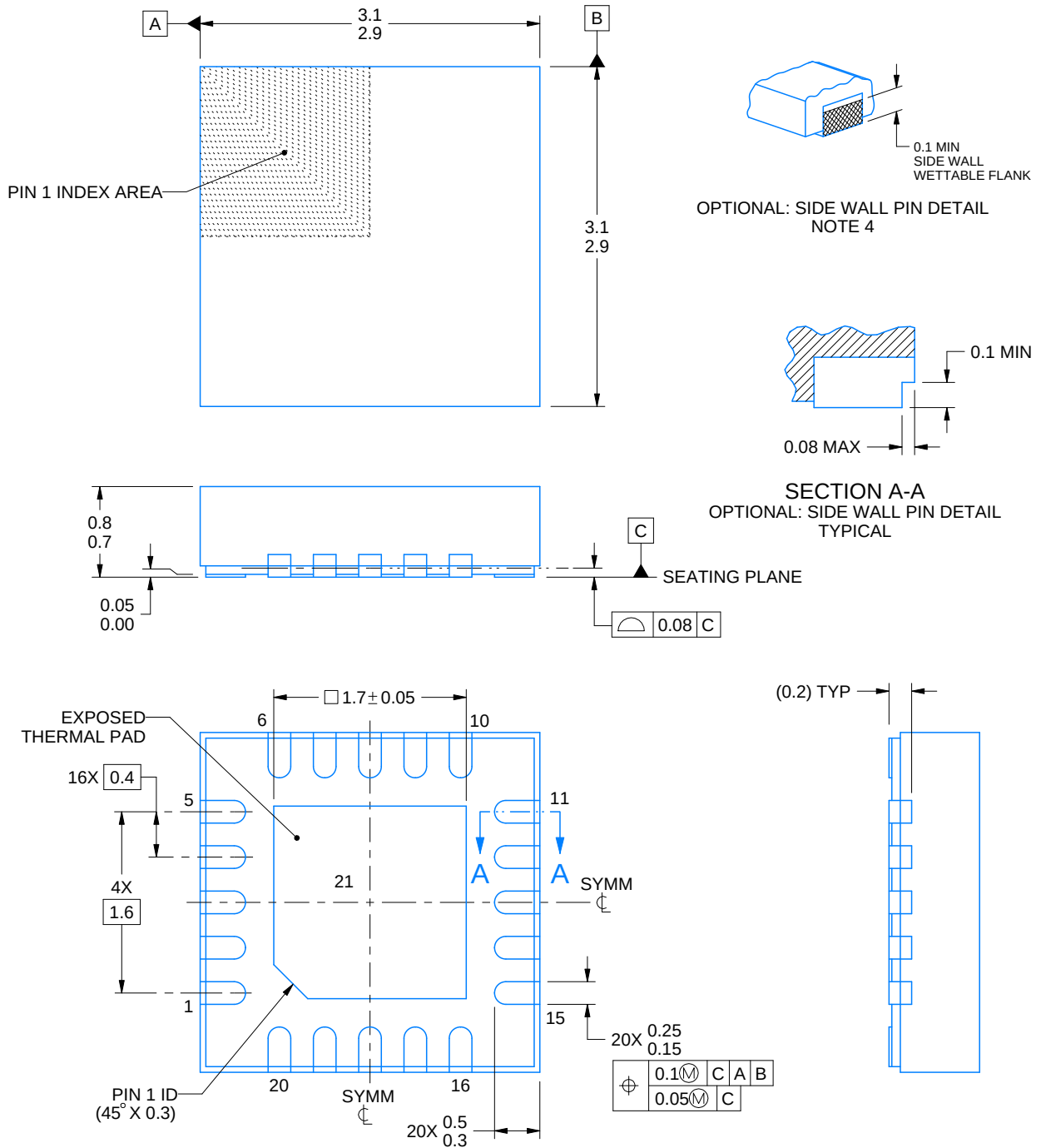
3 x 3, 0.4 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



4229651/A



4229629/C 06/2026

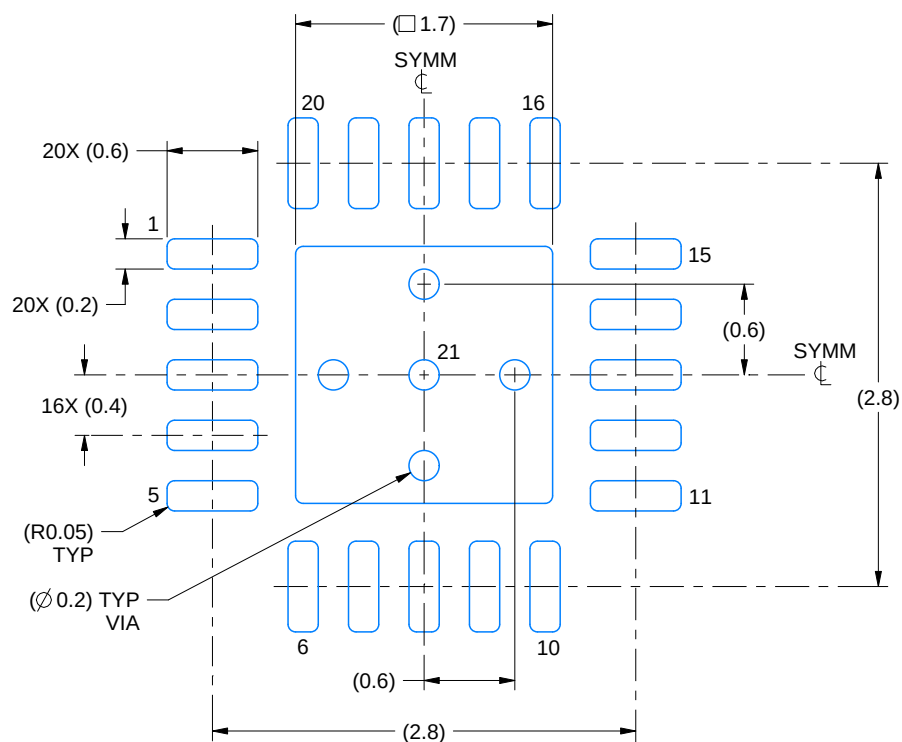
**NOTES:**

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.
4. Minimum 0.1 mm solder wetting on pin side wall. Available for wettable flank version only.

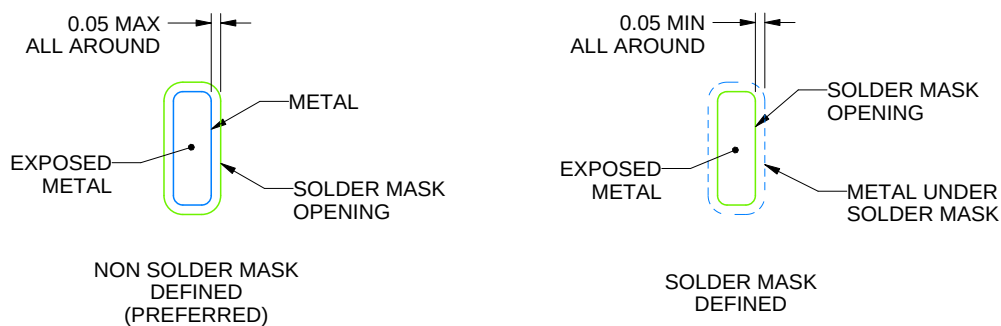
# RUK0020C

**WQFN - 0.8 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:20X



## SOLDER MASK DETAILS

4229629/C 06/2026

NOTES: (continued)

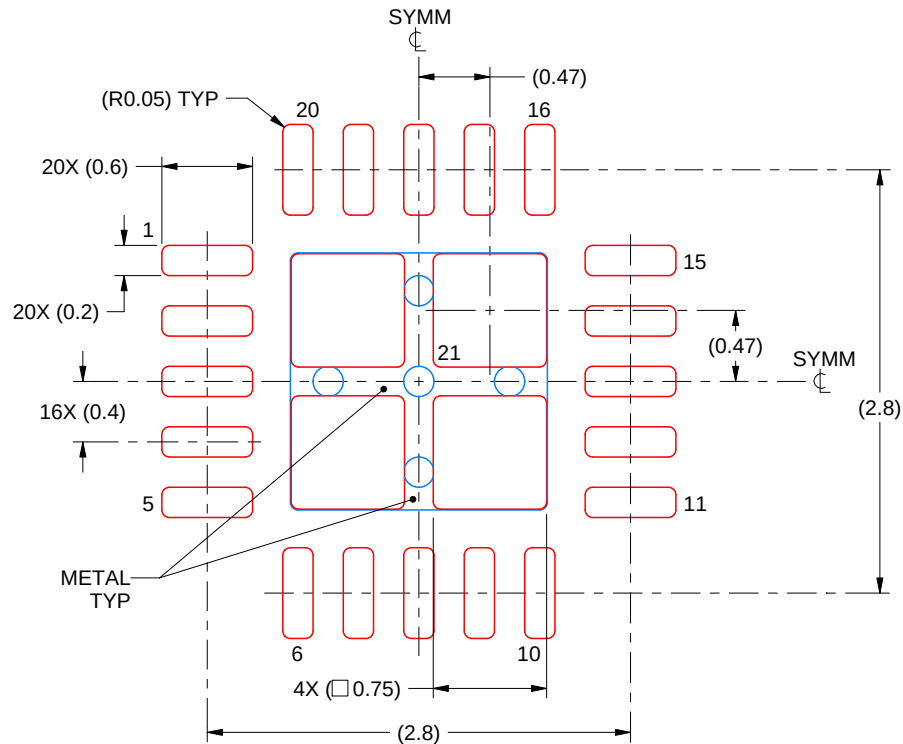
5. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slua271](http://www.ti.com/lit/slua271)).
6. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

## EXAMPLE STENCIL DESIGN

RUK0020C

WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



### SOLDER PASTE EXAMPLE BASED ON 0.1 mm THICK STENCIL

EXPOSED PAD 21:  
78% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE  
SCALE:20X

4229629/C 06/2026

NOTES: (continued)

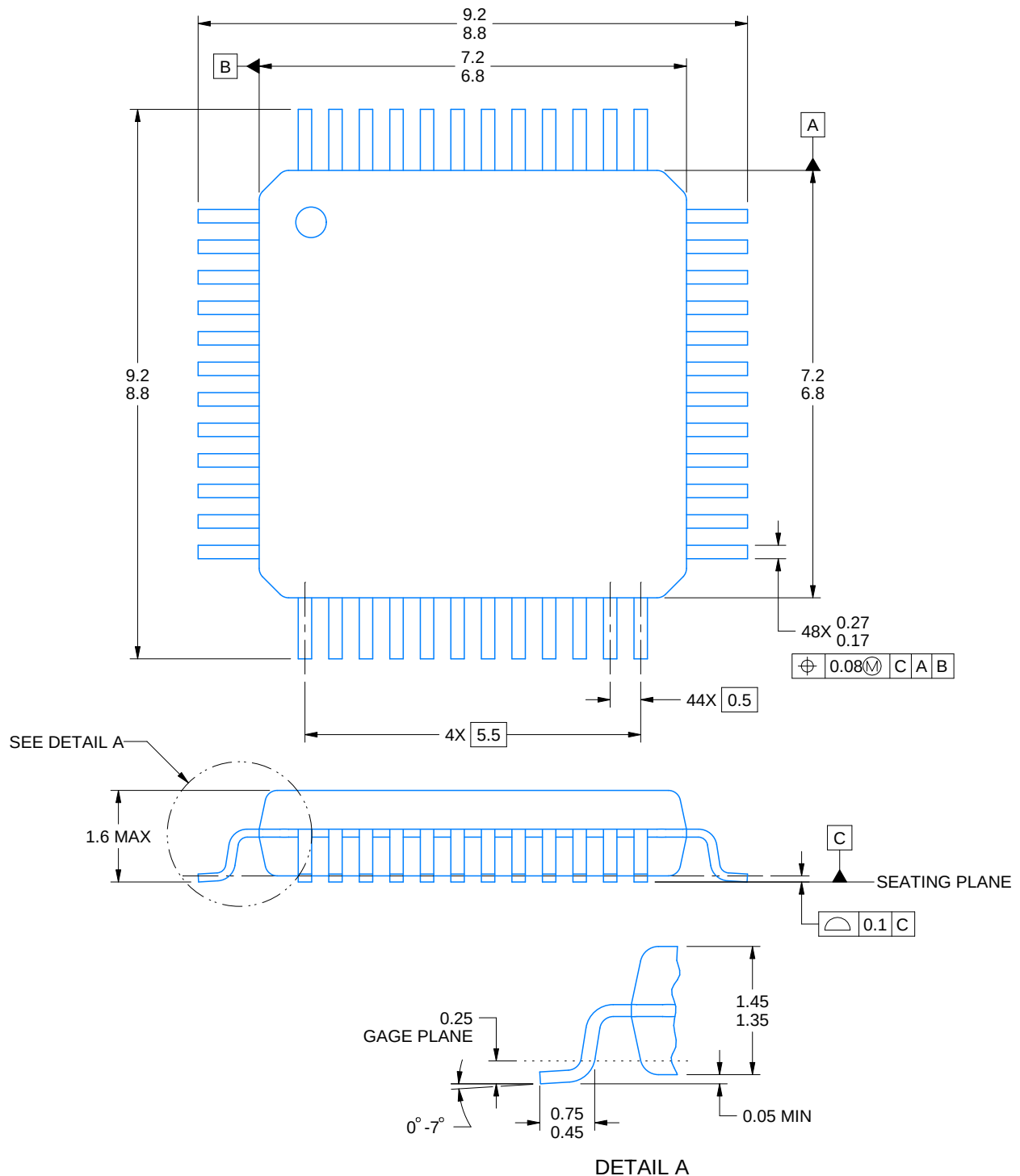
7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

**PT0048A**

## PACKAGE OUTLINE

**LQFP - 1.6 mm max height**

## LOW PROFILE QUAD FLATPACK



4215159/B 11/2023

NOTES:

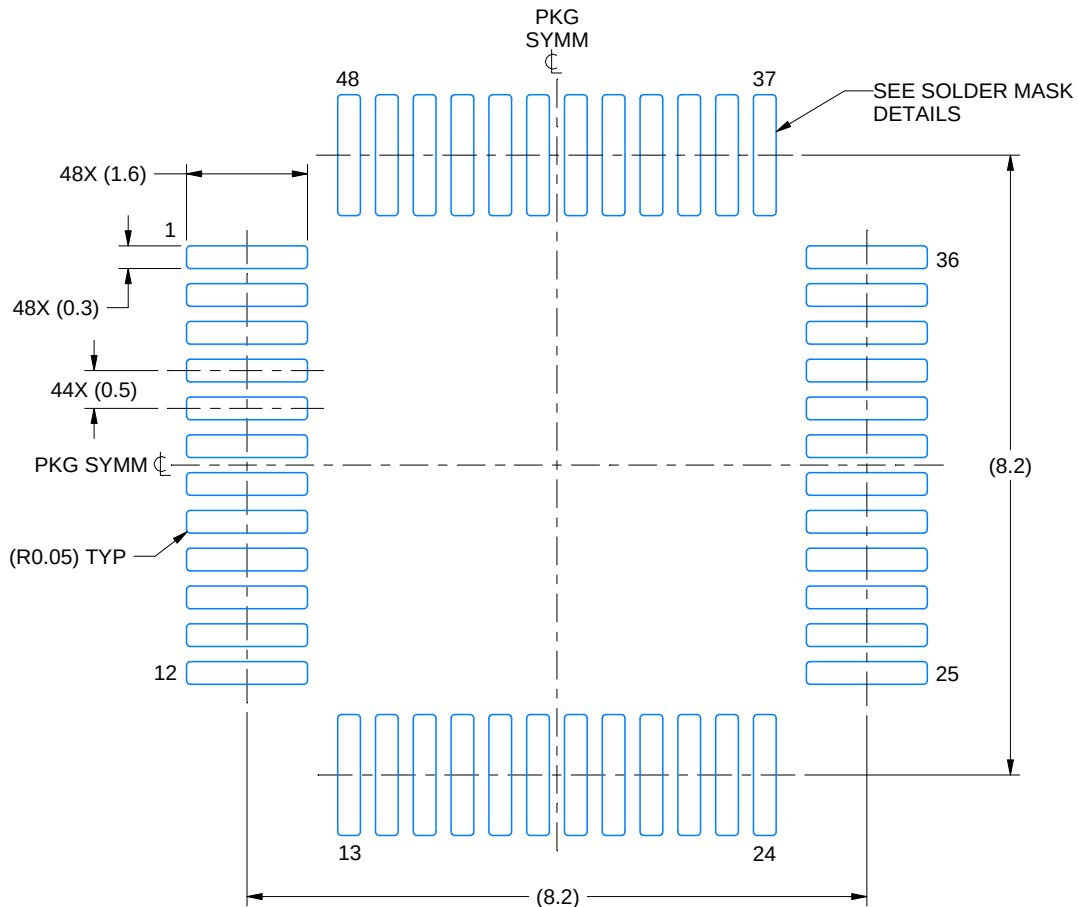
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC registration MS-026.
4. This may also be a thermally enhanced plastic package with leads connected to the die pads.

# EXAMPLE BOARD LAYOUT

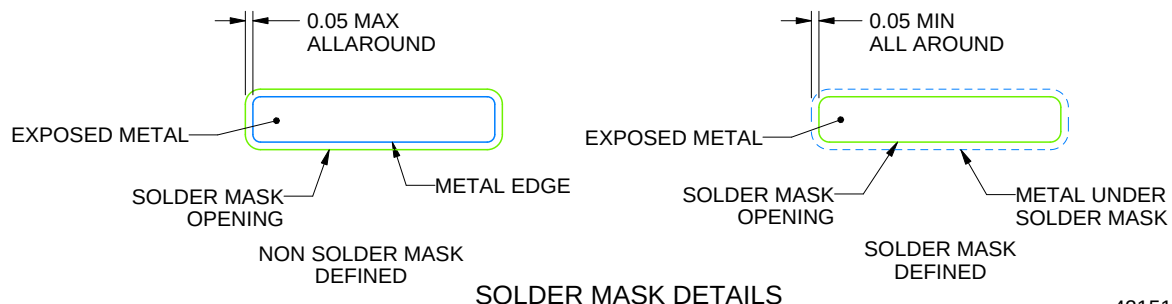
PT0048A

LQFP - 1.6 mm max height

LOW PROFILE QUAD FLATPACK



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE 10.000



4215159/B 11/2023

NOTES: (continued)

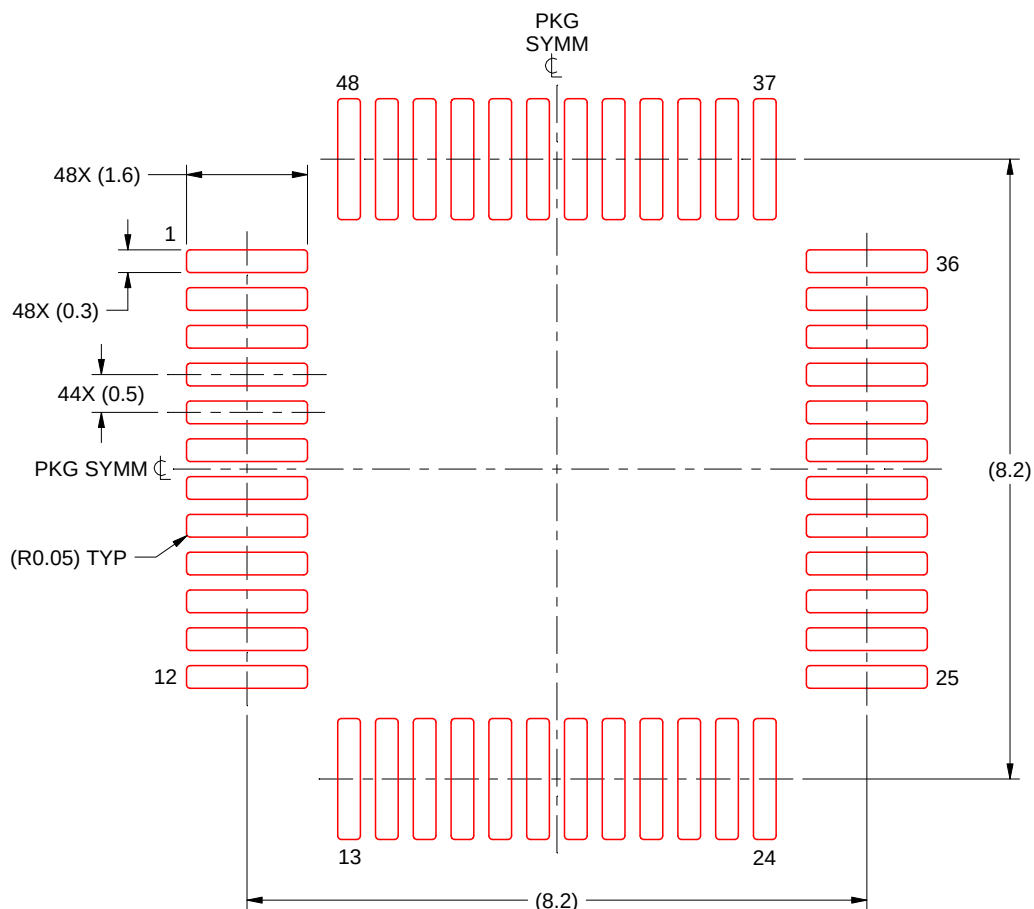
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

PT0048A

LQFP - 1.6 mm max height

LOW PROFILE QUAD FLATPACK



SOLDER PASTE EXAMPLE  
BASED ON 0.1 mm THICK STENCIL  
SCALE: 10X

4215159/B 11/2023

NOTES: (continued)

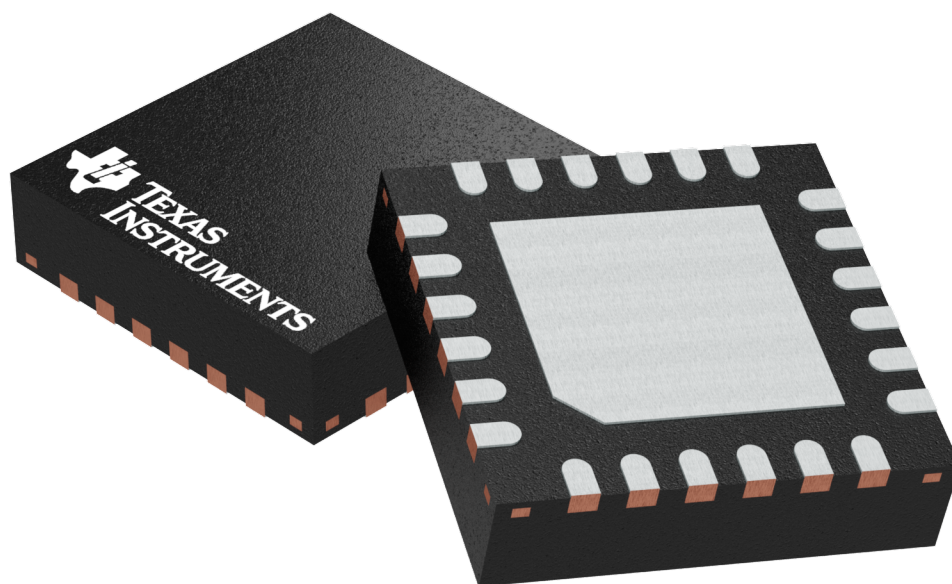
7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

**RGE 24**

**GENERIC PACKAGE VIEW**

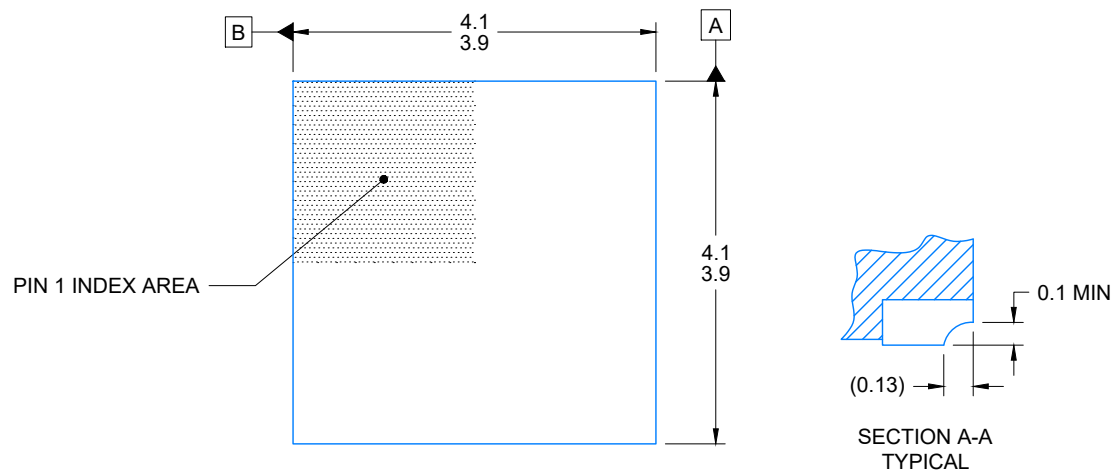
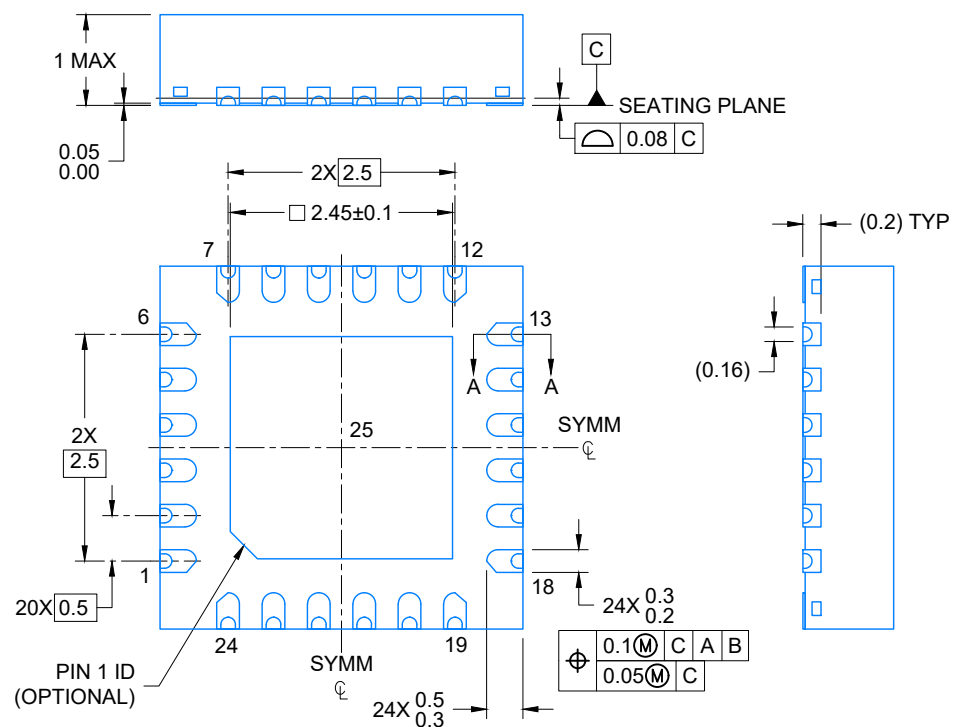
**VQFN - 1 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4204104/H



4224736/A 12/2018

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for optimal thermal and mechanical performance.

## VQFN - 1 mm max height

24X (0.6)

24X (0.25)

20X (0.5)

2X (0.975)

(R0.05) TYP

2X (3.8)

2X (2.5)

(□ 2.45)

24

19

18

13

25

SYMM

2X (2.5)

2X (3.8)

7

12

2X (0.975)

SYMM

(Ø 0.2) VIA TYP

4224736/A 12/2018

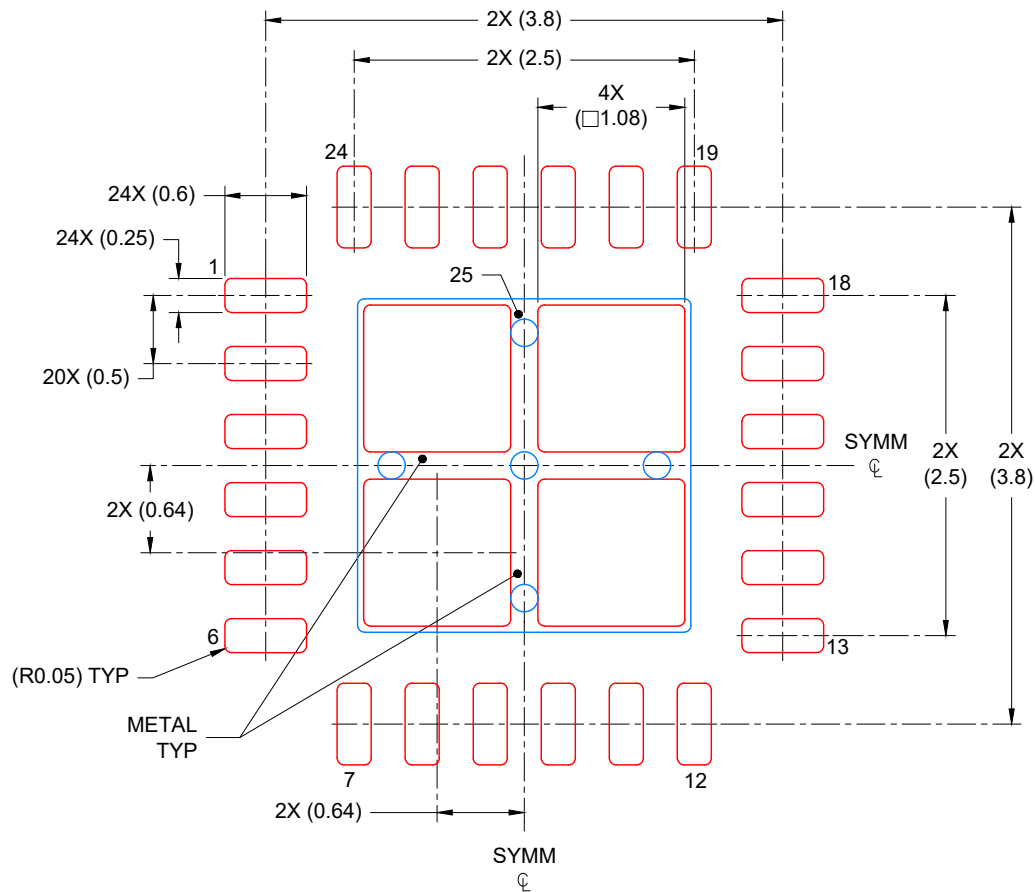
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slua271](http://www.ti.com/lit/slua271)).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

# EXAMPLE STENCIL DESIGN

RGE0024N

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK-NO LEAD



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD  
78% PRINTED COVERAGE BY AREA  
SCALE: 18X

4224736/A 12/2018

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

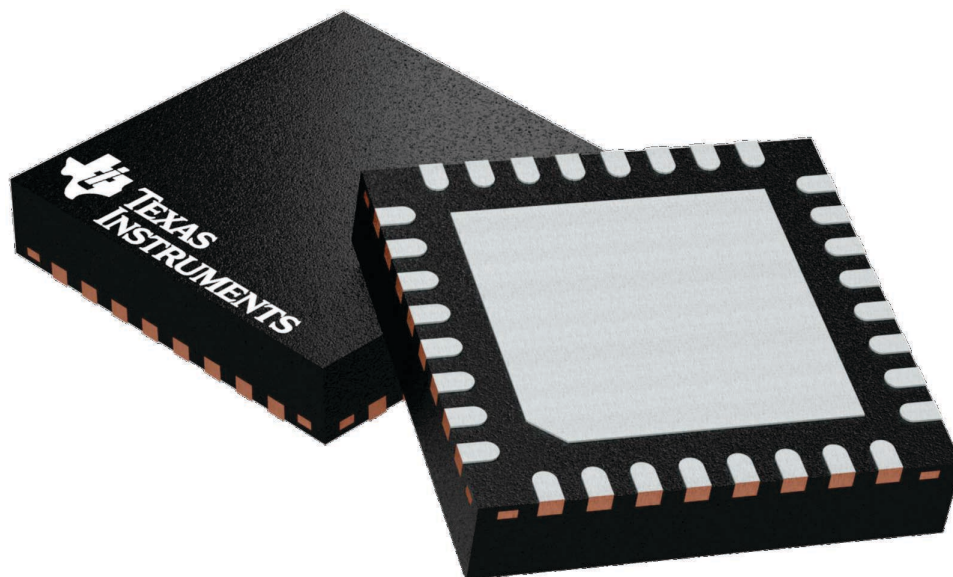
## GENERIC PACKAGE VIEW

**RHB 32**

**VQFN - 1 mm max height**

5 x 5, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4224745/A

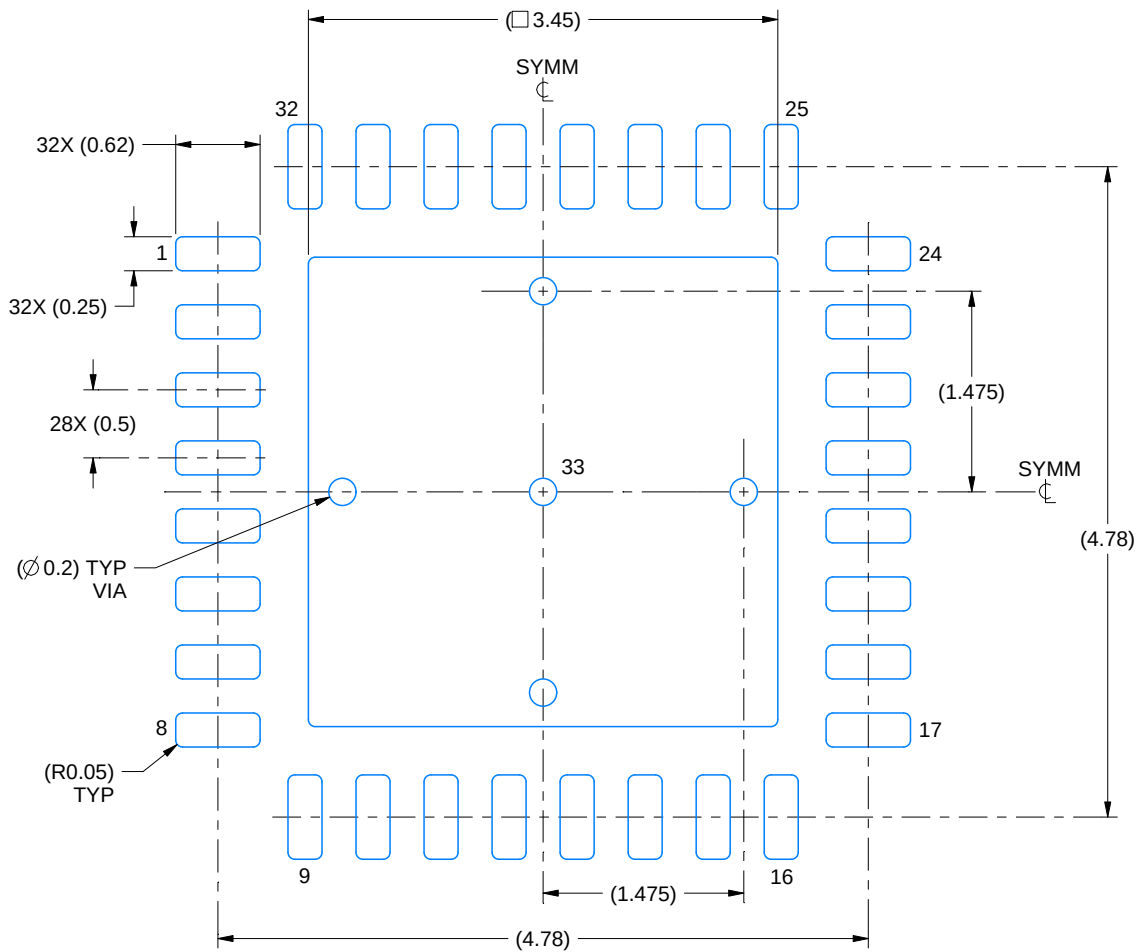
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

# EXAMPLE BOARD LAYOUT

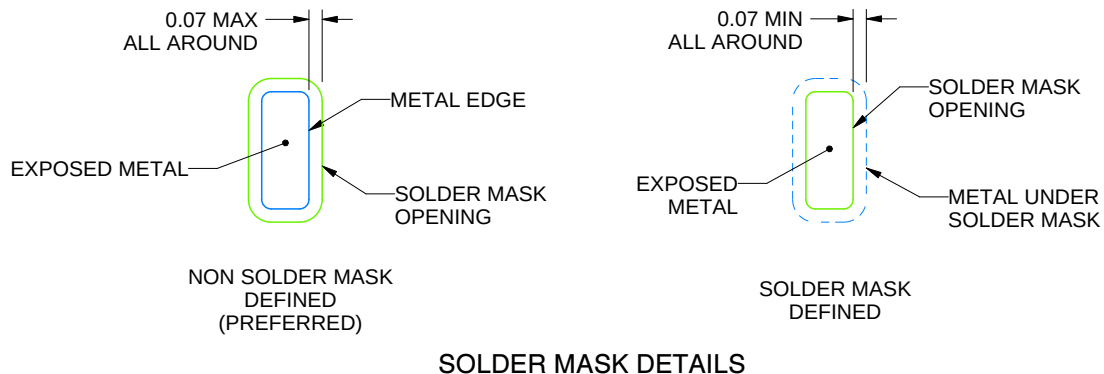
RHB0032T

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



**LAND PATTERN EXAMPLE**  
EXPOSED METAL SHOWN  
SCALE:18X



**SOLDER MASK DETAILS**

4224744/A 01/2019

NOTES: (continued)

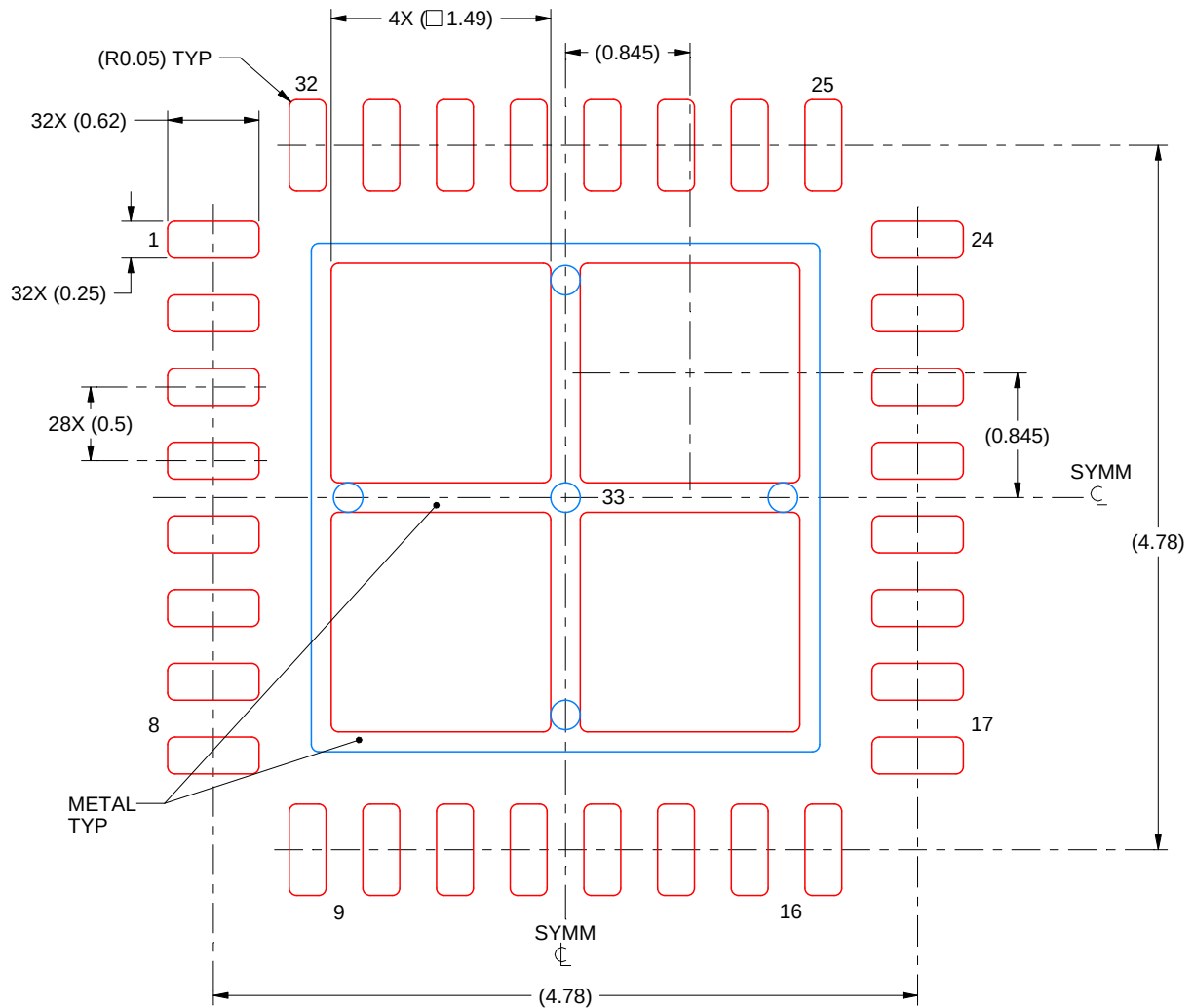
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

# EXAMPLE STENCIL DESIGN

RHB0032T

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



**SOLDER PASTE EXAMPLE**  
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 33:  
75% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE  
SCALE:20X

4224744/A 01/2019

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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